



# PCF2113x

## LCD controllers/drivers

Rev. 04 — 4 March 2008

Product data sheet

## 1. General description

The PCF2113x is a low-power CMOS LCD controller and driver, designed to drive a dot matrix LCD display of 2 lines of 12 characters or 1 line of 24 characters with  $5 \times 8$  dot format. All necessary functions for the display are provided in a single chip, including on-chip generation of LCD bias voltages, resulting in a minimum of external components and lower system current consumption. The PCF2113x interfaces to most microcontrollers via a 4-bit or 8-bit bus or via the 2-wire I<sup>2</sup>C-bus. The chip contains a character generator and displays alphanumeric and kana (Japanese) characters.

The letter 'x' in PCF2113x characterizes the built-in character set. Various character sets can be manufactured on request.

## 2. Features

- Single-chip LCD controller/driver
- 2-line display of up to 12 characters + 120 icons, or 1-line display of up to 24 characters + 120 icons
- $5 \times 7$  character format plus cursor;  $5 \times 8$  for kana (Japanese) and user-defined symbols
- Icon mode for e.g. additional segment display section: reduced current consumption while displaying icons only
- Icon blink function
- Very low current consumption (20  $\mu$ A to 200  $\mu$ A):
  - ◆ Icon mode: < 25  $\mu$ A
  - ◆ Power-down mode: < 2  $\mu$ A
- On-chip:
  - ◆ Configurable 4, 3 or 2 voltage multiplier, generating LCD supply voltage  $V_{LCD}$ , independent of  $V_{DD}$ , programmable by instruction (external supply also possible)
  - ◆ Temperature compensation of on-chip generated  $V_{LCD}$ :  $-0.16\%/K$  to  $-0.24\%/K$  (programmable by instruction)
  - ◆ Generation of intermediate LCD bias voltages
  - ◆ Oscillator requires no external components (external clock also possible)
- Display data RAM: 80 characters
- Character generator ROM: 240 characters of  $5 \times 8$  dots
- Character generator RAM: 16 characters of  $5 \times 8$  dots; 3 characters used to drive 120 icons, 6 characters used if icon blink feature is used in application
- 4-bit or 8-bit parallel bus and 2-wire I<sup>2</sup>C-bus interface
- 18 row and 60 column outputs

- Multiplex rates (MUX) 1:18 (for normal operation), 1:9 (for single-line operation) and 1:2 (for Icon-only mode)
- Uses common 11 code instruction set (extended)
- Logic supply voltage range  $V_{DD1} - V_{SS1} = 1.8\text{ V to }5.5\text{ V}$  (chip may be driven with two battery cells)
- $V_{LCD}$  generator supply voltage range  $V_{DD2} - V_{SS2} = 2.2\text{ V to }4.0\text{ V}$
- Display supply voltage range  $V_{LCD} - V_{SS2} = 2.2\text{ V to }6.5\text{ V}$
- Direct mode to save current consumption for Icon mode and MUX 1:9 (depending on  $V_{DD2}$  and LCD liquid properties)
- CMOS compatible
- **Remark:** Icon mode is a way to save current. When only icons are displayed (i.e. only the lower two rows are active), a much lower operating voltage  $V_{LCD}$  can be used and the switching frequency of the LCD outputs is reduced. In most applications it is possible to use  $V_{DD}$  as  $V_{LCD}$ .

### 3. Applications

- Telecom equipment
- Point-of-sale terminals
- Portable instruments

### 4. Ordering information

Table 1. Ordering information

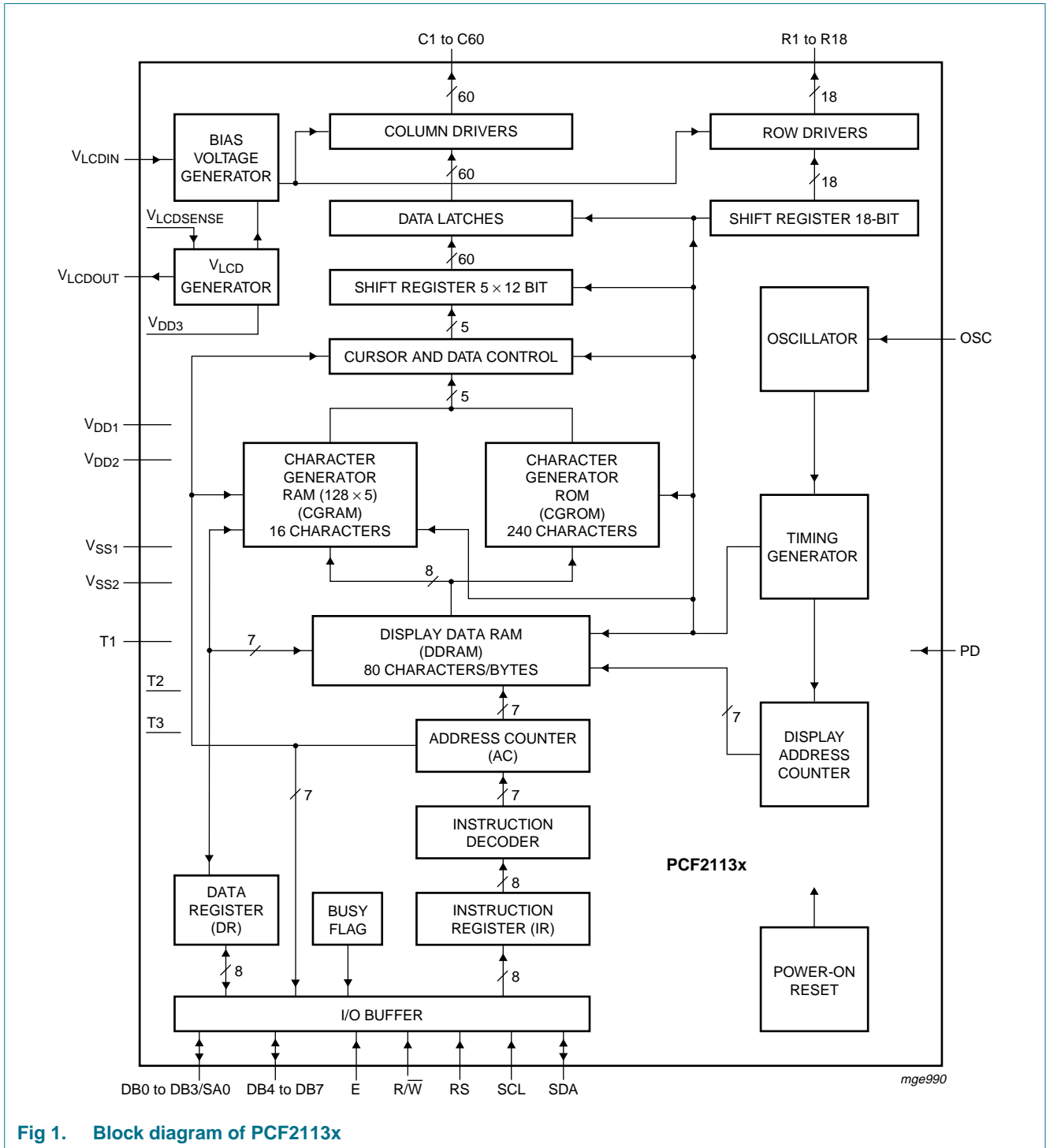
| Type number     | Package |   |          |
|-----------------|---------|---|----------|
|                 | Name    | Description   | Version  |
| PCF2113AU/10/F4 | -       | chip on flexible film carrier   | -        |
| PCF2113DU/F4    | -       | chip in tray  | -        |
| PCF2113DH/4     | LQFP100 | plastic low profile quad flat package; 100 leads; body 14 × 14 × 1.4 mm | SOT407-1 |
| PCF2113DU/2/F4  | -       | chip with bumps in tray   | -        |
| PCF2113EU/2/F4  | -       | chip with bumps in tray   | -        |
| PCF2113WU/2/F4  | -       | chip with bumps in tray   | -        |

### 5. Marking

Table 2. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PCF2113DH/4 | PCF2113DH    |

**6. Block diagram**



**Fig 1. Block diagram of PCF2113x**

## 7. Pinning information

### 7.1 Pinning

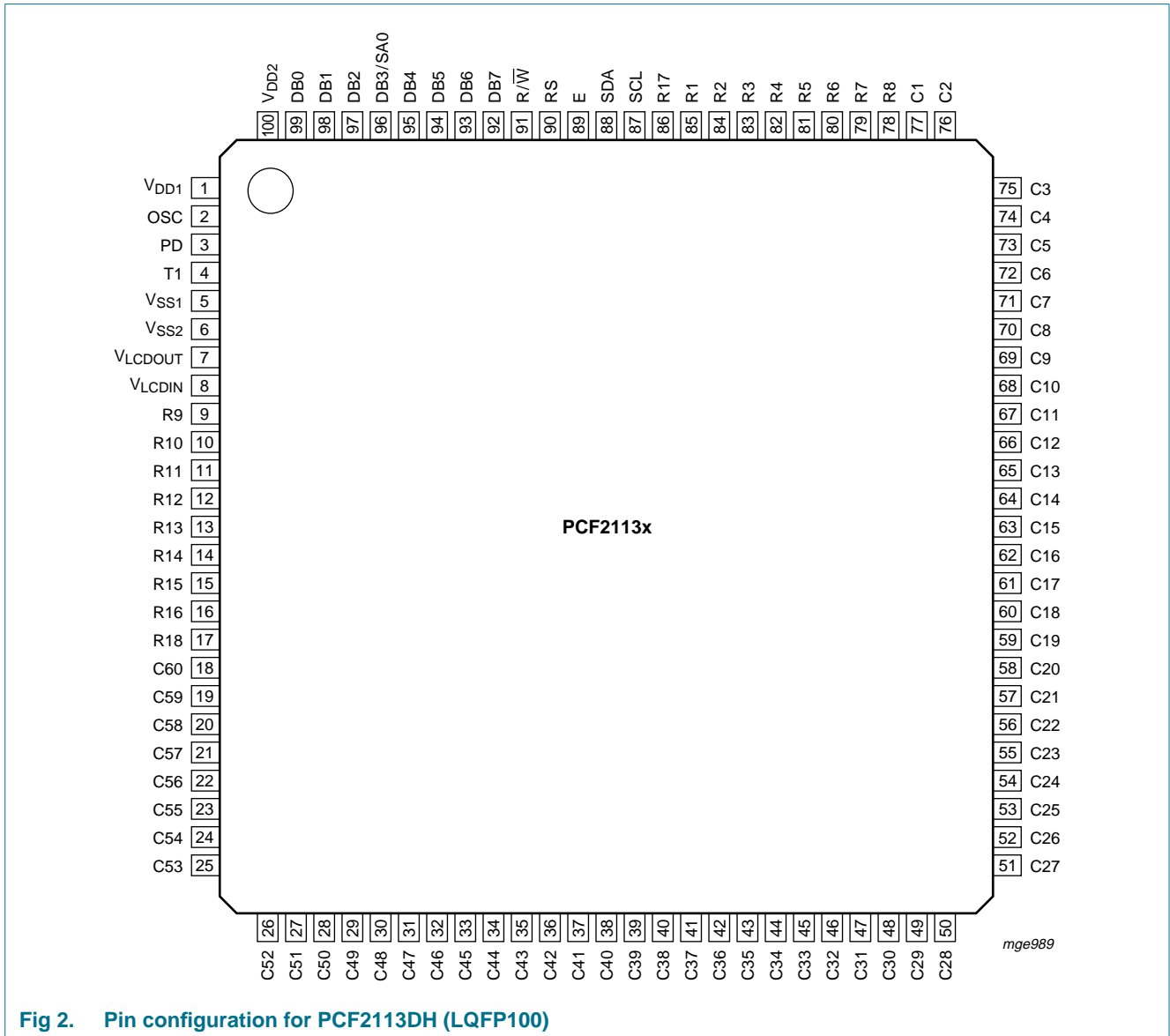
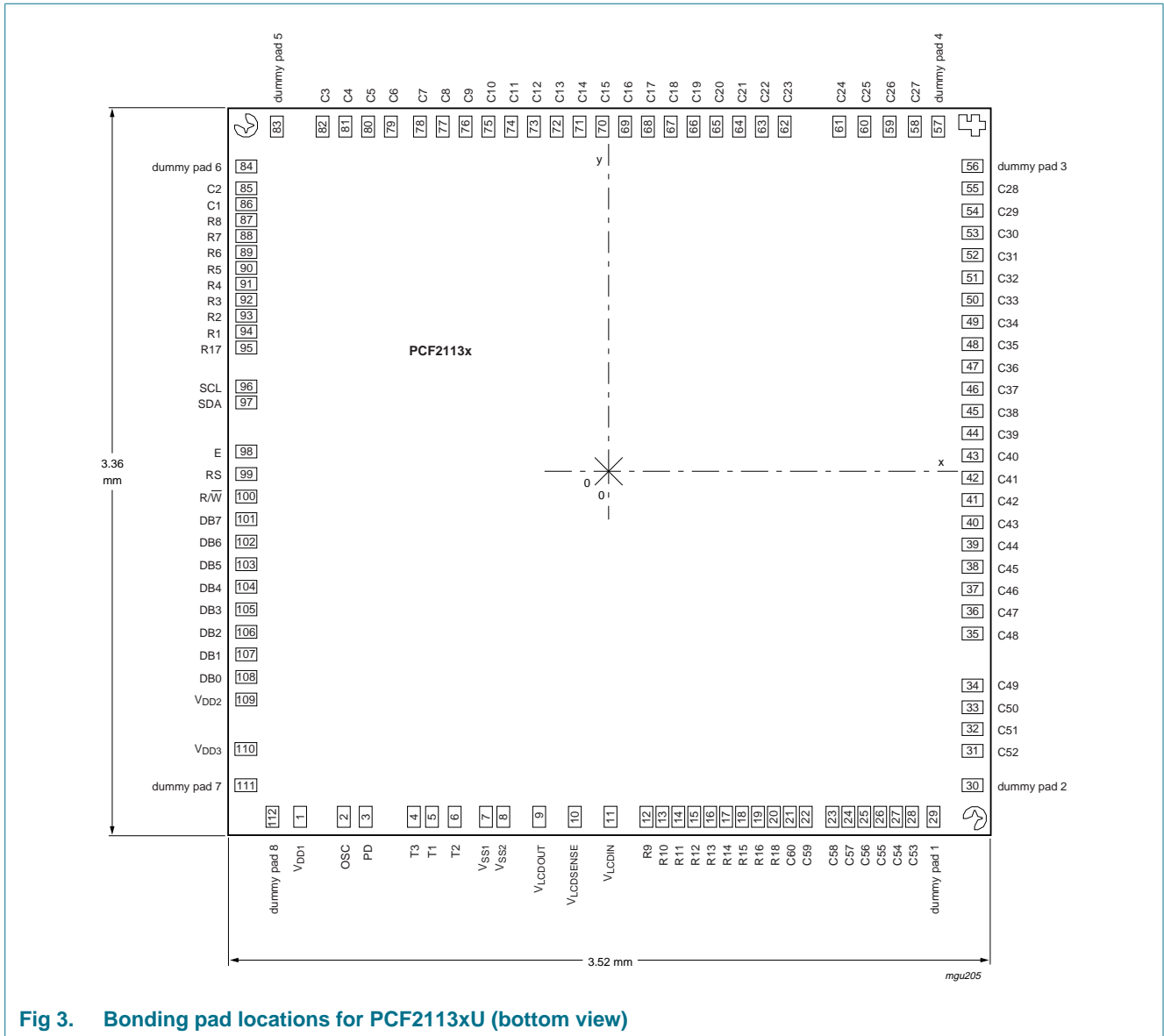


Fig 2. Pin configuration for PCF2113DH (LQFP100)



**Fig 3. Bonding pad locations for PCF2113xU (bottom view)**

**Table 3. Pin (LQFP100 package) or pad allocation table**

| Pin | Pad | Symbol                | Pin      | Pad      | Symbol    |
|-----|-----|-----------------------|----------|----------|-----------|
| 1   | 1   | V <sub>DD1</sub>      | -        | 84       | dummy pad |
| 2   | 2   | OSC                   | 76       | 85       | C2        |
| 3   | 3   | PD                    | 77       | 86       | C1        |
| -   | 4   | T3                    | 78 to 85 | 87 to 94 | R8 to R1  |
| 4   | 5   | T1                    | 86       | 95       | R17       |
| -   | 6   | T2                    | 87       | 96       | SCL       |
| 5   | 7   | V <sub>SS1</sub>      | 88       | 97       | SDA       |
| 6   | 8   | V <sub>SS2</sub>      | 89       | 98       | E         |
| 7   | 9   | V <sub>LCDOUT</sub>   | 90       | 99       | RS        |
| -   | 10  | V <sub>LCDSENSE</sub> | 91       | 100      | R/W       |

**Table 3. Pin (LQFP100 package) or pad allocation table ...continued**

| Pin      | Pad      | Symbol             | Pin | Pad | Symbol           |
|----------|----------|--------------------|-----|-----|------------------|
| 8        | 11       | V <sub>LCDIN</sub> | 92  | 101 | DB7              |
| 9 to 16  | 12 to 19 | R9 to R16          | 93  | 102 | DB6              |
| 17       | 20       | R18                | 94  | 103 | DB5              |
| 18 to 25 | 21 to 28 | C60 to C53         | 95  | 104 | DB4              |
| -        | 29       | dummy pad          | 96  | 105 | DB3/SA0          |
| -        | 30       | dummy pad          | 97  | 106 | DB2              |
| 26 to 50 | 31 to 55 | C52 to C28         | 98  | 107 | DB1              |
| -        | 56       | dummy pad          | 99  | 108 | DB0              |
| -        | 57       | dummy pad          | 100 | 109 | V <sub>DD2</sub> |
| 51 to 75 | 58 to 82 | C27 to C3          | -   | 110 | V <sub>DD3</sub> |
| -        | 83       | dummy pad          | -   | -   | -                |

**Table 4. Bonding pad dimensions**

| Pad                               | Size                             | Unit             |    |
|-----------------------------------|----------------------------------|------------------|----|
| Type                              | galvanic pure Au                 |                  |    |
| Bump dimensions                   | (50 ± 6) × (90 ± 6) × (17.5 ± 5) | µm               |    |
| Height difference in one die      | < 2                              | µm               |    |
| Convex deformation                | < 5                              | µm               |    |
| Pad size (aluminium)              | 62 × 100                         | µm               |    |
| Passivation opening               | 36 × 76                          | µm               |    |
| Pad pitch                         | -635.0                           | µm               |    |
| Wafer thickness (excluding bumps) | 380 ± 25                         | µm               |    |
|                                   | <b>Fab 1 [1]</b>                 | <b>Fab 2 [2]</b> |    |
| Die size X                        | 3.52                             | 3.47             | mm |
| Die size Y                        | 3.36                             | 3.31             | mm |

[1] Fab 1 identification starts with nnnnnn, where n represents a number between 0 and 9 (8 inch wafer).

[2] Fab 2 identification starts with AXnnnn, where X represents a letter or a number and n represents a number between 0 and 9 (6 inch wafer).

**Table 5. Pin and bonding pad description**

All x/y coordinates represent the position of the center of each pad with respect to the center (x/y = 0) of the chip (see Figure 3).

| Symbol           | Pin | Type | Pad | X (µm) | Y (µm) | Description  |
|------------------|-----|------|-----|--------|--------|--|
| V <sub>DD1</sub> | 1   | P    | 1   | -1345  | -1550  | supply voltage 1 for all except V <sub>LCD</sub> generator |
| OSC              | 2   | I    | 2   | -1155  | -1550  | oscillator and external clock input [1]                    |
| PD               | 3   | I    | 3   | -1055  | -1550  | power-down select input; for normal operation PD is LOW    |
| T3               | -   | I    | 4   | -845   | -1550  | test pad; open circuit and not user accessible             |
| T1               | 4   | I    | 5   | -765   | -1550  | test pin; must be connected to V <sub>SS1</sub>            |
| T2               | -   | I    | 6   | -665   | -1550  | test pad; must be connected to V <sub>SS1</sub>            |
| V <sub>SS1</sub> | 5   | P    | 7   | -525   | -1550  | ground 1 for all except V <sub>LCD</sub> generator         |

**Table 5. Pin and bonding pad description ...continued**

All x/y coordinates represent the position of the center of each pad with respect to the center (x/y = 0) of the chip (see Figure 3).

| Symbol                | Pin | Type | Pad | X (μm) | Y (μm) | Description   |
|-----------------------|-----|------|-----|--------|--------|---|
| V <sub>SS2</sub>      | 6   | P    | 8   | -455   | -1550  | ground 2 for V <sub>LCD</sub> generator   |
| V <sub>LCDOUT</sub>   | 7   | O    | 9   | -295   | -1550  | V <sub>LCD</sub> output if V <sub>LCD</sub> is generated internally <a href="#">[2]</a>             |
| V <sub>LCDSENSE</sub> | -   | I    | 10  | -145   | -1550  | input (V <sub>LCD</sub> ) for voltage multiplier regulation <a href="#">[2]</a> <a href="#">[3]</a> |
| V <sub>LCDIN</sub>    | 8   | I    | 11  | 15     | -1550  | input for generation of LCD bias levels <a href="#">[2]</a>   |
| R9                    | 9   | O    | 12  | 175    | -1550  | LCD row driver output   |
| R10                   | 10  | O    | 13  | 245    | -1550  | LCD row driver output   |
| R11                   | 11  | O    | 14  | 315    | -1550  | LCD row driver output   |
| R12                   | 12  | O    | 15  | 385    | -1550  | LCD row driver output   |
| R13                   | 13  | O    | 16  | 455    | -1550  | LCD row driver output   |
| R14                   | 14  | O    | 17  | 525    | -1550  | LCD row driver output   |
| R15                   | 15  | O    | 18  | 595    | -1550  | LCD row driver output   |
| R16                   | 16  | O    | 19  | 665    | -1550  | LCD row driver output   |
| R18                   | 17  | O    | 20  | 735    | -1550  | LCD row driver output   |
| C60                   | 18  | O    | 21  | 805    | -1550  | LCD column driver output  |
| C59                   | 19  | O    | 22  | 875    | -1550  | LCD column driver output  |
| C58                   | 20  | O    | 23  | 995    | -1550  | LCD column driver output  |
| C57                   | 21  | O    | 24  | 1065   | -1550  | LCD column driver output  |
| C56                   | 22  | O    | 25  | 1135   | -1550  | LCD column driver output  |
| C55                   | 23  | O    | 26  | 1205   | -1550  | LCD column driver output  |
| C54                   | 24  | O    | 27  | 1275   | -1550  | LCD column driver output  |
| C53                   | 25  | O    | 28  | 1345   | -1550  | LCD column driver output  |
| dummy pad 1           | -   | -    | 29  | 1435   | -1550  | -   |
| dummy pad 2           | -   | -    | 30  | 1630   | -1395  | -   |
| C52                   | 26  | O    | 31  | 1630   | -1255  | LCD column driver output  |
| C51                   | 27  | O    | 32  | 1630   | -1155  | LCD column driver output  |
| C50                   | 28  | O    | 33  | 1630   | -1055  | LCD column driver output  |
| C49                   | 29  | O    | 34  | 1630   | -955   | LCD column driver output  |
| C48                   | 30  | O    | 35  | 1630   | -735   | LCD column driver output  |
| C47                   | 31  | O    | 36  | 1630   | -635   | LCD column driver output  |
| C46                   | 32  | O    | 37  | 1630   | -535   | LCD column driver output  |
| C45                   | 33  | O    | 38  | 1630   | -435   | LCD column driver output  |
| C44                   | 34  | O    | 39  | 1630   | -335   | LCD column driver output  |
| C43                   | 35  | O    | 40  | 1630   | -235   | LCD column driver output  |
| C42                   | 36  | O    | 41  | 1630   | -135   | LCD column driver output  |
| C41                   | 37  | O    | 42  | 1630   | -35    | LCD column driver output  |
| C40                   | 38  | O    | 43  | 1630   | 65     | LCD column driver output  |
| C39                   | 39  | O    | 44  | 1630   | 165    | LCD column driver output  |
| C38                   | 40  | O    | 45  | 1630   | 265    | LCD column driver output  |
| C37                   | 41  | O    | 46  | 1630   | 365    | LCD column driver output  |

**Table 5. Pin and bonding pad description ...continued**

All x/y coordinates represent the position of the center of each pad with respect to the center (x/y = 0) of the chip (see Figure 3).

| Symbol      | Pin | Type | Pad | X (μm) | Y (μm) | Description              |
|-------------|-----|------|-----|--------|--------|--------------------------|
| C36         | 42  | O    | 47  | 1630   | 465    | LCD column driver output |
| C35         | 43  | O    | 48  | 1630   | 565    | LCD column driver output |
| C34         | 44  | O    | 49  | 1630   | 665    | LCD column driver output |
| C33         | 45  | O    | 50  | 1630   | 765    | LCD column driver output |
| C32         | 46  | O    | 51  | 1630   | 865    | LCD column driver output |
| C31         | 47  | O    | 52  | 1630   | 965    | LCD column driver output |
| C30         | 48  | O    | 53  | 1630   | 1065   | LCD column driver output |
| C29         | 49  | O    | 54  | 1630   | 1165   | LCD column driver output |
| C28         | 50  | O    | 55  | 1630   | 1265   | LCD column driver output |
| dummy pad 3 | -   | -    | 56  | 1630   | 1335   | -                        |
| dummy pad 4 | -   | -    | 57  | 1435   | 1550   | -                        |
| C27         | 51  | O    | 58  | 1335   | 1550   | LCD column driver output |
| C26         | 52  | O    | 59  | 1225   | 1550   | LCD column driver output |
| C25         | 53  | O    | 60  | 1115   | 1550   | LCD column driver output |
| C24         | 54  | O    | 61  | 1005   | 1550   | LCD column driver output |
| C23         | 55  | O    | 62  | 765    | 1550   | LCD column driver output |
| C22         | 56  | O    | 63  | 665    | 1550   | LCD column driver output |
| C21         | 57  | O    | 64  | 565    | 1550   | LCD column driver output |
| C20         | 58  | O    | 65  | 465    | 1550   | LCD column driver output |
| C19         | 59  | O    | 66  | 365    | 1550   | LCD column driver output |
| C18         | 60  | O    | 67  | 265    | 1550   | LCD column driver output |
| C17         | 61  | O    | 68  | 165    | 1550   | LCD column driver output |
| C16         | 62  | O    | 69  | 65     | 1550   | LCD column driver output |
| C15         | 63  | O    | 70  | -35    | 1550   | LCD column driver output |
| C14         | 64  | O    | 71  | -135   | 1550   | LCD column driver output |
| C13         | 65  | O    | 72  | -235   | 1550   | LCD column driver output |
| C12         | 66  | O    | 73  | -335   | 1550   | LCD column driver output |
| C11         | 67  | O    | 74  | -435   | 1550   | LCD column driver output |
| C10         | 68  | O    | 75  | -535   | 1550   | LCD column driver output |
| C9          | 69  | O    | 76  | -635   | 1550   | LCD column driver output |
| C8          | 70  | O    | 77  | -735   | 1550   | LCD column driver output |
| C7          | 71  | O    | 78  | -835   | 1550   | LCD column driver output |
| C6          | 72  | O    | 79  | -965   | 1550   | LCD column driver output |
| C5          | 73  | O    | 80  | -1065  | 1550   | LCD column driver output |
| C4          | 74  | O    | 81  | -1165  | 1550   | LCD column driver output |
| C3          | 75  | O    | 82  | -1265  | 1550   | LCD column driver output |
| dummy pad 5 | -   | -    | 83  | -1465  | 1550   | -                        |
| dummy pad 6 | -   | -    | 84  | -1630  | 1355   | -                        |
| C2          | 76  | O    | 85  | -1630  | 1255   | LCD column driver output |



**Table 5. Pin and bonding pad description ...continued**

All x/y coordinates represent the position of the center of each pad with respect to the center (x/y = 0) of the chip (see Figure 3).

| Symbol           | Pin | Type | Pad | X (μm) | Y (μm) | Description  |
|------------------|-----|------|-----|--------|--------|--|
| C1               | 77  | O    | 86  | -1 630 | 1 185  | LCD column driver output   |
| R8               | 78  | O    | 87  | -1 630 | 1 115  | LCD row driver output  |
| R7               | 79  | O    | 88  | -1 630 | 1 045  | LCD row driver output  |
| R6               | 80  | O    | 89  | -1 630 | 975    | LCD row driver output  |
| R5               | 81  | O    | 90  | -1 630 | 905    | LCD row driver output  |
| R4               | 82  | O    | 91  | -1 630 | 835    | LCD row driver output  |
| R3               | 83  | O    | 92  | -1 630 | 765    | LCD row driver output  |
| R2               | 84  | O    | 93  | -1 630 | 695    | LCD row driver output  |
| R1               | 85  | O    | 94  | -1 630 | 625    | LCD row driver output  |
| R17              | 86  | O    | 95  | -1 630 | 555    | LCD row driver output  |
| SCL              | 87  | I    | 96  | -1 630 | 375    | I <sup>2</sup> C-bus serial clock input <a href="#">[4]</a>                                |
| SDA              | 88  | I/O  | 97  | -1 630 | 305    | I <sup>2</sup> C-bus serial data input/output <a href="#">[4]</a>                          |
| E                | 89  | I    | 98  | -1 630 | 85     | data bus clock input <a href="#">[4]</a>   |
| RS               | 90  | I    | 99  | -1 630 | -15    | register select input  |
| R $\overline{W}$ | 91  | I    | 100 | -1 630 | -115   | read or write input  |
| DB7              | 92  | I/O  | 101 | -1 630 | -215   | 8-bit bidirectional bus bit 7 <a href="#">[5]</a>  |
| DB6              | 93  | I/O  | 102 | -1 630 | -315   | 8-bit bidirectional bus bit 6  |
| DB5              | 94  | I/O  | 103 | -1 630 | -415   | 8-bit bidirectional bus bit 5  |
| DB4              | 95  | I/O  | 104 | -1 630 | -515   | 8-bit bidirectional bus bit 4  |
| DB3/SA0          | 96  | I/O  | 105 | -1 630 | -615   | 8-bit bidirectional bus bit 3 or I <sup>2</sup> C-bus address input <a href="#">[4][5]</a> |
| DB2              | 97  | I/O  | 106 | -1 630 | -715   | 8-bit bidirectional bus bit 2  |
| DB1              | 98  | I/O  | 107 | -1 630 | -815   | 8-bit bidirectional bus bit 1  |
| DB0              | 99  | I/O  | 108 | -1 630 | -915   | 8-bit bidirectional bus bit 0  |
| V <sub>DD2</sub> | 100 | P    | 109 | -1 630 | -1 015 | supply voltage 2 for V <sub>LCD</sub> generator <a href="#">[6]</a>                        |
| V <sub>DD3</sub> | -   | P    | 110 | -1 630 | -1 235 | supply voltage 3 for V <sub>LCD</sub> generator <a href="#">[3][6]</a>                     |
| dummy pad 7      | -   | -    | 111 | -1 630 | -1 395 | -  |
| dummy pad 8      | -   | -    | 112 | -1 465 | -1 550 | -  |

[1] When the on-chip oscillator is used this pad must be connected to V<sub>DD1</sub>.

[2] When V<sub>LCD</sub> is generated internally, pins V<sub>LCDIN</sub>, V<sub>LCDOUT</sub> and V<sub>LCDSENSE</sub> must be connected together. When an external V<sub>LCD</sub> is supplied, this should be done via V<sub>LCDIN</sub>. In this case only pins V<sub>LCDOUT</sub> and V<sub>LCDSENSE</sub> must be connected together.

[3] In the LQFP100 version this signal is connected internally and is not accessible.

[4] When the I<sup>2</sup>C-bus is used, the parallel interface pin E must be LOW. In the I<sup>2</sup>C-bus read mode pins DB7 to DB0 must be connected to V<sub>DD1</sub> or left open-circuit.

When the parallel bus is used, the pins SCL and SDA must be connected to pin V<sub>SS1</sub> or pin V<sub>DD1</sub>; they must not be left open-circuit.

When the 4-bit interface is used without reading out from the PCF2113x (bit R $\overline{W}$  is set permanently to logic 0), the unused ports DB0 to DB3 can either be connected to V<sub>SS1</sub> or V<sub>DD1</sub> instead of leaving them open-circuit.

[5] DB7 may be used as the busy flag, signalling that internal operations are not yet completed. In 4-bit operations the four higher order lines DB7 to DB4 are used; DB3 to DB0 must be left open-circuit except for I<sup>2</sup>C-bus operations (see [Table note 4](#)).

[6] V<sub>DD2</sub> and V<sub>DD3</sub> must always be equal.

## 8. Functional description

### 8.1 LCD supply voltage generator

The LCD supply voltage ( $V_{LCD}$ ) may be generated on-chip. The  $V_{LCD}$  generator is controlled by two internal 6-bit registers: VA and VB. [Section 10.10.1](#) shows how to program these registers. The nominal LCD operating voltage at room temperature is given by the relationship:

$$V_{oper(nom)} = (\text{integer value of register} \times 0.08 \text{ V}) + 1.82 \text{ V}$$

With a programmed value from 1 to 63,  $V_{oper(nom)} = 1.90 \text{ V}$  to  $6.86 \text{ V}$  at  $T_{amb} = 27 \text{ }^\circ\text{C}$ .

Values producing more than 6.5 V at operating temperature are not allowed. Operation above this voltage may damage the device. When programming the operating voltage the  $V_{LCD}$  tolerance and temperature coefficient must be taken into account.

Values below 2.2 V are below the specified operating range of the chip and therefore are not allowed.

Value 0 for VA and VB switches off the generator (i.e. VA = 0 in Character mode, VB = 0 in Icon mode).

Usually register VA is programmed with the voltage for Character mode and register VB with the voltage for Icon mode.

When  $V_{LCD}$  is generated on-chip, the  $V_{LCD}$  pins must be decoupled to  $V_{SS}$  with a suitable capacitor.

The generated  $V_{LCD}$  is independent of  $V_{DD}$  and is temperature compensated. When the  $V_{LCD}$  generator and the Direct mode are switched off, an external voltage may be supplied at pins  $V_{LCDIN}$  and  $V_{LCDOUT}$  (which are connected together).  $V_{LCDIN}$  and  $V_{LCDOUT}$  may be higher or lower than  $V_{DD2}$ .

During Direct mode (program DM bit) the internal  $V_{LCD}$  generator is turned off and the  $V_{LCDOUT}$  output voltage is directly connected to  $V_{DD2}$ . This reduces the current consumption during Icon mode and MUX 1:9 (depending on  $V_{DD2}$  and LCD liquid properties).

The  $V_{LCD}$  generator ensures that, as long as  $V_{DD}$  is in the valid range (2.2 V to 4 V), the required peak operating voltage of 6.5 V can be generated at any time.

### 8.2 LCD bias voltage generator

The intermediate bias voltages for the LCD display are also generated on-chip. This removes the need for an external resistive bias chain and significantly reduces the system current consumption. The optimum value of  $V_{LCD}$  depends on the multiplex rate, the LCD threshold voltage ( $V_{th}$ ) and the number of bias levels. Using a 5-level bias scheme for 1:18 maximum rate allows  $V_{LCD} < 5 \text{ V}$  for most LCD liquids. The intermediate bias levels for the different multiplex rates are shown in [Table 6](#). These bias levels are automatically set to the given values when switching to the corresponding multiplex rate.

**Table 6. Bias levels as a function of multiplex rate**

| Multiplex rate | Number of levels | Bias voltages <sup>[1]</sup> |                |                |                |                |                 |
|----------------|------------------|------------------------------|----------------|----------------|----------------|----------------|-----------------|
|                |                  | V <sub>1</sub>               | V <sub>2</sub> | V <sub>3</sub> | V <sub>4</sub> | V <sub>5</sub> | V <sub>6</sub>  |
| 1:18           | 5                | V <sub>LCD</sub>             | 3/4            | 1/2            | 1/2            | 1/4            | V <sub>SS</sub> |
| 1:9            | 5                | V <sub>LCD</sub>             | 3/4            | 1/2            | 1/2            | 1/4            | V <sub>SS</sub> |
| 1:2            | 4                | V <sub>LCD</sub>             | 2/3            | 2/3            | 1/3            | 1/3            | V <sub>SS</sub> |

[1] The values in the table are given relative to V<sub>LCD</sub> – V<sub>SS</sub>, e.g. 3/4 means {3/4 × (V<sub>LCD</sub> – V<sub>SS</sub>)} + V<sub>SS</sub>.

### 8.3 Oscillator

The on-chip oscillator provides the clock signal for the display system. No external components are required and the OSC pin must be connected to V<sub>DD1</sub>.

### 8.4 External clock

If an external clock is to be used, this input is at the OSC pin. The resulting display frame

frequency is given by:  $f_{fr(LCD)} = \frac{f_{osc}}{3072}$

Only in the Power-down mode is the clock allowed to be stopped (pin OSC connected to V<sub>SS</sub>), otherwise the LCD is frozen in a DC state.

### 8.5 Power-on reset

The on-chip power-on reset block initializes the chip after power-on or power failure. This is a synchronous reset and requires 3 oscillator cycles to be executed.

### 8.6 Registers

The PCF2113x has two 8-bit registers: an Instruction Register (IR) and a Data Register (DR). The Register Select (RS) signal determines which register will be accessed. The instruction register stores instruction codes such as ‘display clear’, ‘cursor shift’, and address information for the Display Data RAM (DDRAM) and Character Generator RAM (CGRAM). The instruction register can be written to but not read from by the system controller.

The data register temporarily stores data to be read from the DDRAM and CGRAM. When reading, data from the DDRAM or CGRAM corresponding to the address in the instruction register is written to the data register prior to being read by the ‘read data’ instruction.

### 8.7 Busy flag

The busy flag indicates the internal status of the PCF2113x. A logic 1 indicates that the chip is busy and further instructions will not be accepted. The busy flag is output to pin DB7 when bit RS = 0 and bit R/W = 1. Instructions must only be written after checking that the busy flag is at logic 0 or waiting for the required number of cycles.

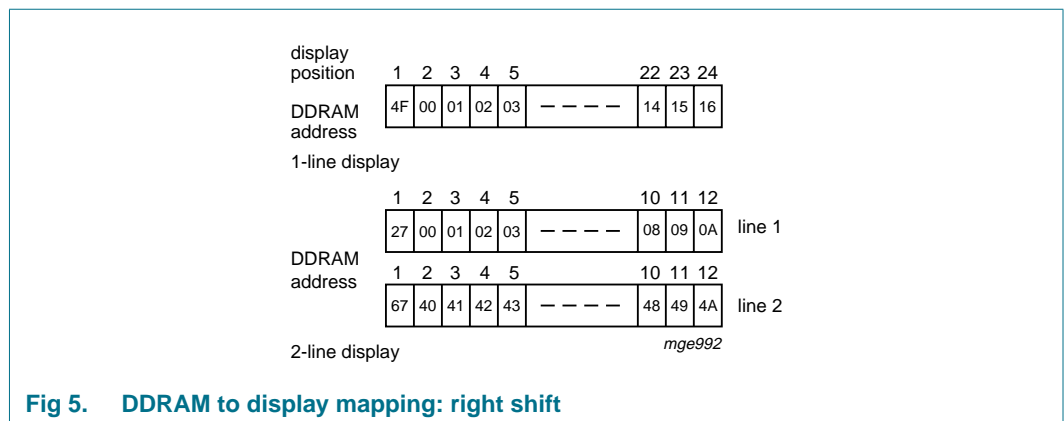
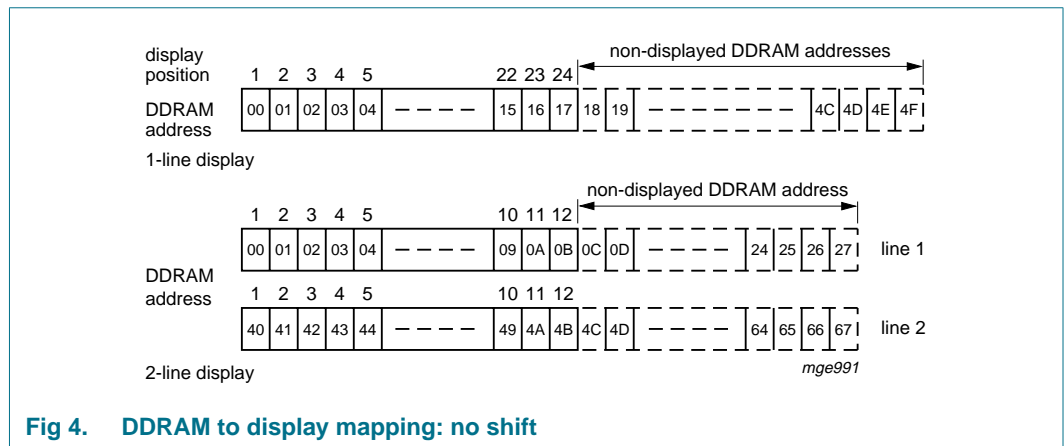
### 8.8 Address counter

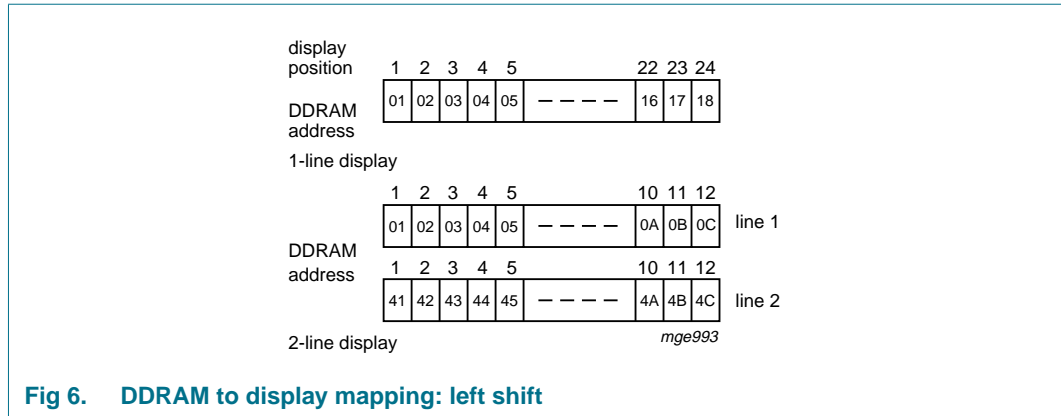
The Address Counter (AC) assigns addresses to the DDRAM and CGRAM for reading and writing and is set by the commands 'set DDRAM address' and 'set CGRAM address'. After a read/write operation the address counter is automatically incremented or decremented by 1. The address counter contents are output to the bus (DB6 to DB0) when bit RS = 0 and bit R/W = 1.

### 8.9 Display data RAM

The Display Data RAM (DDRAM) stores up to 80 characters of display data represented by 8-bit character codes. RAM locations which are not used for storing display data can be used as general purpose RAM. The basic RAM to display addressing scheme is shown in [Figure 4](#). With no display shift the characters represented by the codes in the first 24 RAM locations starting at address 00h in line 1 are displayed. [Figure 5](#) and [Figure 6](#) show the display mapping for right and left shift respectively.

When data is written to or read from the DDRAM, wrap-around occurs from the end of one line to the start of the next line. When the display is shifted each line wraps around within itself, independently of the others. Thus all lines are shifted and wrapped around together. The address ranges and wrap-around operations for the various modes are shown in [Table 7](#).





**Fig 6. DDRAM to display mapping: left shift**

**Table 7. Address space and wrap-around operation**

| Mode  | 1 × 24     | 2 × 12                 | 1 × 12     |
|---|------------|------------------------|------------|
| Address space                                 | 00h to 4Fh | 00h to 27h; 40h to 67h | 00h to 27h |
| Read/write wrap-around (moves to next line)   | 4Fh to 00h | 27h to 40h; 67h to 00h | 27h to 00h |
| Display shift wrap-around (stays within line) | 4Fh to 00h | 27h to 00h; 67h to 40h | 27h to 00h |

### 8.10 Character generator ROM

The Character Generator ROM (CGROM) generates 240 character patterns in a 5 × 8 dot format from 8-bit character codes. [Figure 7](#), [Figure 8](#), [Figure 9](#) and [Figure 10](#) show the character sets that are currently implemented.

| upper<br>4 bits<br>lower<br>4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|------------------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000                          | 1    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0001                          | 2    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0010                          | 3    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0011                          | 4    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0100                          | 5    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0101                          | 6    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0110                          | 7    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0111                          | 8    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1000                          | 9    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1001                          | 10   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1010                          | 11   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1011                          | 12   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1100                          | 13   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1101                          | 14   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1110                          | 15   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1111                          | 16   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |

m1b245

The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 7. Character set 'A' in CGROM

| upper<br>lower<br>4 bits<br>4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|------------------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000                          | 1    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 0001                          | 2    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 0010                          | 3    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 0011                          | 4    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 0100                          | 5    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 0101                          | 6    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 0110                          | 7    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 0111                          | 8    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 1000                          | 9    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 1001                          | 10   | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 1010                          | 11   | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 1011                          | 12   | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 1100                          | 13   | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 1101                          | 14   | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 1110                          | 15   | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |
| xxxx 1111                          | 16   | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    | Q    |

mgd688

The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 8. Character set 'D' in CGROM

| upper<br>lower<br>4 bits<br>4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|------------------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000                          | 1    | D    | E    | F    | G    | H    | I    | J    | K    | L    | M    | N    | O    | P    | Q    | R    |
| xxxx 0001                          | 2    | S    | T    | U    | V    | W    | X    | Y    | Z    | [    | \    | ]    | ^    | _    | 0    | 1    |
| xxxx 0010                          | 3    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    | ?    | @    |
| xxxx 0011                          | 4    | A    | B    | C    | D    | E    | F    | G    | H    | I    | J    | K    | L    | M    | N    | O    |
| xxxx 0100                          | 5    | P    | Q    | R    | S    | T    | U    | V    | W    | X    | Y    | Z    | [    | \    | ]    | ^    |
| xxxx 0101                          | 6    | a    | b    | c    | d    | e    | f    | g    | h    | i    | j    | k    | l    | m    | n    | o    |
| xxxx 0110                          | 7    | p    | q    | r    | s    | t    | u    | v    | w    | x    | y    | z    | {    |      | }    | ~    |
| xxxx 0111                          | 8    | 0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    |
| xxxx 1000                          | 9    | 0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    |
| xxxx 1001                          | 10   | 0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    |
| xxxx 1010                          | 11   | 0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    |
| xxxx 1011                          | 12   | 0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    |
| xxxx 1100                          | 13   | 0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    |
| xxxx 1101                          | 14   | 0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    |
| xxxx 1110                          | 15   | 0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    |
| xxxx 1111                          | 16   | 0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | :    | ;    | <    | =    | >    |

mgd689

The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 9. Character set 'E' in CGROM



| upper<br>4 bits<br>lower<br>4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|------------------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000                          | 1    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0001                          | 2    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0010                          | 3    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0011                          | 4    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0100                          | 5    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0101                          | 6    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0110                          | 7    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 0111                          | 8    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1000                          | 9    |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1001                          | 10   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1010                          | 11   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1011                          | 12   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1100                          | 13   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1101                          | 14   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1110                          | 15   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |
| xxxx 1111                          | 16   |      |      |      |      |      |      |      |      |      |      |      |      |      |      |      |

mgu204

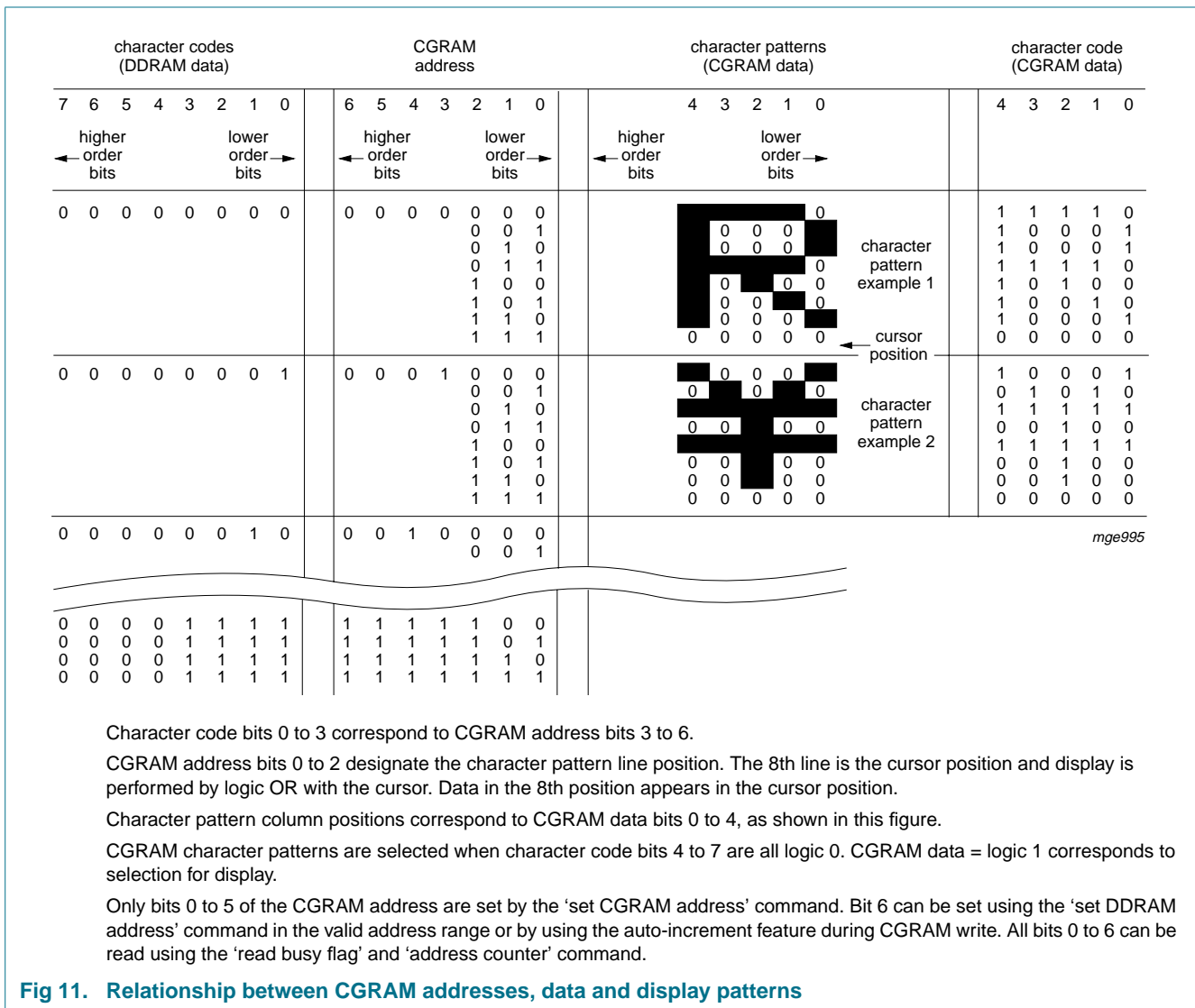
The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 10. Character set 'W' in CGROM

### 8.11 Character generator RAM

Up to 16 user-defined characters may be stored in the Character Generator RAM (CGRAM). Some CGRAM characters (see [Figure 18](#) and [Figure 19](#)) are also used to drive icons (6 if icons blink and both icon rows are used in the application; 3 if no blink but both icon rows are used in the application; 0 if no icons are driven by the icon rows). The CGROM and CGRAM use a common address space, of which the first column is reserved for the CGRAM (see [Figure 7](#), [Figure 8](#), [Figure 9](#) and [Figure 10](#)).

[Figure 11](#) shows the addressing principle for the CGRAM.



Character code bits 0 to 3 correspond to CGRAM address bits 3 to 6.

CGRAM address bits 0 to 2 designate the character pattern line position. The 8th line is the cursor position and display is performed by logic OR with the cursor. Data in the 8th position appears in the cursor position.

Character pattern column positions correspond to CGRAM data bits 0 to 4, as shown in this figure.

CGRAM character patterns are selected when character code bits 4 to 7 are all logic 0. CGRAM data = logic 1 corresponds to selection for display.

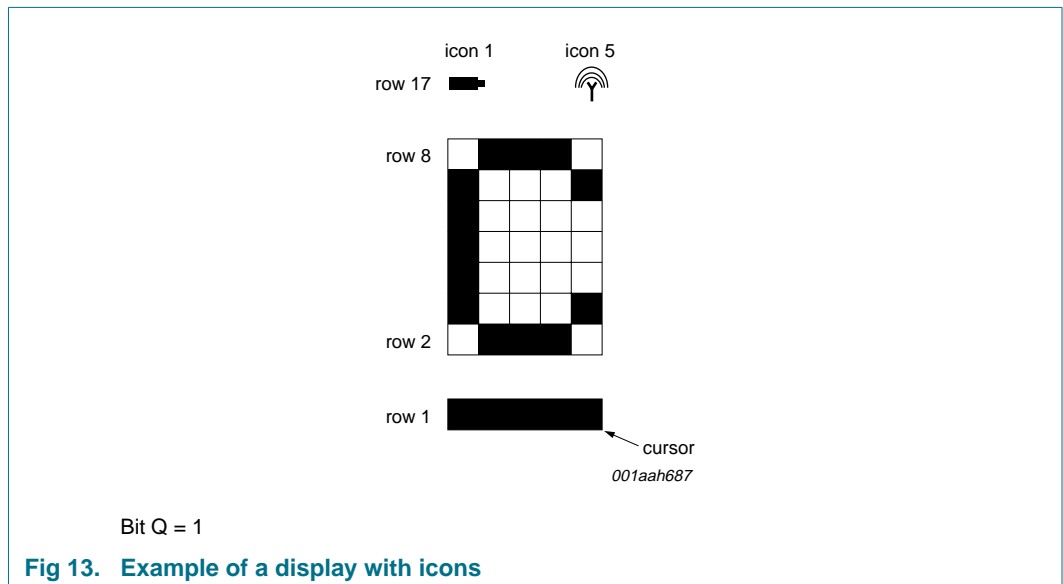
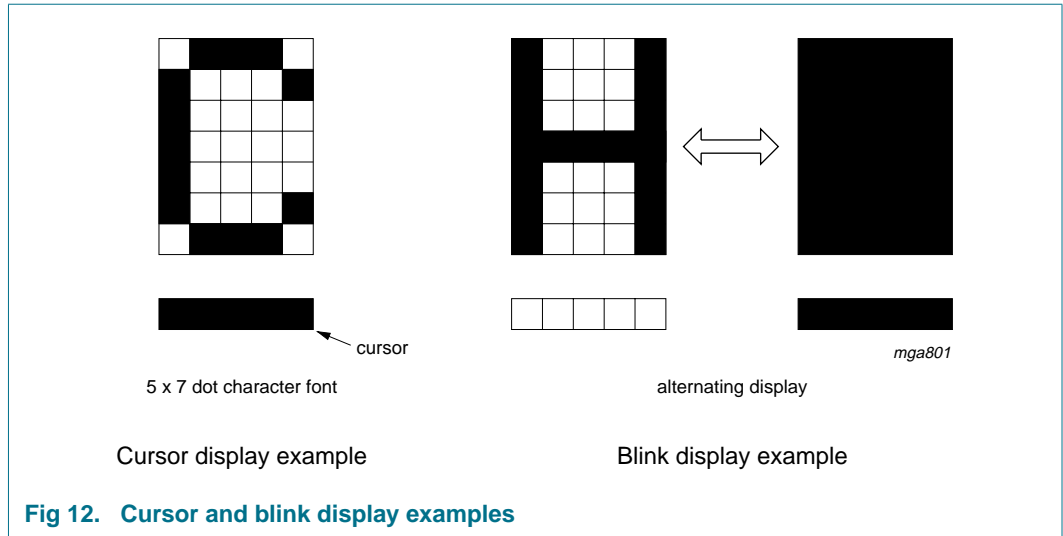
Only bits 0 to 5 of the CGRAM address are set by the 'set CGRAM address' command. Bit 6 can be set using the 'set DDRAM address' command in the valid address range or by using the auto-increment feature during CGRAM write. All bits 0 to 6 can be read using the 'read busy flag' and 'address counter' command.

Fig 11. Relationship between CGRAM addresses, data and display patterns

### 8.12 Cursor control circuit

The cursor control circuit generates the cursor underline and/or cursor blink as shown in [Figure 12](#) at the DDRAM address contained in the address counter.

When the address counter contains the CGRAM address the cursor will be inhibited.



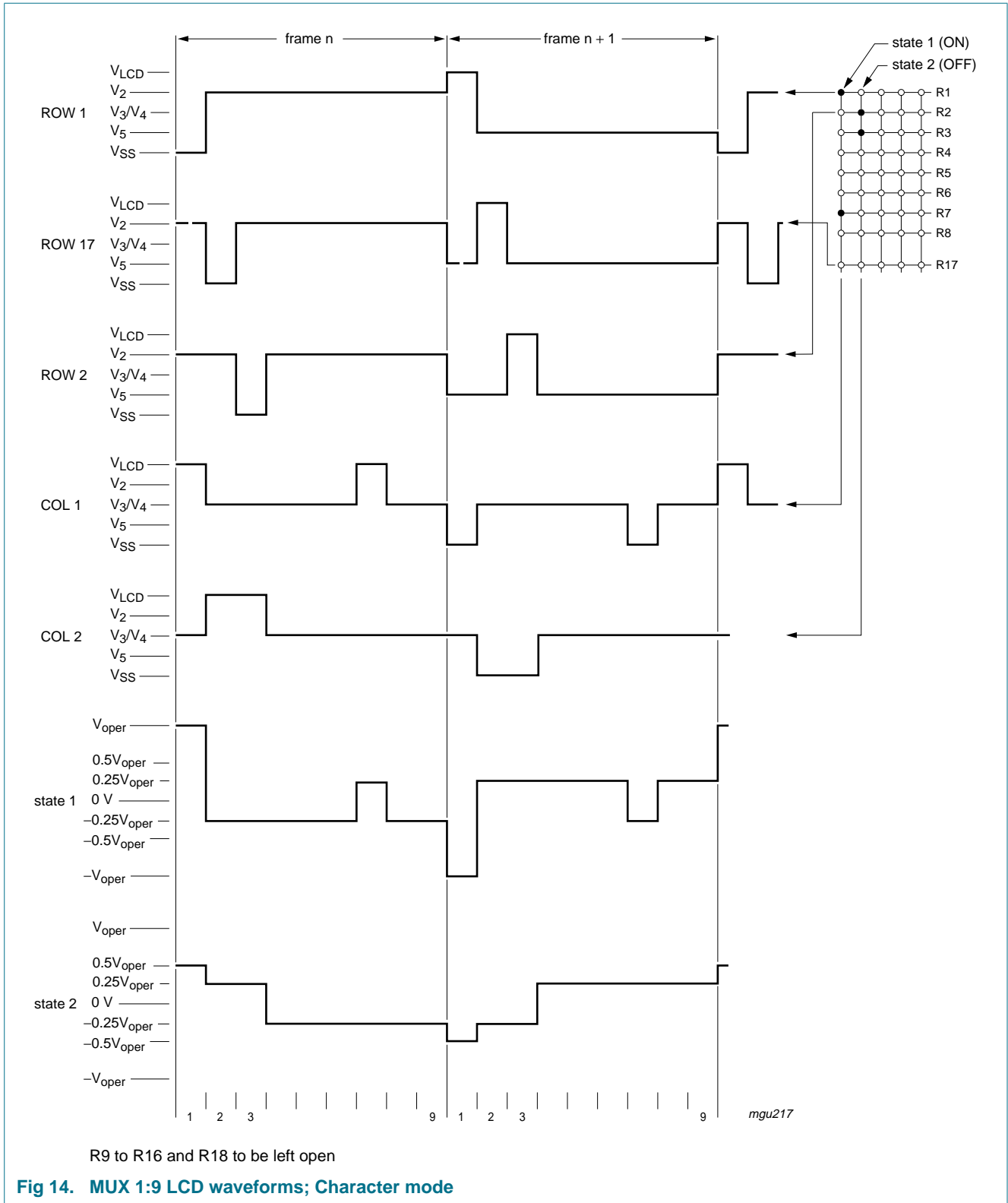
**8.13 Timing generator**

The timing generator produces the various signals required to drive the internal circuitry. Internal chip operation is not disturbed by operations on the data buses.

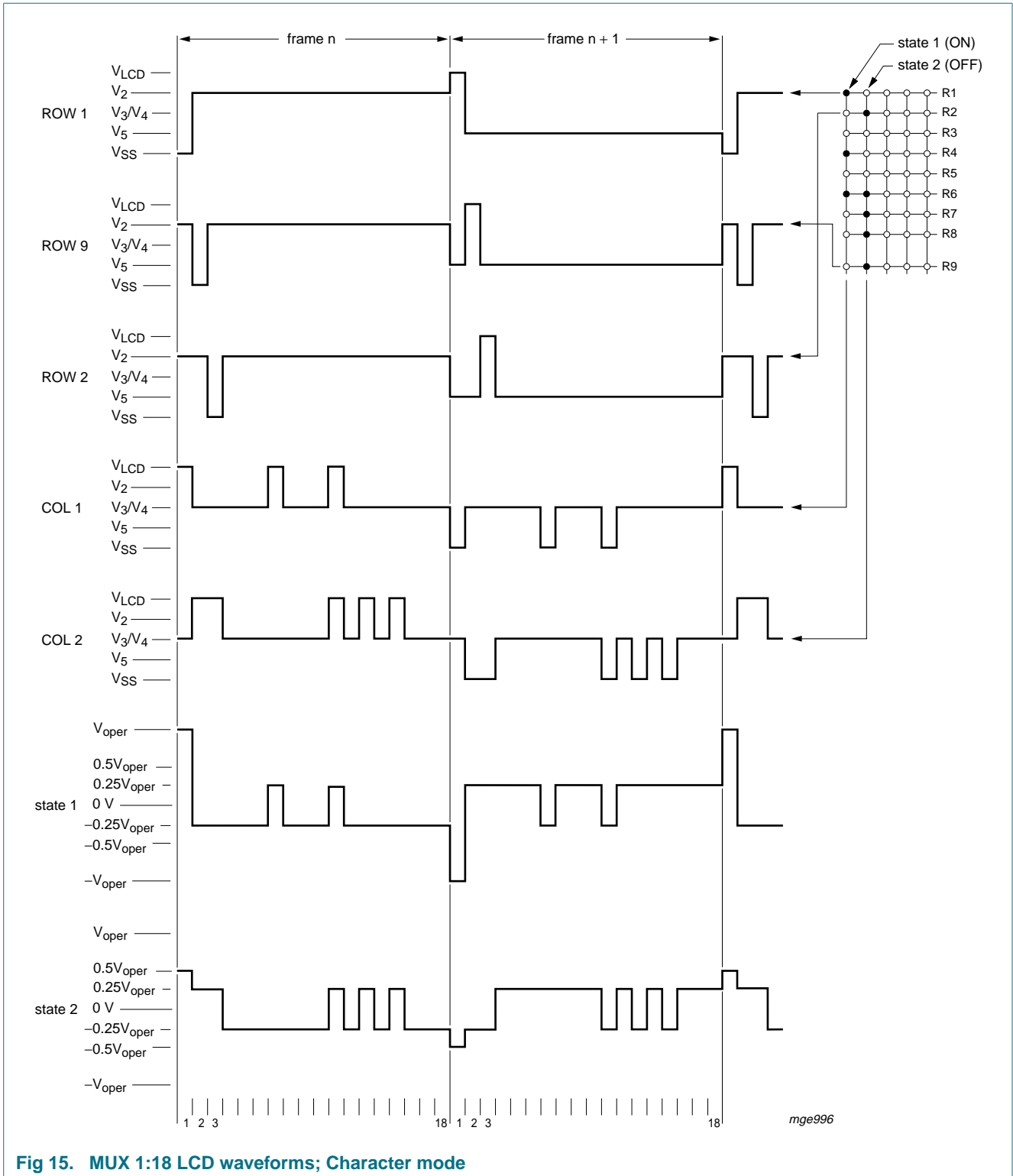
**8.14 LCD row and column drivers**

The PCF2113x contains 18 row and 60 column drivers, which connect the appropriate LCD bias voltages in sequence to the display in accordance with the data to be displayed. R17 and R18 drive the icon rows.

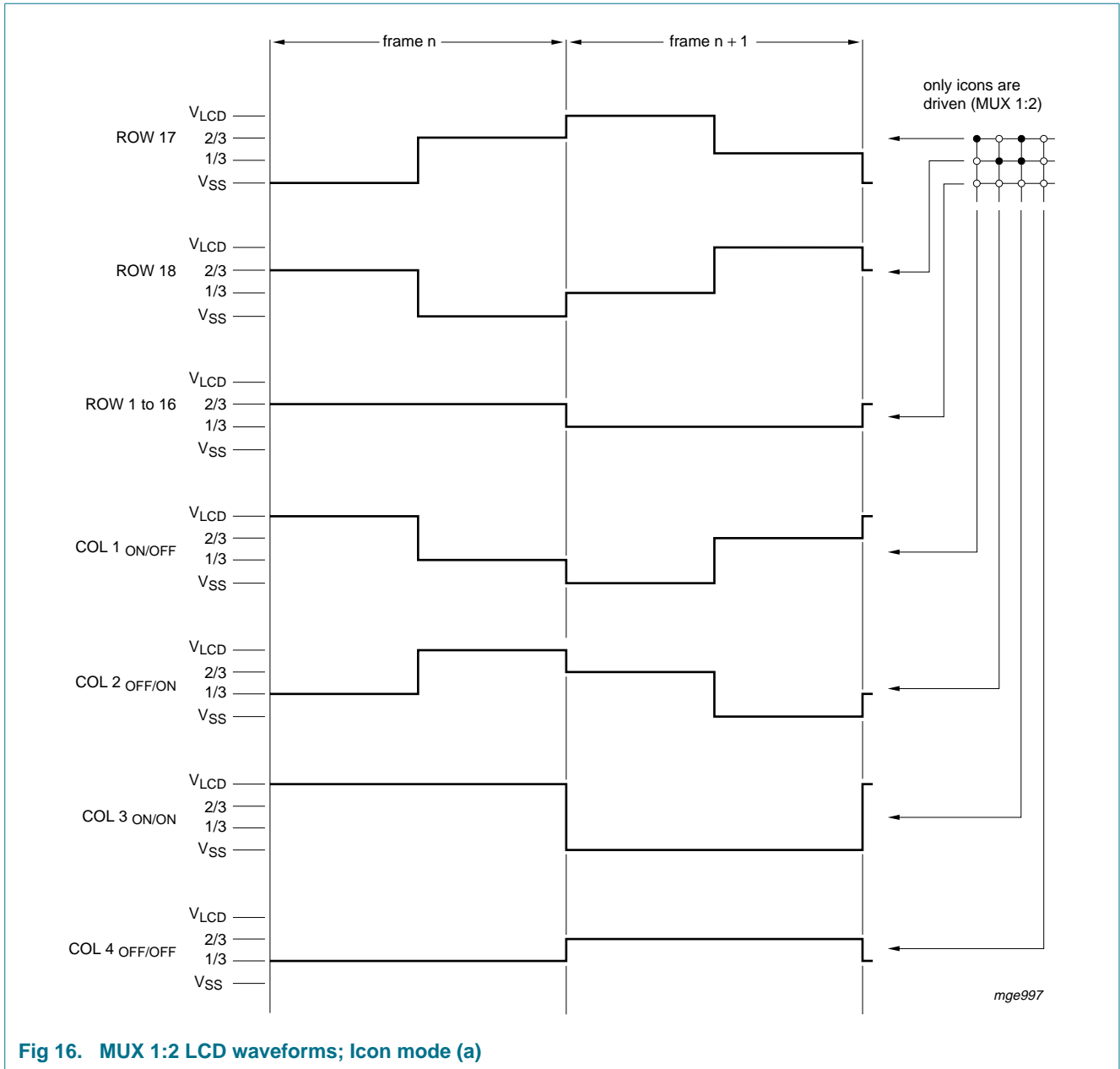
The bias voltages and the timing are selected automatically when the number of lines in the display is selected. [Figure 14](#), [Figure 15](#), [Figure 16](#) and [Figure 17](#) show typical waveforms. Unused outputs should be left unconnected.



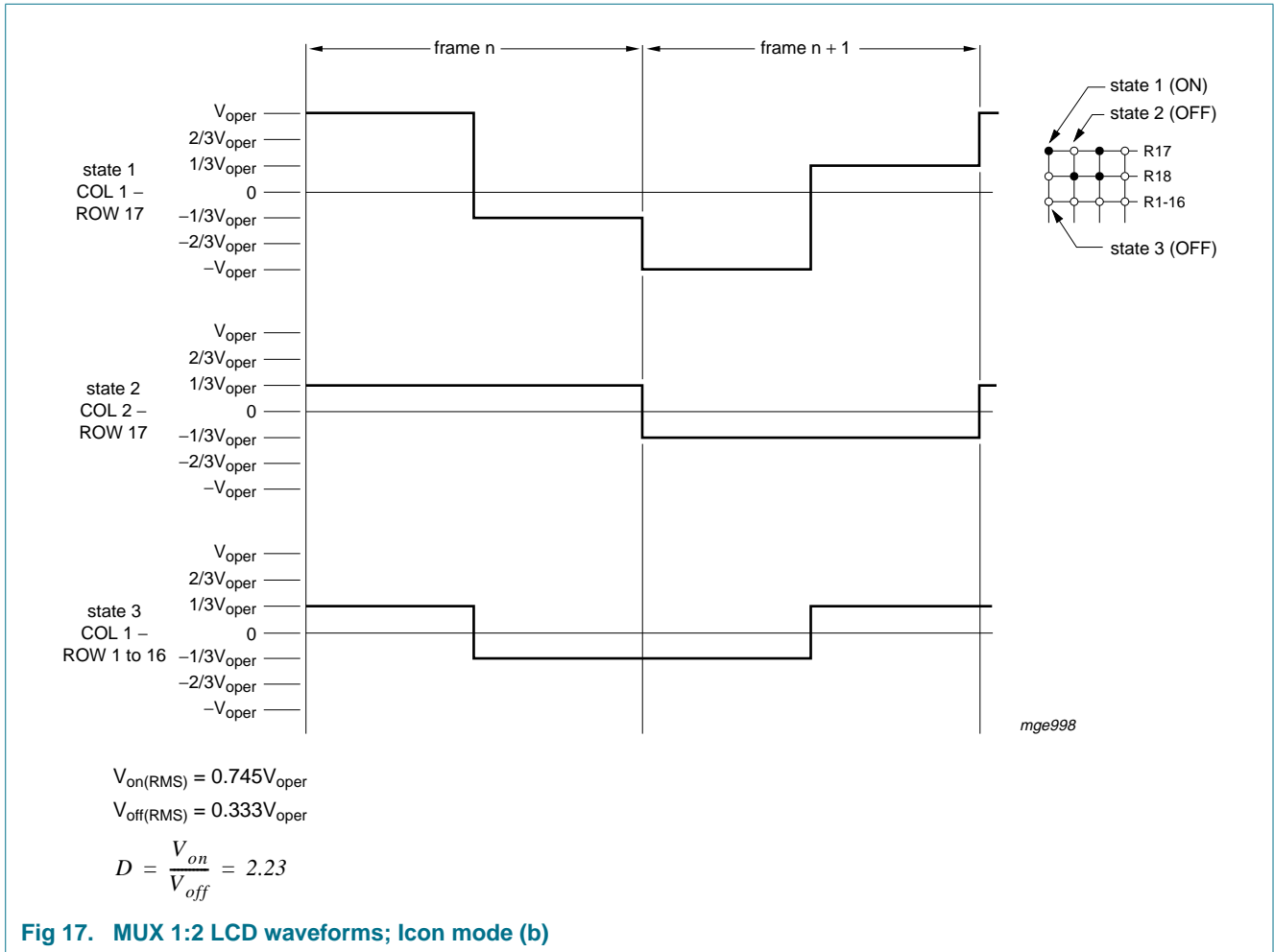
**Fig 14. MUX 1:9 LCD waveforms; Character mode**



**Fig 15. MUX 1:18 LCD waveforms; Character mode**



**Fig 16. MUX 1:2 LCD waveforms; Icon mode (a)**



### 8.15 Power-down mode

The chip can be put into Power-down mode by applying an external HIGH level to the PD pin. In Power-down mode all static currents are switched off (no internal oscillator, no bias level generation and all LCD outputs are internally connected to V<sub>SS</sub>).

During power-down, information in the RAMs and the chip state are preserved. Instruction execution during power-down is possible when pin OSC is externally clocked.

### 8.16 Reset function

The PCF2113x automatically initializes (resets) when power is turned on. The chip executes a reset sequence, including a 'clear display', requiring 165 oscillator cycles. After the reset the chip has the state shown in [Table 8](#).

**Table 8. State after reset**

| Step | Function                                 | Control bit state  | Conditions  |
|------|--|--|---|
| 1    | clear display                            |  |   |
| 2    | entry mode set                           | I/D = 1<br>S = 0   | +1 (increment)<br>no shift  |
| 3    | display control                          | D = 0<br>C = 0<br>B = 0  | display off<br>cursor off<br>cursor character blink off   |
| 4    | function set                             | DL = 1<br>M = 0<br>H = 0<br>SL = 0   | 8-bit interface<br>1-line display<br>normal instruction set<br>MUX 1:18 mode  |
| 5    | default address pointer to DDRAM         | the Busy Flag (BF) indicates the busy state (BF = 1) until initialization ends | the busy state lasts 2 ms; the chip may also be initialized by software; see <a href="#">Table 26</a> (8-bit interface) and <a href="#">Table 27</a> (4-bit interface). |
| 6    | icon control                             | IM = 0; IB = 0; DM = 0   | icons, icon blink and Direct mode disabled  |
| 7    | display or screen configuration          | L = 0; P = 0; Q = 0  | default configurations  |
| 8    | V <sub>LCD</sub> temperature coefficient | TC1 = 0; TC2 = 0   | default temperature coefficient   |
| 9    | set V <sub>LCD</sub>                     | VA = 0; VB = 0   | V <sub>LCD</sub> generator off  |
| 10   | I <sup>2</sup> C-bus interface reset     |  |   |
| 11   | set HVgen stages                         | S1 = 1; S0 = 0   | V <sub>LCD</sub> generator voltage multiplier set at factor 4   |

## 9. Instructions

Only two PCF2113x registers, the Instruction Register (IR) and the Data Register (DR), can be directly controlled by the microcontroller. Before internal operation, control information is stored temporarily in these registers to allow interfacing to various types of microcontrollers which operate at different speeds or to allow interfacing to peripheral control ICs.

The instruction set for I<sup>2</sup>C-bus commands is given in [Table 9](#). [Section 11.2.1](#) discusses how these control and command bytes are embedded in the I<sup>2</sup>C-bus protocol.

**Table 9. Instruction set for I<sup>2</sup>C-bus commands**

| I <sup>2</sup> C-bus commands | Control byte                     | Command byte                    | I <sup>2</sup> C-bus commands |
|-------------------------------|----------------------------------|---------------------------------|-------------------------------|
| <a href="#">[1]</a>           | Co <sup>[2]</sup> RS 0 0 0 0 0 0 | DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 | <a href="#">[1]</a>           |

[1] R/W is set together with the slave address.

[2] For explanation, see [Table 11](#).

The PCF2113x operation is controlled by the instructions shown in [Table 10](#) together with their execution time. Details are explained in subsequent sections.



There are 4 types of instructions:

- Designate PCF2113x functions such as display format, data length
- Set internal RAM addresses
- Perform data transfer with internal RAM
- Other functions

In normal use, data transfer instructions are used most frequently. However, automatic incrementing by 1 (or decrementing by 1) of internal RAM addresses after each data write lessens the microcontroller program load. The display shift in particular can be performed concurrently with display data write, enabling the designer to develop systems in minimum time with maximum programming efficiency.

During internal operation, no instructions other than the ‘read busy flag’ and ‘read address’ instructions will be executed. Because the busy flag is set to logic 1 while an instruction is being executed, check to ensure it is logic 0 before sending the next instruction or wait for the maximum instruction execution time, as given in [Table 10](#). An instruction sent while the busy flag is logic 1 will not be executed.

**Table 10. Instruction set with parallel bus commands**

| Instruction                                      | Control and command bits |             |            |     |     |     |     |     |     |     | Description <sup>[1]</sup>  | Required clock cycles |
|--|--------------------------|-------------|------------|-----|-----|-----|-----|-----|-----|-----|---|-----------------------|
|  | RS                       | R $\bar{W}$ | DB7        | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |   |                       |
| <b>H = 0 or 1 (basic and extended functions)</b> |                          |             |            |     |     |     |     |     |     |     |   |                       |
| NOP  | 0                        | 0           | 0          | 0   | 0   | 0   | 0   | 0   | 0   | 0   | no operation  | 3                     |
| Function set                                     | 0                        | 0           | 0          | 0   | 1   | DL  | 0   | M   | SL  | H   | sets interface Data Length (DL), number of display lines (M), single line/MUX 1:9 (SL) and extended instruction set control (H) | 3                     |
| Read busy flag and address counter               | 0                        | 1           | BF         | AC  |     |     |     |     |     |     | reads the Busy Flag (BF), indicating internal operating is being performed, and the Address Counter (AC)                        | 0                     |
| Read data  | 1                        | 1           | read data  |     |     |     |     |     |     |     | reads data from CGRAM or DDRAM  | 3                     |
| Write data                                       | 1                        | 0           | write data |     |     |     |     |     |     |     | writes data to CGRAM or DDRAM   | 3                     |
| <b>H = 0 (basic functions)</b>                   |                          |             |            |     |     |     |     |     |     |     |   |                       |
| Clear display                                    | 0                        | 0           | 0          | 0   | 0   | 0   | 0   | 0   | 0   | 1   | clears entire display and sets DDRAM address 0 in address counter   | 165                   |
| Return home                                      | 0                        | 0           | 0          | 0   | 0   | 0   | 0   | 0   | 1   | 0   | sets DDRAM address 0 in address counter; also returns shifted display to original position; DDRAM contents remain unchanged     | 3                     |

Table 10. Instruction set with parallel bus commands ...continued

| Instruction                       | Control and command bits |     |     |     |         |     |     |     |     |                    | Description <sup>[1]</sup>   | Required clock cycles |
|-----------------------------------|--------------------------|-----|-----|-----|---------|-----|-----|-----|-----|--------------------|--|-----------------------|
|                                   | RS                       | R/W | DB7 | DB6 | DB5     | DB4 | DB3 | DB2 | DB1 | DB0                |  |                       |
| Entry mode set                    | 0                        | 0   | 0   | 0   | 0       | 0   | 0   | 1   | I/D | S                  | sets cursor move direction (I/D) and specifies shift of display (S); these operations are performed during data write and read | 3                     |
| Display control                   | 0                        | 0   | 0   | 0   | 0       | 0   | 1   | D   | C   | B                  | sets entire display on/off (D), cursor on/off (C) and blink of cursor position character (B)                                   | 3                     |
| Cursor/display shift              | 0                        | 0   | 0   | 0   | 0       | 1   | S/C | R/L | 0   | 0                  | moves cursor or shifts display (S/C) to right or left (R/L) without changing the DDRAM contents                                | 3                     |
| Set CGRAM address                 | 0                        | 0   | 0   | 1   | ACG     |     |     |     |     |                    | sets CGRAM address; bit DB6 is to be set by the command 'set DDRAM address'; the descriptions of the commands provide details  | 3                     |
| Set DDRAM address                 | 0                        | 0   | 1   | ADD |         |     |     |     |     | sets DDRAM address | 3  |                       |
| <b>H = 1 (extended functions)</b> |                          |     |     |     |         |     |     |     |     |                    |  |                       |
| Reserved                          | 0                        | 0   | 0   | 0   | 0       | 0   | 0   | 0   | 0   | 1                  | do not use   | -                     |
| Screen configuration              | 0                        | 0   | 0   | 0   | 0       | 0   | 0   | 0   | 1   | L                  | set screen configuration (L)   | 3                     |
| Display configuration             | 0                        | 0   | 0   | 0   | 0       | 0   | 0   | 1   | P   | Q                  | set display configuration, columns (P) and rows (Q)  | 3                     |
| Icon control                      | 0                        | 0   | 0   | 0   | 0       | 0   | 1   | IM  | IB  | DM                 | set Icon mode (IM), icon blink (IB), Direct mode (DM)  | 3                     |
| Temperature control               | 0                        | 0   | 0   | 0   | 0       | 1   | 0   | 0   | TC1 | TC2                | set temperature coefficient (TC1 and TC2)  | 3                     |
| Set HVgen stages                  | 0                        | 0   | 0   | 1   | 0       | 0   | 0   | 0   | S1  | S0                 | set internal V <sub>LCD</sub> generator voltage multiplier stages (S1 = 1 and S0 = 1 are not allowed)                          | 3                     |
| Set V <sub>LCD</sub>              | 0                        | 0   | 1   | V   | voltage |     |     |     |     |                    | store V <sub>LCD</sub> in register VA or in register VB (V)  | 3                     |

[1] For explanation of symbols, see [Table 11](#).

**Table 11. Explanation of symbols**

| Bit                              | Logic 0   | Logic 1   |
|----------------------------------|---|---|
| Co                               | last control byte   | another control byte follows after data/command   |
| RS                               | select instruction register   | select data register  |
| DL                               | data length: 4 bits   | data length: 8 bits   |
| M (no impact if SL = 1)          | 1 line × 24 character display   | 2 line × 12 character display   |
| SL                               | MUX 1:18 (1 line × 24 character or 2 line × 12 character display)                             | MUX 1:9 (1 line × 12 character display)   |
| H                                | use basic instruction set   | use extended instruction set  |
| I/D                              | decrement   | increment   |
| S                                | display freeze  | display shift   |
| D                                | display off   | display on  |
| C                                | cursor off  | cursor on   |
| B                                | cursor character blink off; character at cursor position does not blink                       | cursor character blink on; character at cursor position blinks                                |
| S/C                              | cursor move   | display shift   |
| R/L                              | left shift  | right shift   |
| L (no impact if M = 1 or SL = 1) | left/right screen; standard connection  | left/right screen; mirrored connection  |
|                                  | 1 <sup>st</sup> 12 characters of 24; columns are from 1 to 60                                 | 1 <sup>st</sup> 12 characters of 24; columns are from 60 to 1                                 |
|                                  | 2 <sup>nd</sup> 12 characters of 24; columns are from 1 to 60                                 | 2 <sup>nd</sup> 12 characters of 24; columns are from 60 to 1                                 |
| P                                | column data; left to right; column data is displayed from 1 to 60                             | column data; right to left; column data is displayed from 60 to 1                             |
| Q                                | row data; top to bottom; row data is displayed from 1 to 16 and icon row data is in 17 and 18 | row data; top to bottom; row data is displayed from 16 to 1 and icon row data is in 18 and 17 |
| IM                               | Character mode; full display  | Icon mode; only icons displayed   |
| IB                               | icon blink disabled   | icon blink enabled  |
| DM                               | Direct mode disabled  | Direct mode enabled   |
| V                                | set VA  | set VB  |

### 9.1 Clear display

‘Clear display’ writes character code 20h into all DDRAM addresses (the character pattern for character code 20h must be a blank pattern), sets the DDRAM address counter to 0 and returns the display to its original position, if it was shifted. Thus, the display disappears and the cursor or blink position goes to the left edge of the display. Sets entry mode I/D = 1 (increment mode). S of entry mode does not change.

The instruction ‘clear display’ requires extra execution time. This may be allowed by checking the Busy Flag (BF) or by waiting until the 165 clock cycles have elapsed. The latter must be applied where no read-back options are foreseen, as in some Chip-On-Glass (COG) applications.

## 9.2 Return home

'Return home' sets the DDRAM address counter to 0 and returns the display to its original position if it was shifted. DDRAM contents do not change. The cursor or blink position goes to the left of the first display line. I/D and S of entry mode do not change.

## 9.3 Entry mode set

### 9.3.1 Bit I/D

When I/D = 1 (0) the DDRAM or CGRAM address increments (decrements) by 1 when data is written into or read from the DDRAM or CGRAM. The cursor or blink position moves to the right when incremented and to the left when decremented. The cursor underline and cursor character blink are inhibited when the CGRAM is accessed.

### 9.3.2 Bit S

When S = 1, the entire display shifts either to the right (I/D = 0) or to the left (I/D = 1) during a DDRAM write. Thus it appears as if the cursor stands still and the display moves. The display does not shift when reading from the DDRAM, or when writing to or reading from the CGRAM.

When S = 0, the display does not shift.

## 9.4 Display control (and partial Power-down mode)

### 9.4.1 Bit D

The display is on when D = 1 and off when D = 0. Display data in the DDRAM is not affected and can be displayed immediately by setting D = 1.

When the display is off (D = 0) the chip is in partial Power-down mode:

- The LCD outputs are connected to  $V_{SS}$
- The LCD generator and bias generator are turned off

Three oscillator cycles are required after sending the 'display off' instruction to ensure all outputs are at  $V_{SS}$ , afterwards the oscillator can be stopped. If the oscillator is running during partial Power-down mode ('display off') the chip can still execute instructions. Even lower current consumption is obtained by inhibiting the oscillator (pin OSC =  $V_{SS}$ ).

To ensure  $I_{DD} < 1 \mu A$ , pin PD and the parallel bus pins DB7 to DB0 should be connected to  $V_{DD}$ , pins RS and  $R/\overline{W}$  to  $V_{DD}$  or left open-circuit.

Recovery from Power-down mode: connect pin PD back to  $V_{SS}$ , if necessary pin OSC back to  $V_{DD}$  and send a 'display control' instruction with D = 1.

### 9.4.2 Bit C

The cursor is displayed when C = 1 and inhibited when C = 0. The cursor is displayed using 5 dots in the 8th line (see [Figure 12](#)). Even if the cursor disappears, the display functions like I/D, remain in operation during display data write.

### 9.4.3 Bit B

The character indicated by the cursor blinks when B = 1. The cursor character blink is displayed by switching between display characters and all dots on with a period of

approximately 1 s, with  $f_{blink} = \frac{f_{osc}}{104448}$  Hz.

The cursor underline and the cursor character blink can be set to display simultaneously.

## 9.5 Cursor or display shift

'Cursor/display shift' moves the cursor position or the display to the right or left without writing or reading display data. This function is used to correct a character or move the cursor through the display. In 2-line displays, the cursor moves to the next line when it passes the last position of the line. When the displayed data is shifted repeatedly all lines shift at the same time; displayed characters do not shift into the next line.

The Address Counter (AC) content does not change if the only action performed is shift display, but increments or decrements with the 'cursor display shift'.

## 9.6 Function set

### 9.6.1 Bit DL (parallel mode only)

Sets interface data width. Data is sent or received in bytes (DB7 to DB0) when DL = 1 or in two nibbles (DB7 to DB4) when DL = 0. When 4-bit width is selected, data is transmitted in two cycles using the parallel bus. In a 4-bit application DB3 to DB0 should be left open-circuit (internal pull-ups). Hence in the first 'function set' instruction after power-on M, SL and H are set to logic 1. A second 'function set' must then be sent (2 nibbles) to set M, SL and H to their required values.

'Function set' from the I<sup>2</sup>C-bus interface sets the DL bit to logic 1.

### 9.6.2 Bit M

Selects either 1 line × 24 character display (M = 0) or 2 line × 12 character display (M = 1).

### 9.6.3 Bit SL

Selects MUX 1:9, 1 line × 12 character display (independent of M and L). Only rows 1 to 8 and 17 are to be used. All other rows must be left open-circuit. The DDRAM map is the same as in the 2 line × 12 character display mode, however, the second line is not displayed.

### 9.6.4 Bit H

When H = 0 the chip can be programmed via the standard 11 instruction codes used in the PCF2116 and other LCD controllers.

When H = 1 the extended range of instructions will be used. These are mainly for controlling the display configuration and the icons, as shown in [Section 10](#).

## 9.7 Set CGRAM address

'Set CGRAM address' writes bits DB5 to DB0 of the CGRAM address ACG into the address counter (A5h to A0h). Data can then be written to or read from the CGRAM.

**Remark:** the CGRAM address uses the same address register as the DDRAM address and consists of 7 bits (A6h to A0h). With the 'set CGRAM address' command, only bits DB5 to DB0 are set. Bit DB6 can be set using the 'set DDRAM address' command first, or by using the auto-increment feature during CGRAM write. All bits DB6 to DB0 can be read using the 'read busy flag' and 'read address' command.

When writing to the lower part of the CGRAM, ensure that bit DB6 of the address is not set (e.g. by an earlier DDRAM write or read action).

## 9.8 Set DDRAM address

'Set DDRAM address' writes the DDRAM address ADD into the address counter (A6h to A0h). Data can then be written to or read from the DDRAM.

## 9.9 Read busy flag and read address

'Read busy flag and address counter' reads the Busy Flag (BF) and Address Counter (AC). BF = 1 indicates that an internal operation is in progress. The next instruction will not be executed until BF = 0. It is recommended that the BF status is checked before the next write operation is executed.

At the same time, the value of the address counter (A6h to A0h) is read out, into DB6 to DB0. The address counter is used by both CGRAM and DDRAM, and its value is determined by the previous instruction.

## 9.10 Write data to CGRAM or DDRAM

'Write data' writes binary 8-bit data DB7 to DB0 to the CGRAM or the DDRAM.

Whether the CGRAM or DDRAM is to be written into is determined by the previous 'set CGRAM address' or 'set DDRAM address' command. After writing, the address automatically increments or decrements by 1, in accordance with the entry mode. Only bits DB4 to DB0 of CGRAM data are valid, bits DB7 to DB5 are 'not relevant'.

## 9.11 Read data from CGRAM or DDRAM

'Read data' reads binary 8-bit data DB7 to DB0 from the CGRAM or DDRAM.

The most recent 'set address' command determines whether the CGRAM or DDRAM is to be read.

The 'read data' instruction gates the content of the Data Register (DR) to the bus while pin E is HIGH. After pin E goes LOW again, internal operation increments (or decrements) the AC and stores RAM data corresponding to the new AC into the DR.

There are only three instructions that update the DR:

- 'Set CGRAM address'
- 'Set DDRAM address'
- 'Read data' from CGRAM or DDRAM

Other instructions (e.g. 'write data', 'cursor/display shift', 'clear display' and 'return home') do not modify the data register content.

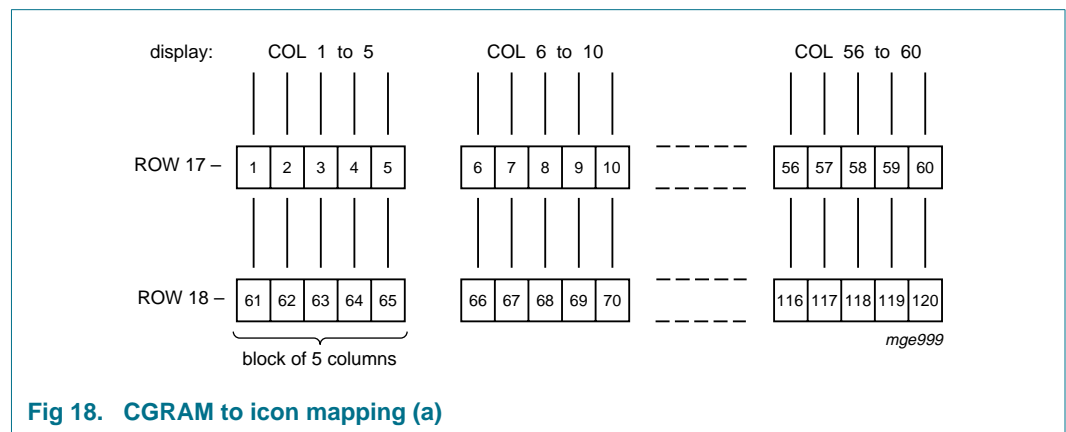
## 10. Extended function set instructions and features

### 10.1 New instructions

H = 1 sets the chip into Extended instruction set mode.

### 10.2 Icon control

The PCF2113x can drive up to 120 icons. See [Figure 18](#) and [Figure 19](#) for CGRAM to icon mapping.



| icon no. | phase       | ROW/COL  | character codes |   |   |   |     |   |   |   | CGRAM address |   |   |   |     |   |   |   | CGRAM data |   |   |   |     |   |   |   | icon view |
|----------|-------------|----------|-----------------|---|---|---|-----|---|---|---|---------------|---|---|---|-----|---|---|---|------------|---|---|---|-----|---|---|---|-----------|
|          |             |          | 7               | 6 | 5 | 4 | 3   | 2 | 1 | 0 | 6             | 5 | 4 | 3 | 2   | 1 | 0 | 4 | 3          | 2 | 1 | 0 |     |   |   |   |           |
|          |             |          | MSB             |   |   |   | LSB |   |   |   | MSB           |   |   |   | LSB |   |   |   | MSB        |   |   |   | LSB |   |   |   |           |
| 1-5      | even        | 17/1-5   | 0               | 0 | 0 | 0 | 0   | 0 | 0 | 0 | 0             | 0 | 0 | 0 | 0   | 0 | 0 | 0 | 0          | 0 | 1 | 0 | 1   | 0 | 1 |   |           |
| 6-10     | even        | 17/6-10  | 0               | 0 | 0 | 0 | 0   | 0 | 0 | 0 | 0             | 0 | 0 | 0 | 0   | 1 |   |   |            |   | 0 | 1 | 0   | 1 | 0 |   |           |
| 11-15    | even        | 17/11-15 | 0               | 0 | 0 | 0 | 0   | 0 | 0 | 0 | 0             | 0 | 0 | 0 | 1   | 0 |   |   |            |   | 0 | 1 | 1   | 1 | 0 |   |           |
|          |             |          |                 |   |   |   |     |   |   |   |               |   |   |   |     |   |   |   |            |   |   |   |     |   |   |   |           |
| 56-60    | even        | 17/56-60 | 0               | 0 | 0 | 0 | 0   | 0 | 0 | 0 | 0             | 1 |   |   |     |   |   |   |            | 0 | 0 | 0 | 0   | 0 | 0 |   |           |
| 61-65    | even        | 18/1-5   | 0               | 0 | 0 | 0 | 0   | 0 | 0 | 0 | 0             | 1 |   |   |     | 0 | 0 | 0 | 1          | 1 | 0 | 0 | 0   |   |   |   |           |
|          |             |          |                 |   |   |   |     |   |   |   |               |   |   |   |     |   |   |   |            |   |   |   |     |   |   |   |           |
| 116-120  | even        | 18/56-60 | 0               | 0 | 0 | 0 | 0   | 0 | 0 | 1 | 0             |   |   |   |     |   |   |   |            | 0 | 0 | 1 | 0   | 1 | 1 |   |           |
| 1-5      | odd (blink) | 17/1-5   | 0               | 0 | 0 | 0 | 0   | 0 | 1 | 0 | 0             |   |   |   |     |   |   |   |            | 0 | 1 | 0 | 0   | 0 | 0 |   |           |
|          |             |          |                 |   |   |   |     |   |   |   |               |   |   |   |     |   |   |   |            |   |   |   |     |   |   |   |           |
| 116-120  | odd (blink) | 18/56-60 | 0               | 0 | 0 | 0 | 0   | 0 | 1 | 1 | 0             |   |   |   |     |   |   |   |            | 0 | 1 | 1 | 0   | 0 | 1 | 1 |           |

mgg001

CGRAM data bit = logic 1 turns the icon on, data bit = logic 0 turns the icon off.

Data in character codes 0 to 3 define the icon state when icon blink is disabled or during the even phase when icon blink is enabled.

Data in character codes 4 to 7 define the icon state during the odd phase when icon blink is enabled (not used for icons when icon blink is disabled).

**Fig 19. CGRAM to icon mapping (b)**

### 10.3 Bit IM

When IM = 0, the chip is in Character mode. In Character mode, characters and icons are driven (MUX 1:18 or MUX 1:9). The V<sub>LCD</sub> generator, if used, produces the V<sub>LCD</sub> voltage programmed in register VA.

When IM = 1, the chip is in Icon mode. In Icon mode only the icons are driven (MUX 1:2) and the V<sub>LCD</sub> generator, if used, produces the V<sub>LCD</sub> voltage as programmed in register VB.

**Table 12. Character/Icon mode operation**

| IM | Mode           | V <sub>LCD</sub> |
|----|----------------|------------------|
| 0  | Character mode | defined in VA    |
| 1  | Icon mode      | defined in VB    |

### 10.4 Bit IB

Icon blink control is independent of the cursor/character blink function.

When IB = 0, the icon blink is disabled. Icon data is stored in CGRAM characters 0 to 2 (3 × 8 × 5 = 120 bits for 120 icons).

When IB = 1, the icon blink is enabled. In this case each icon is controlled by two bits. Blink consists of two half phases (corresponding to the cursor on and off phases called even and odd phases hereafter).



Icon states for the even phase are stored in CGRAM characters 0 to 2 ( $3 \times 8 \times 5 = 120$  bits for 120 icons). These bits also define icon state when icon blink is not used (see [Table 13](#)).

Icon states for the odd phase are stored in CGRAM characters 4 to 6 (another 120 bits for the 120 icons). When icon blink is disabled CGRAM characters 4 to 6 may be used as normal CGRAM characters.

**Table 13. Blink effect for icons and cursor character blink**

| Parameter              | Even phase                      | Odd phase                       |
|------------------------|---------------------------------|---------------------------------|
| Cursor character blink | block (all on)                  | normal (display character)      |
| Icons                  | state 1; CGRAM character 0 to 2 | state 2; CGRAM character 4 to 6 |

## 10.5 Direct mode

When  $DM = 0$ , the chip is not in the Direct mode. Either the internal  $V_{LCD}$  generator or an external voltage may be used to achieve  $V_{LCD}$ .

When  $DM = 1$ , the chip is in Direct mode. The internal  $V_{LCD}$  generator is turned off and the output  $V_{LCDOUT}$  is directly connected  $V_{DD2}$  (i.e. the  $V_{LCD}$  generator supply voltage).

The Direct mode can be used to reduce the current consumption when the required output voltage  $V_{LCDOUT}$  is close to the  $V_{DD2}$  supply voltage. This can be the case in Icon mode or in MUX 1:9 (depending on LCD liquid properties).

## 10.6 Voltage multiplier control

### 10.6.1 Bits S1 and S0

A software configurable voltage multiplier is incorporated in the  $V_{LCD}$  generator and can be set via the 'Set HVgen stages' command.

The voltage multiplier control can be used to reduce current consumption by disconnecting internal voltage multiplier stages, depending on the required output voltage  $V_{LCD}$  (see [Table 14](#)).

**Table 14. S1 and S0 control of voltage multiplier**

| S1 | S0 | Description  |
|----|----|--|
| 0  | 0  | set $V_{LCD}$ generator stages to 1 ( $2 \times$ voltage multiplier) |
| 0  | 1  | set $V_{LCD}$ generator stages to 2 ( $3 \times$ voltage multiplier) |
| 1  | 0  | set $V_{LCD}$ generator stages to 3 ( $4 \times$ voltage multiplier) |
| 1  | 1  | do not use   |

## 10.7 Screen configuration

### 10.7.1 Bit L

$L = 0$ : the two halves of a split screen are connected in a standard way i.e. column 1/61, 2/62 to 60/120; default.

$L = 1$ : the two halves of a split screen are connected in a mirrored way i.e. column 1/120, 2/119 to 60/61. This allows single layer PCB or glass layout.

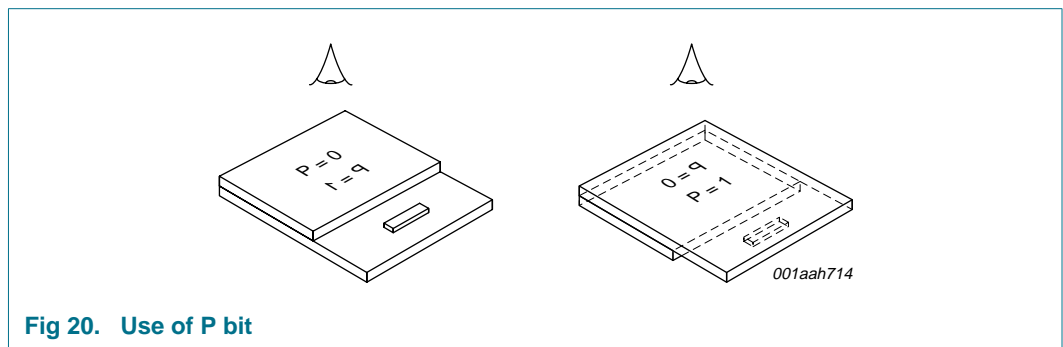
## 10.8 Display configuration

### 10.8.1 Bit P

The P bit is used to flip the display left to right by mirroring the column data, as shown in [Figure 20](#). This allows the display to be viewed from behind instead of front, enhances the flexibility in the assembly of equipment and avoids complicated data manipulation within the controller.

P = 0: default.

P = 1: mirrors the column data.



**Fig 20. Use of P bit**

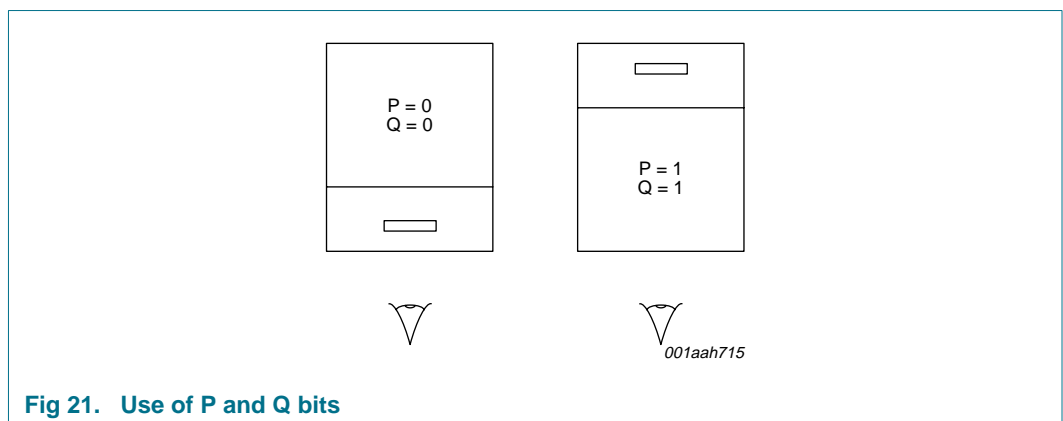
### 10.8.2 Bit Q

The Q bit flips the display top to bottom by mirroring the row data.

Q = 0: default.

Q = 1: mirrors the row data.

A combination of Q and P allows the display to be rotated 180 deg, as shown in [Figure 21](#). This is useful for viewing the display from the opposite edge.



**Fig 21. Use of P and Q bits**

### 10.9 Temperature control

Default is bit TC1 = 0 and bit TC2 = 0. Selects the default temperature coefficient for the internally generated  $V_{LCD}$  (see [Table 15](#)).

**Table 15. TC1 and TC2 selection of  $V_{LCD}$  temperature coefficient**

| Bit TC1 | Bit TC2 | $V_{LCD}$ temperature coefficient TC (typical values) |
|---------|---------|---|
| 0       | 0       | TC = -0.16 %/K  |
| 1       | 0       | TC = -0.18 %/K  |
| 0       | 1       | TC = -0.21 %/K  |
| 1       | 1       | TC = -0.24 %/K  |

### 10.10 Set $V_{LCD}$

The  $V_{LCD}$  value is programmed by instruction. Two on-chip registers, VA and VB hold  $V_{LCD}$  values for the Character mode and the Icon mode respectively. The generated  $V_{LCD}$  is independent of  $V_{DD}$ , allowing battery operation of the chip.

#### 10.10.1 $V_{LCD}$ programming

1. Send 'function set' instruction with H = 1
2. Send 'set  $V_{LCD}$ ' instruction to write to voltage register:
  - a. If DB[7:6] = 10, then DB[5:0] represents  $V_{LCD}$  of Character mode (VA)
  - b. If DB[7:6] = 11, then DB[5:0] represents  $V_{LCD}$  of Icon mode (VB)
  - c. DB[5:0] = 00 0000 switches  $V_{LCD}$  generator off (when selected)
  - d. During 'display off' and power-down the  $V_{LCD}$  generator is also disabled
3. Send 'function set' instruction with H = 0 to resume normal programming

[Section 8.1](#) shows the relation between  $V_{LCD}$  and registers VA and VB.

### 10.11 Reducing current consumption

Reducing current consumption can be achieved by one of the options given in [Table 16](#).

When  $V_{LCD}$  lies outside the  $V_{DD}$  range and must be generated, it is usually more efficient to use the on-chip generator than an external regulator.

**Table 16. Reducing current consumption**

| Original mode                 | Alternative mode            |
|-------------------------------|-----------------------------|
| Character mode                | Icon mode (control bit M)   |
| Display on                    | display off (control bit D) |
| $V_{LCD}$ generator operating | Direct mode                 |
| Any mode                      | Power-down mode (PD pin)    |

## 11. Interfaces to microcontroller

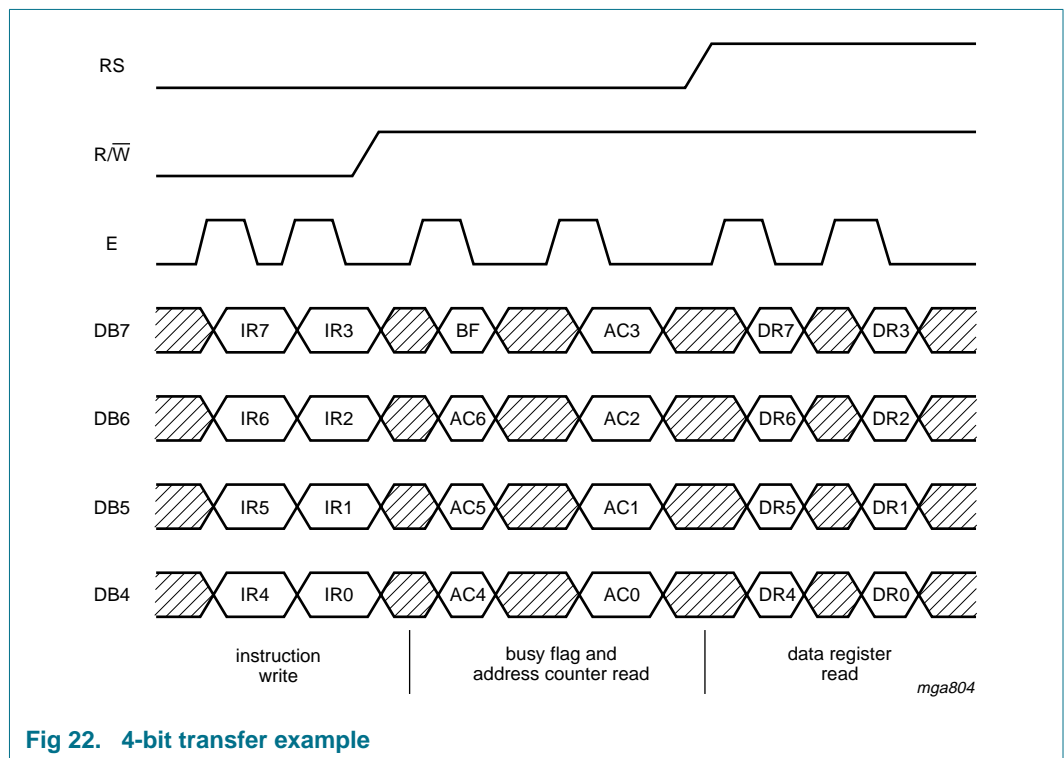
### 11.1 Parallel interface

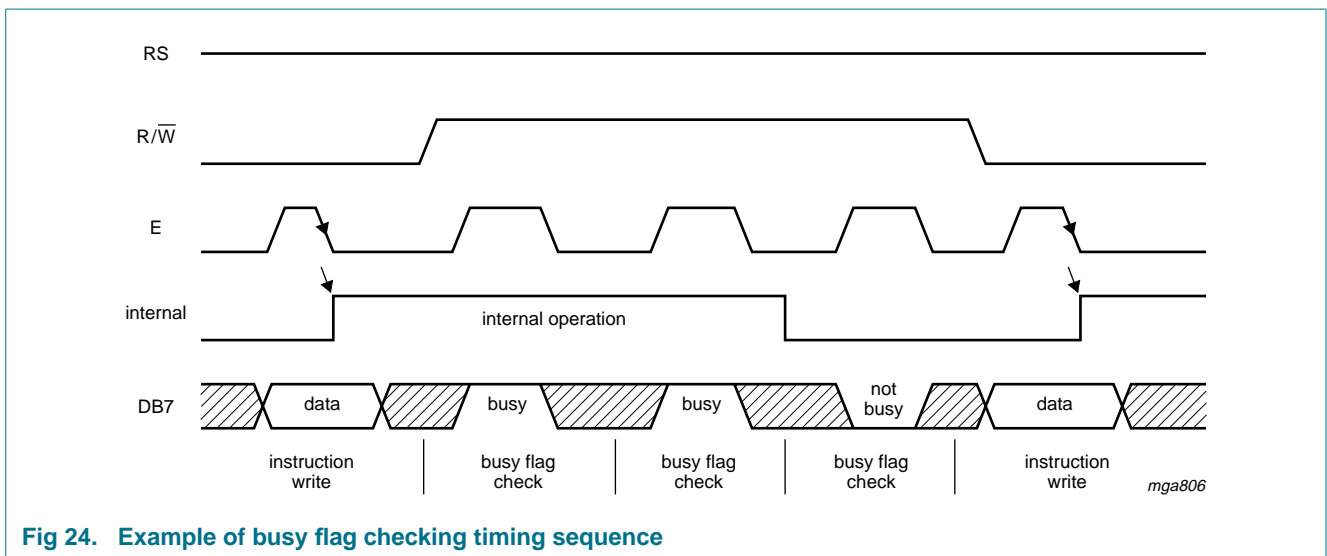
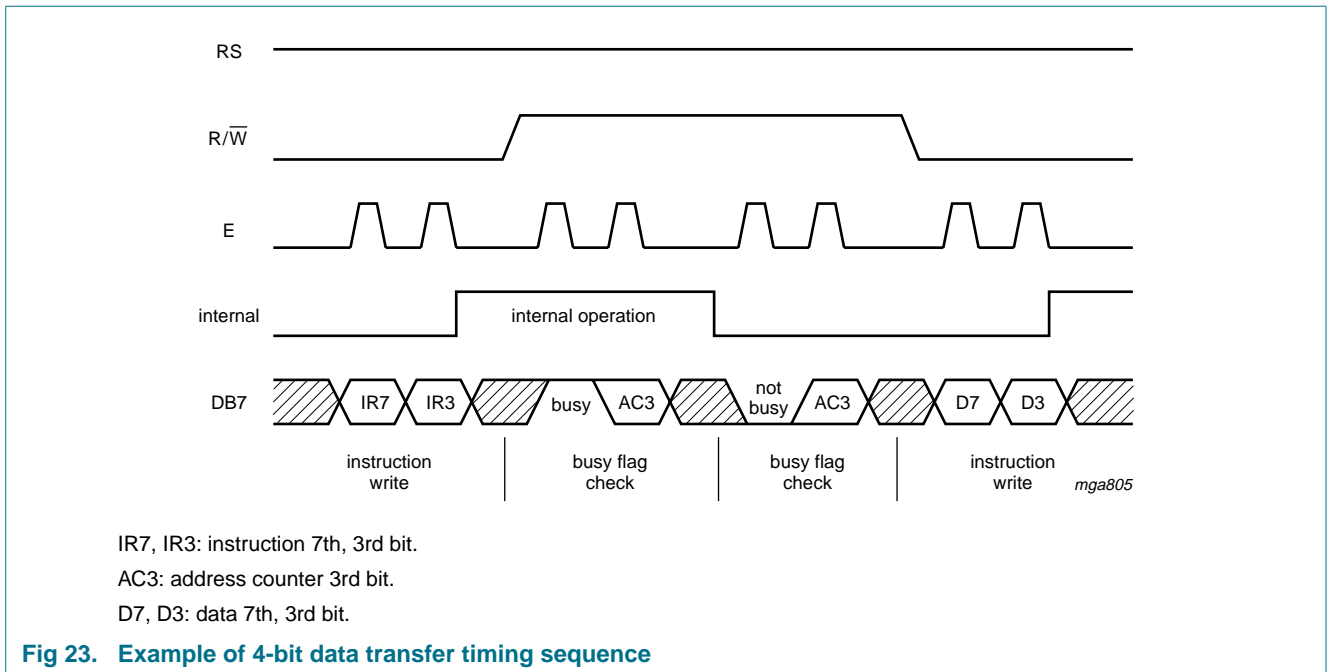
The PCF2113x can send data in either two 4-bit operations or one 8-bit operation and can thus interface to 4-bit or 8-bit microcontrollers.

In 8-bit mode data is transferred as 8-bit bytes using the 8 data lines DB7 to DB0. Three further control lines E, RS and  $R/\overline{W}$  are required (see [Section 7](#)).

In 4-bit mode data is transferred in two cycles of 4 bits each using pins DB7 to DB4 for the transaction. The higher order bits (corresponding to bits DB7 to DB4 in 8-bit mode) are sent in the first cycle and the lower order bits (corresponding to bits DB3 to DB0 in 8-bit mode) in the second cycle. Data transfer is complete after two 4-bit data transfers. It should be noted that two cycles are also required for the busy flag check. 4-bit operation is selected by instruction: see [Figure 22](#), [Figure 23](#) and [Figure 24](#) for examples of bus protocol.

In 4-bit mode, pins DB3 to DB0 must be left open-circuit. They are pulled up to  $V_{DD}$  internally.





### 11.2 I<sup>2</sup>C-bus interface

The I<sup>2</sup>C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are the Serial Data line (SDA) and the Serial Clock Line (SCL). Both lines must be connected to a positive supply via pull-up resistors. Data transfer may be initiated only when the bus is not busy.

Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH level signal put on the bus by the transmitter during which time the master generates an extra acknowledge related clock pulse. A slave receiver which is addressed must generate an acknowledge after the reception of each byte.

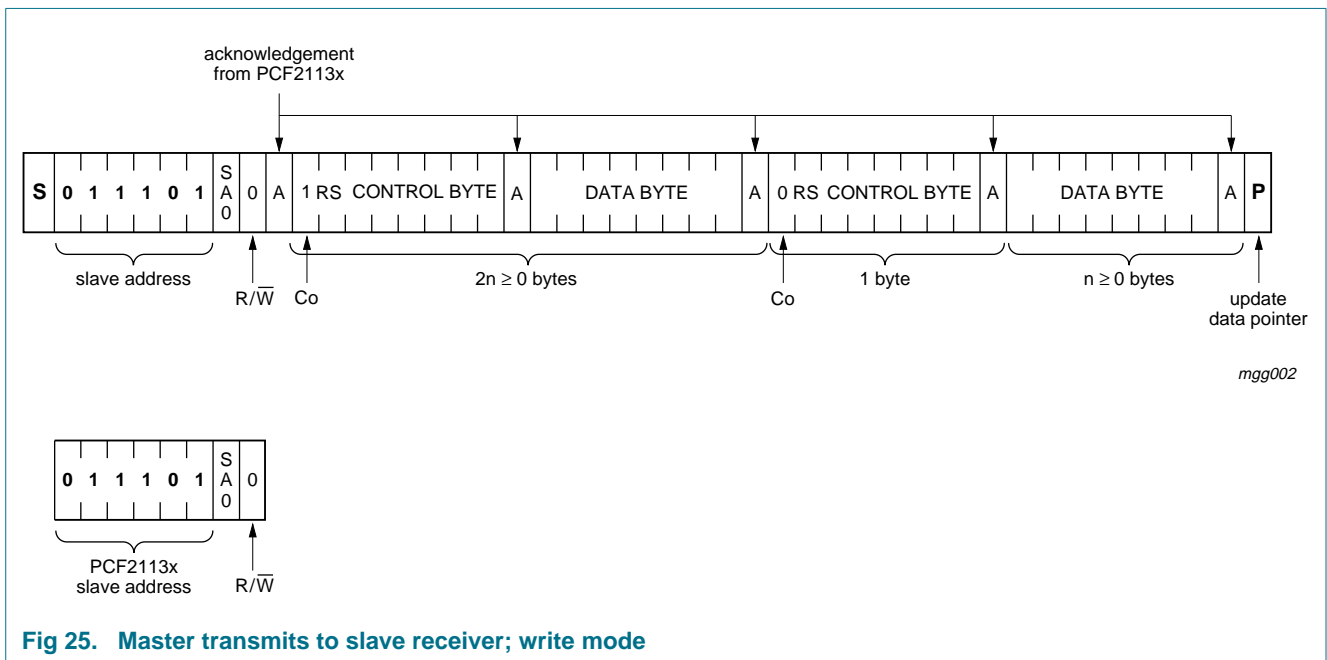
Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.

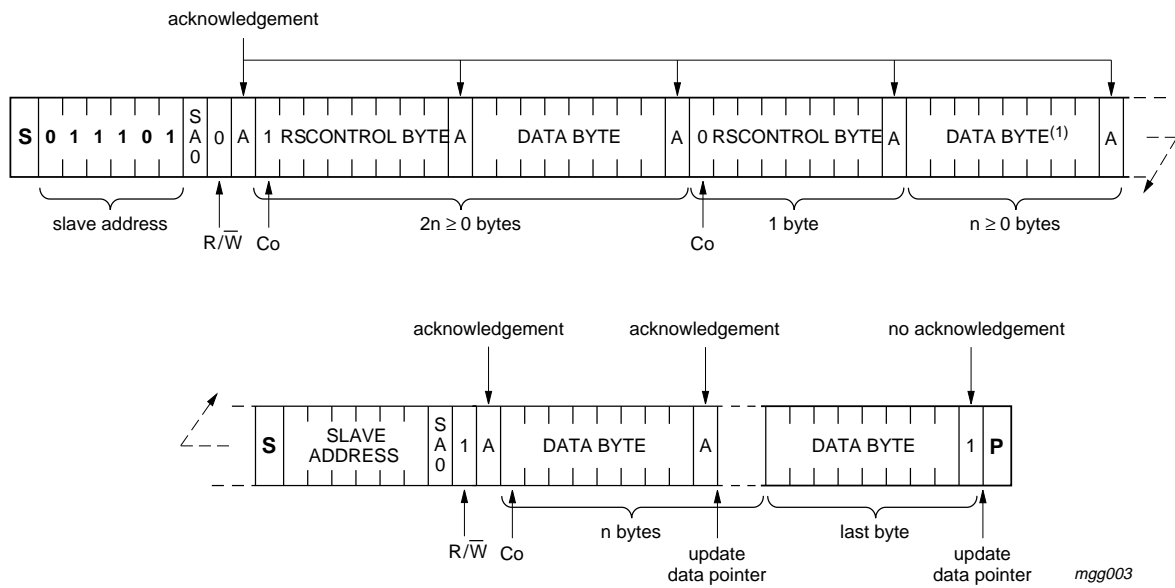
The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration).

A master receiver must signal an end of data to the transmitter by not generating an acknowledge bit on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

### 11.2.1 I<sup>2</sup>C-bus protocol

Before any data is transmitted on the I<sup>2</sup>C-bus, the device which should respond is addressed first. The addressing is always carried out with the first byte transmitted after the START procedure. The I<sup>2</sup>C-bus configuration for the different PCF2113x read and write cycles is shown in [Figure 25](#), [Figure 26](#) and [Figure 27](#). The slow-down feature of the I<sup>2</sup>C-bus protocol (receiver holds SCL LOW during internal operations) is not used in the PCF2113x.





(1) Last data byte is a dummy byte (may be omitted).

Fig 26. Master reads after setting word address; write word address; set RS; 'read data'

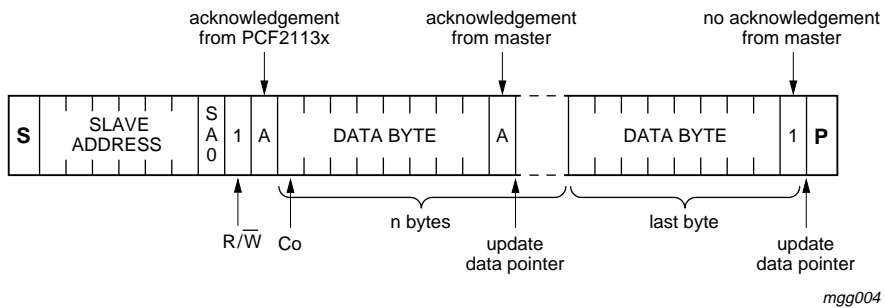


Fig 27. Master reads slave immediately after first byte; read mode (RS previously defined)

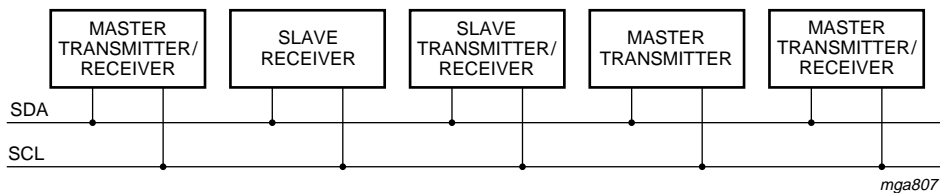
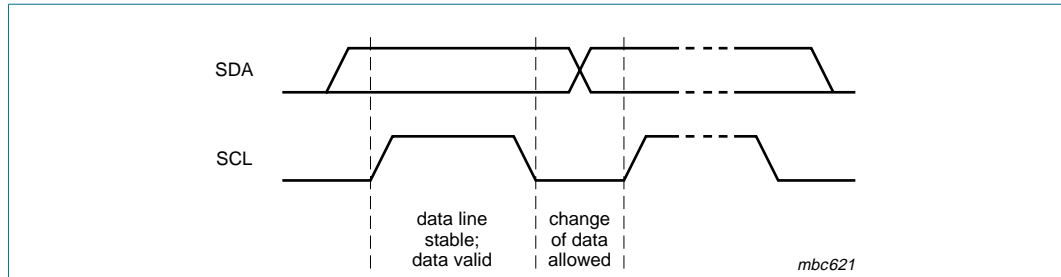
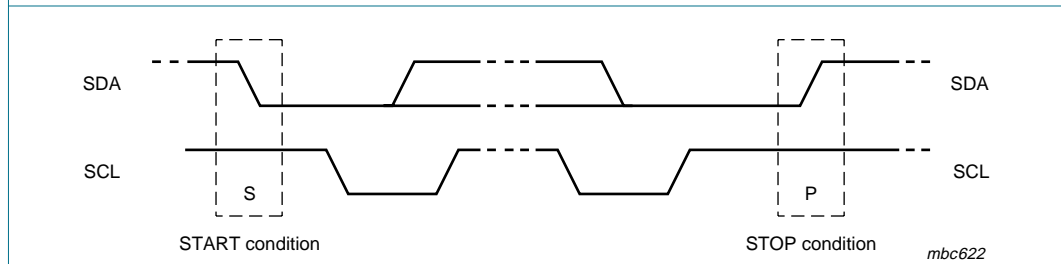


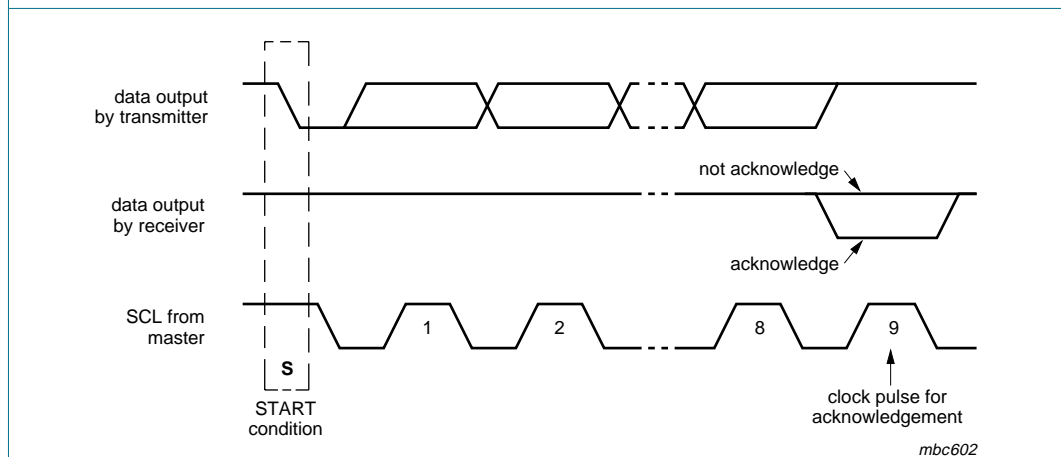
Fig 28. System configuration



**Fig 29. Bit transfer**



**Fig 30. Definition of START and STOP conditions**



**Fig 31. Acknowledgement on the I<sup>2</sup>C-bus**

**11.2.2 Definitions**

- Transmitter: the device that sends the data to the bus
- Receiver: the device that receives the data from the bus
- Master: the device that initiates and terminates a transfer and generates clock signals
- Slave: the device addressed by a master
- Multi-master: more than one master can attempt to control the bus at the same time without corrupting the message
- Arbitration: procedure to ensure that if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted
- Synchronization: procedure to synchronize the clock signals of two or more devices

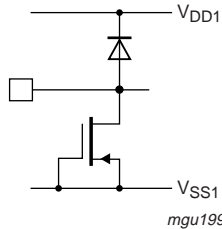


## 12. Internal circuitry

**Table 17. Device protection circuits**

| Symbol         | Pad | Internal circuit                                |
|----------------|-----|---|
| $V_{DD1}$      | 1   | <p style="text-align: right;"><i>mgu200</i></p> |
| $V_{DD2}$      | 109 | <p style="text-align: right;"><i>mgu201</i></p> |
| $V_{DD3}$      | 110 | <p style="text-align: right;"><i>mgu202</i></p> |
| $V_{SS1}$      | 7   | <p style="text-align: right;"><i>mgu203</i></p> |
| $V_{SS2}$      | 8   |   |
| $V_{LCDSENSE}$ | 10  | <p style="text-align: right;"><i>mgu196</i></p> |
| $V_{LCDIN}$    | 11  |   |
| $V_{LCDOUT}$   | 9   |   |
| SCL            | 96  | <p style="text-align: right;"><i>mgu198</i></p> |
| SDA            | 97  |   |

Table 17. Device protection circuits ...continued

| Symbol     | Pad        | Internal circuit   |
|------------|------------|--|
| OSC        | 2          |  <p style="text-align: right;">mgu199</p> |
| PD         | 3          |  |
| T1         | 5          |  |
| T2         | 6          |  |
| T3         | 4          |  |
| E          | 98         |  |
| RS         | 99         |  |
| R/W        | 100        |  |
| DB0 to DB7 | 108 to 101 |  |
| R1 to R8   | 94 to 87   |  |
| R9 to R16  | 12 to 19   |  |
| R17        | 95         |  |
| R18        | 20         |  |
| C1 to C2   | 86 to 85   |  |
| C3 to C27  | 82 to 58   |  |
| C28 to C52 | 55 to 31   |  |
| C53 to C60 | 28 to 21   |  |

### 13. Limiting values

Table 18. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol        | Parameter                       | Conditions                                | Min  | Max  | Unit  |    |
|---------------|---------------------------------|---|------|------|-------|----|
| $V_{DD1}$     | supply voltage 1                | logic supply                              | -0.5 | +5.5 | V     |    |
| $V_{DD2}$     | supply voltage 2                | $V_{LCD}$ generator supply                | -0.5 | +4.0 | V     |    |
| $V_{DD3}$     | supply voltage 3                | analog supply                             | -0.5 | +4.0 | V     |    |
| $V_{LCD}$     | LCD supply voltage              |   | -0.5 | +6.5 | V     |    |
| $V_{i(n)}$    | voltage on any input            | $V_{DD}$ related inputs                   | -0.5 | +5.5 | V     |    |
| $V_{o(n)}$    | voltage on any output           | $V_{LCD}$ related outputs                 | -0.5 | +6.5 | V     |    |
| $I_I$         | input current                   | DC level                                  | -10  | +10  | mA    |    |
| $I_O$         | output current                  | DC level                                  | -10  | +10  | mA    |    |
| $I_{DD}$      | supply current                  | on pins $V_{DD1}$ , $V_{DD2}$ , $V_{DD3}$ | -    | +50  | mA    |    |
| $I_{SS}$      | ground supply current           | on pins $V_{SS1}$ and $V_{SS2}$           | -    | -50  | mA    |    |
| $I_{DD(LCD)}$ | LCD supply current              |   | -    | +50  | mA    |    |
| $P_{tot}$     | total power dissipation         |   | -    | 400  | mW    |    |
| $P_{out}$     | power dissipation per output    |   | -    | 100  | mW    |    |
| $V_{esd}$     | electrostatic discharge voltage | HBM                                       | [1]  | -    | ±2000 | V  |
|               |                                 | MM  | [2]  | -    | ±200  | V  |
|               |                                 | CDM                                       | [3]  | -    | ±2000 | V  |
| $I_{lu}$      | latch-up current                |   | [4]  | -    | 100   | mA |
| $T_{stg}$     | storage temperature             |   | -65  | +150 | °C    |    |

- [1] HBM: Human Body Model, according to JESD22-A114.
- [2] MM: Machine Model, according to JESD22-A115.
- [3] CDM: Charged-Device Model, according to JESD22-C101.
- [4] Latch-up testing, according to JESD78.

## 14. Static characteristics

**Table 19. Static characteristics**

$V_{DD1} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{DD2} = V_{DD3} = 2.2\text{ V to }4.0\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{LCD} = 2.2\text{ V to }6.5\text{ V}$ ;  $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol          | Parameter                | Conditions  | Min             | Typ | Max             | Unit          |               |
|-----------------|--------------------------|---|-----------------|-----|-----------------|---------------|---------------|
| <b>Supplies</b> |                          |   |                 |     |                 |               |               |
| $V_{DD1}$       | supply voltage 1         | logic supply  | [1] 1.8         | -   | 5.5             | V             |               |
| $V_{DD2}$       | supply voltage 2         | $V_{LCD}$ generator supply; internal $V_{LCD}$ generation ( $V_{DD2}$ and $V_{DD3} < V_{LCD}$ )   | 2.2             | -   | 4.0             | V             |               |
| $V_{DD3}$       | supply voltage 3         | analog supply; internal $V_{LCD}$ generation ( $V_{DD2}$ and $V_{DD3} < V_{LCD}$ )  | 2.2             | -   | 4.0             | V             |               |
| $V_{LCD}$       | LCD supply voltage       |   | 2.2             | -   | 6.5             | V             |               |
| $V_{POR}$       | power-on reset voltage   |   | [1][2] 0.9      | -   | 1.6             | V             |               |
| $I_{SS}$        | ground supply current    | external $V_{LCD}$ ; pins $V_{SS1}$ and $V_{SS2}$   | [3]             |     |                 |               |               |
|                 |                          | Character mode; $V_{LCD} = 6.5\text{ V}$ ; $V_{DD1} = 5.5\text{ V}$ ; $V_{DD2} = V_{DD3} = 4\text{ V}$  | -               | 70  | 120             | $\mu\text{A}$ |               |
|                 |                          | Character mode; $V_{LCD} = 5\text{ V}$ ; $V_{DD1} = V_{DD2} = V_{DD3} = 3\text{ V}$   | [4]             | -   | 45              | 80            | $\mu\text{A}$ |
|                 |                          | Icon mode; $V_{LCD} = 2.5\text{ V}$ ; $V_{DD1} = V_{DD2} = V_{DD3} = 3\text{ V}$  | [4]             | -   | 25              | 45            | $\mu\text{A}$ |
|                 |                          | internal $V_{LCD}$ ; pins $V_{SS1}$ and $V_{SS2}$   | [3][5]          |     |                 |               |               |
|                 |                          | Character mode; $V_{LCD} = 6.5\text{ V}$ ; $V_{DD1} = 5.5\text{ V}$ ; $V_{DD2} = V_{DD3} = 2.2\text{ V}$  | -               | 190 | 400             | $\mu\text{A}$ |               |
|                 |                          | Character mode; $V_{LCD} = 5\text{ V}$ ; $V_{DD1} = V_{DD2} = V_{DD3} = 3\text{ V}$   | [4]             | -   | 160             | 400           | $\mu\text{A}$ |
|                 |                          | Icon mode; $V_{LCD} = 2.5\text{ V}$ ; $V_{DD1} = V_{DD2} = V_{DD3} = 2.5\text{ V}$  | [4]             | -   | 120             | -             | $\mu\text{A}$ |
|                 |                          | Power-down mode; $V_{LCD} = 2.5\text{ V}$ ; $V_{DD1} = V_{DD2} = V_{DD3} = 3\text{ V}$ ; pins RS, PD, $R/\bar{W}$ and DB7 to DB0 = HIGH; in OSC = LOW | [3][4]          | -   | 2               | 5             | $\mu\text{A}$ |
| <b>Logic</b>    |                          |   |                 |     |                 |               |               |
| $V_i$           | input voltage            |   | $V_{SS1} - 0.5$ | -   | $V_{DD1} + 0.5$ | V             |               |
| $V_{iL}$        | LOW-level input voltage  | on pin OSC  | $V_{SS1}$       | -   | $V_{DD1} - 1.2$ | V             |               |
|                 |                          | on any other pin  | $V_{SS1}$       | -   | $0.3V_{DD1}$    | V             |               |
| $V_{iH}$        | HIGH-level input voltage | on pin OSC  | $V_{DD1} - 0.1$ | -   | $V_{DD1}$       | V             |               |
|                 |                          | on any other pin  | $0.7V_{DD1}$    | -   | $V_{DD1}$       | V             |               |
| $I_L$           | leakage current          | $V_i = V_{DD1}$ or $V_{SS1}$  | -1              | -   | +1              | $\mu\text{A}$ |               |

**Table 19. Static characteristics ...continued**

$V_{DD1} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{DD2} = V_{DD3} = 2.2\text{ V to }4.0\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{LCD} = 2.2\text{ V to }6.5\text{ V}$ ;  $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol                           | Parameter                           | Conditions                                       | Min             | Typ  | Max          | Unit          |            |
|----------------------------------|-------------------------------------|--|-----------------|------|--------------|---------------|------------|
| <b>Pins DB7 to DB0</b>           |                                     |  |                 |      |              |               |            |
| $I_{OL}$                         | LOW-level output current            | $V_{OL} = 0.4\text{ V}$ ; $V_{DD1} = 5\text{ V}$ | 1.6             | 4    | -            | mA            |            |
| $I_{OH}$                         | HIGH-level output current           | $V_{OH} = 0.4\text{ V}$ ; $V_{DD1} = 5\text{ V}$ | -1              | -8   | -            | mA            |            |
| $I_{pu}$                         | pull-up current                     | $V_I = V_{SS1}$                                  | 0.04            | 0.15 | 1            | $\mu\text{A}$ |            |
| <b>I<sup>2</sup>C-bus</b>        |                                     |  |                 |      |              |               |            |
| <b>Input on pins SDA and SCL</b> |                                     |  |                 |      |              |               |            |
| $V_I$                            | input voltage                       |  | $V_{SS1} - 0.5$ | -    | 5.5          | V             |            |
| $V_{IL}$                         | LOW-level input voltage             |  | 0               | -    | $0.3V_{DD1}$ | V             |            |
| $V_{IH}$                         | HIGH-level input voltage            |  | $0.7V_{DD1}$    | -    | 5.5          | V             |            |
| $I_{LI}$                         | input leakage current               | $V_I = V_{DD1}$ or $V_{SS1}$                     | -1              | -    | +1           | $\mu\text{A}$ |            |
| $C_I$                            | input capacitance                   |  | [6]             | -    | 5            | pF            |            |
| <b>Output on pin SDA</b>         |                                     |  |                 |      |              |               |            |
| $I_{OL(SDA)}$                    | LOW-level output current on pin SDA | $V_{OL} = 0.4\text{ V}$ ; $V_{DD1} > 2\text{ V}$ | 3               | -    | -            | mA            |            |
|                                  |                                     | $V_{OL} = 0.2V_{DD1}$ ; $V_{DD1} < 2\text{ V}$   | 2               | -    | -            | mA            |            |
| <b>LCD outputs</b>               |                                     |  |                 |      |              |               |            |
| $R_O$                            | output resistance                   | row outputs: pins R1 to R18                      | [7]             | -    | 10           | 30            | k $\Omega$ |
|                                  |                                     | column outputs: pins C1 to C60                   | [7]             | -    | 15           | 40            | k $\Omega$ |
| $\Delta V_{bias}$                | bias voltage variation              | pins R1 to R18 and C1 to C60                     | [8]             | -    | 20           | 130           | mV         |
| $\Delta V_{LCD}$                 | LCD voltage variation               | $T_{amb} = 25\text{ }^{\circ}\text{C}$           | [5]             |      |              |               |            |
|                                  |                                     | $V_{LCD} < 3\text{ V}$                           | -               | -    | 160          | mV            |            |
|                                  |                                     | $V_{LCD} < 4\text{ V}$                           | -               | -    | 200          | mV            |            |
|                                  |                                     | $V_{LCD} < 5\text{ V}$                           | -               | -    | 260          | mV            |            |
|                                  |                                     | $V_{LCD} < 6\text{ V}$                           | -               | -    | 340          | mV            |            |

- [1] Spikes on  $V_{DD1}$  or  $V_{SS1}$  which cause  $(V_{DD1} - V_{SS1}) \leq 1.6\text{ V}$  can cause a Power-on reset.
- [2] Resets all logic when  $V_{DD1} < V_{POR}$ ; 3 oscillator cycles required.
- [3] LCD outputs are open-circuit; inputs at  $V_{DD1}$  or  $V_{SS1}$ ; bus inactive.
- [4]  $T_{amb} = 25\text{ }^{\circ}\text{C}$ ;  $f_{osc} = 200\text{ kHz}$ .
- [5] LCD outputs are open-circuit;  $V_{LCD}$  generator is on; load current  $I_{DD(LCD)} = 5\text{ }\mu\text{A}$  (at  $V_{LCD}$ ).
- [6] Tested on a sample basis.
- [7] Resistance of output pins (R1 to R18 and C1 to C60) with a load current of  $10\text{ }\mu\text{A}$ ; outputs measured one at a time; external  $V_{LCD} = 3\text{ V}$ ;  $V_{DD1} = V_{DD2} = V_{DD3} = V_{LCD}$ .
- [8] LCD outputs are open-circuit; external  $V_{LCD}$ .

## 15. Dynamic characteristics

**Table 20. Dynamic characteristics**

$V_{DD1} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{DD2} = V_{DD3} = 2.2\text{ V to }4.0\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{LCD} = 2.2\text{ V to }6.5\text{ V}$ ;  $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ ;  
unless otherwise specified

| Symbol                | Parameter                      | Conditions                              | Min     | Typ | Max | Unit          |
|-----------------------|--------------------------------|---|---------|-----|-----|---------------|
| $f_{fr(LCD)}$         | LCD frame frequency            | internal clock; $V_{DD} = 5.0\text{ V}$ | 45      | 95  | 147 | Hz            |
| $f_{osc}$             | oscillator frequency           |   | [1] 140 | 250 | 450 | kHz           |
| $f_{osc(ext)}$        | external oscillator frequency  |   | 140     | -   | 450 | kHz           |
| $t_{d(startup)(OSC)}$ | start-up delay time on pin OSC | oscillator, after power down            | [2] -   | 200 | 300 | $\mu\text{s}$ |
| $t_{w(pd)}$           | power-down pulse width         |   | 1       | -   | -   | $\mu\text{s}$ |
| $t_{w(spike)}$        | spike pulse width              | on pin PD                               | [2] -   | -   | 90  | ns            |

### Timing characteristics of parallel interface [3]

Write operation (writing data from microcontroller to PCF2113x); see [Figure 32](#)

|              |                        |  |     |   |   |    |
|--------------|------------------------|--|-----|---|---|----|
| $t_{cy(en)}$ | enable cycle time      |  | 500 | - | - | ns |
| $t_{w(en)}$  | enable pulse width     |  | 220 | - | - | ns |
| $t_{su(A)}$  | address set-up time    |  | 50  | - | - | ns |
| $t_{h(A)}$   | address hold time      |  | 25  | - | - | ns |
| $t_{su(D)}$  | data input set-up time |  | 60  | - | - | ns |
| $t_{h(D)}$   | data input hold time   |  | 25  | - | - | ns |

Read operation (reading data from PCF2113x to microcontroller); see [Figure 33](#)

|              |                             |                          |     |   |     |    |
|--------------|-----------------------------|--------------------------|-----|---|-----|----|
| $t_{cy(en)}$ | enable cycle time           |                          | 500 | - | -   | ns |
| $t_{w(en)}$  | enable pulse width          |                          | 220 | - | -   | ns |
| $t_{su(A)}$  | address set-up time         |                          | 50  | - | -   | ns |
| $t_{h(A)}$   | address hold time           |                          | 25  | - | -   | ns |
| $t_{d(DV)}$  | data input valid delay time | $V_{DD1} > 2.2\text{ V}$ | -   | - | 150 | ns |
|              |                             | $V_{DD1} > 1.5\text{ V}$ | -   | - | 250 | ns |
| $t_{h(D)}$   | data input hold time        |                          | 5   | - | -   | ns |

### Timing characteristics of I<sup>2</sup>C-bus interface [3]; see [Figure 34](#)

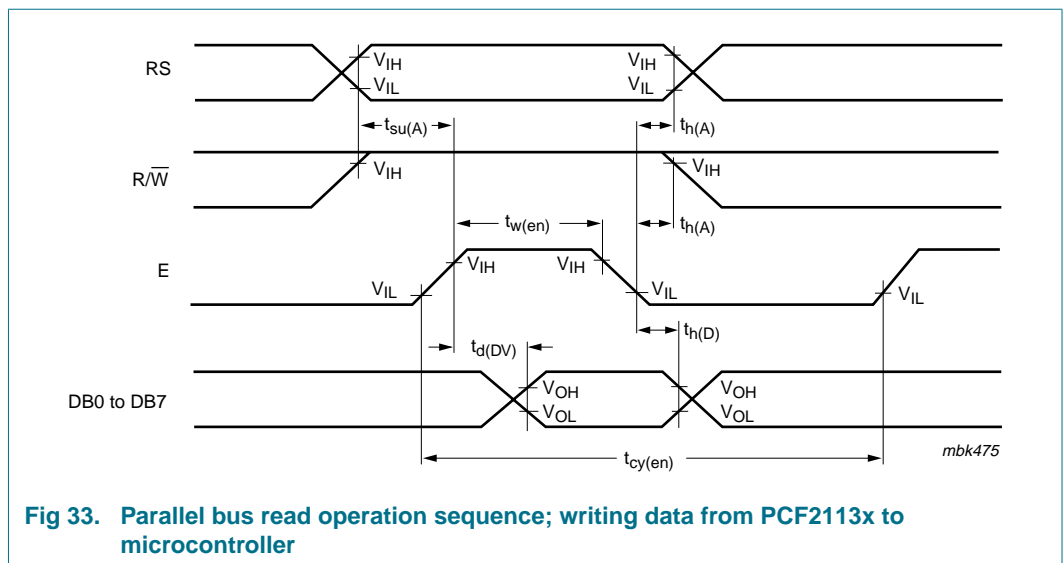
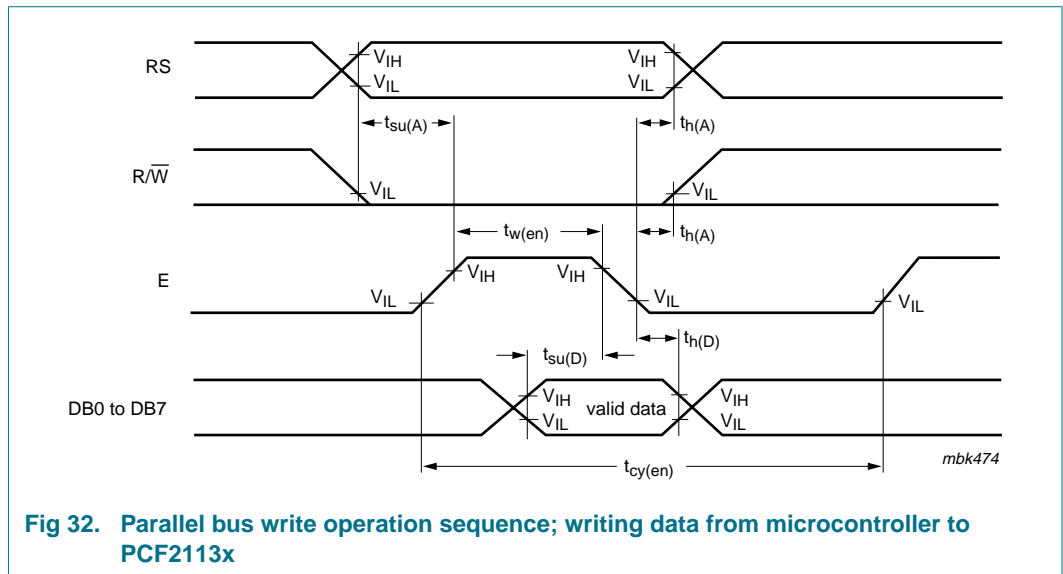
|              |  |  |                      |   |     |               |
|--------------|--|--|----------------------|---|-----|---------------|
| $f_{SCL}$    | SCL frequency                              |  | -                    | - | 400 | Hz            |
| $t_{LOW}$    | LOW period of the SCL clock                |  | 1.3                  | - | -   | $\mu\text{s}$ |
| $t_{HIGH}$   | HIGH period of the SCL clock               |  | 0.6                  | - | -   | $\mu\text{s}$ |
| $t_{SU;DAT}$ | data set-up time                           |  | 100                  | - | -   | ns            |
| $t_{HD;DAT}$ | data hold time                             |  | 0                    | - | -   | ns            |
| $t_r$        | rise time of both SDA and SCL signals      |  | [2][4] $15 + 0.1C_b$ | - | 300 | ns            |
| $t_f$        | fall time of both SDA and SCL signals      |  | [2][4] $15 + 0.1C_b$ | - | 300 | ns            |
| $C_b$        | capacitive load for each bus line          |  | [4] -                | - | 400 | pF            |
| $t_{SU;STA}$ | set-up time for a repeated START condition |  | 0.6                  | - | -   | $\mu\text{s}$ |
| $t_{HD;STA}$ | hold time (repeated) START condition       |  | 0.6                  | - | -   | $\mu\text{s}$ |

**Table 20. Dynamic characteristics ...continued**

$V_{DD1} = 1.8\text{ V to }5.5\text{ V}$ ;  $V_{DD2} = V_{DD3} = 2.2\text{ V to }4.0\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{LCD} = 2.2\text{ V to }6.5\text{ V}$ ;  $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ ; unless otherwise specified

| Symbol       | Parameter   | Conditions | Min | Typ | Max | Unit          |
|--------------|---|------------|-----|-----|-----|---------------|
| $t_{SU,STO}$ | set-up time for STOP condition                                    |            | 0.6 | -   | -   | $\mu\text{s}$ |
| $t_{SP}$     | pulse width of spikes that must be suppressed by the input filter | on bus     | -   | -   | 50  | ns            |
| $t_{BUF}$    | bus free time between a STOP and START condition                  |            | 1.3 | -   | -   | $\mu\text{s}$ |

- [1] Not available at any pin.
- [2] Tested on a sample basis.
- [3] All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ .
- [4]  $C_b$  = total capacitance of one bus line in pF.



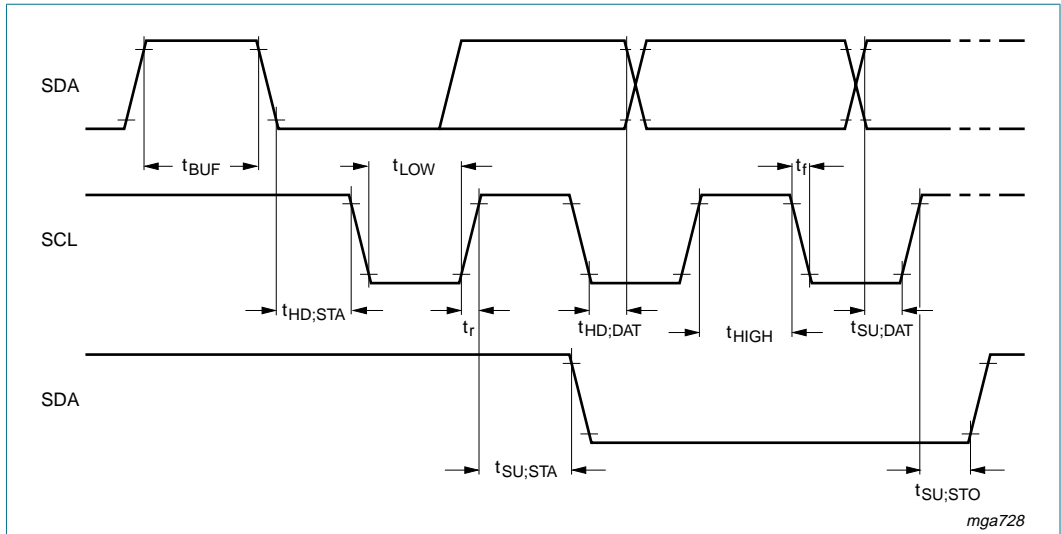


Fig 34. I<sup>2</sup>C-bus timing diagram

## 16. Application information

### 16.1 Application diagrams

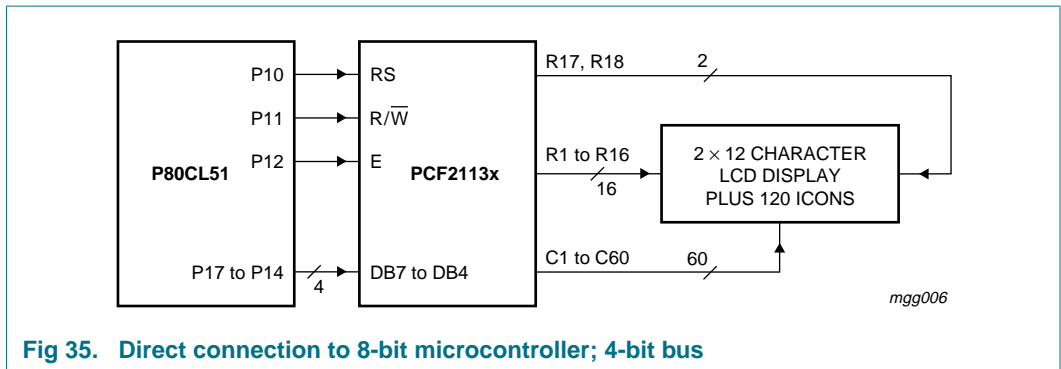


Fig 35. Direct connection to 8-bit microcontroller; 4-bit bus

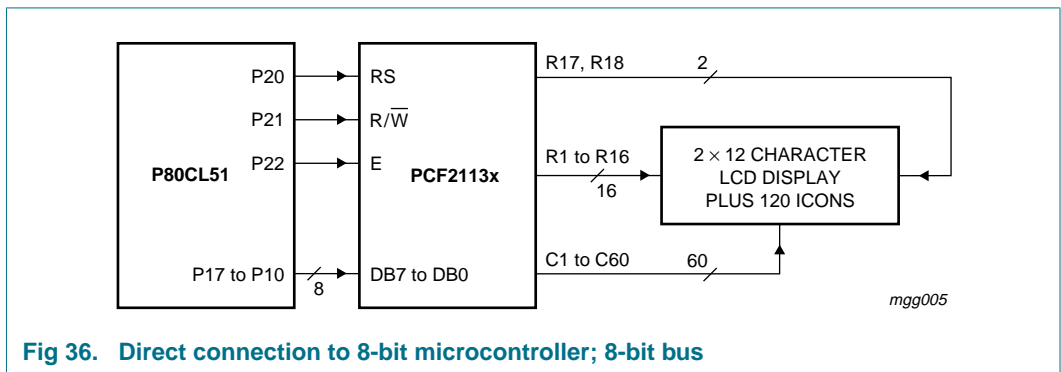
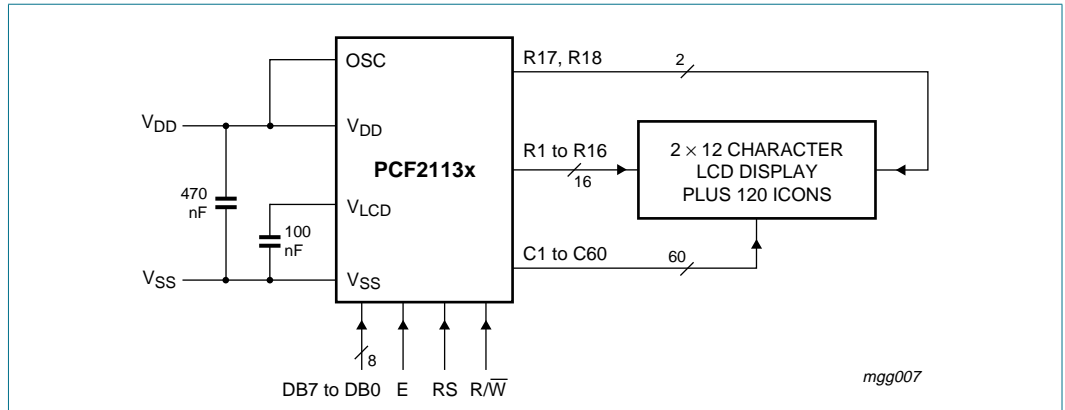
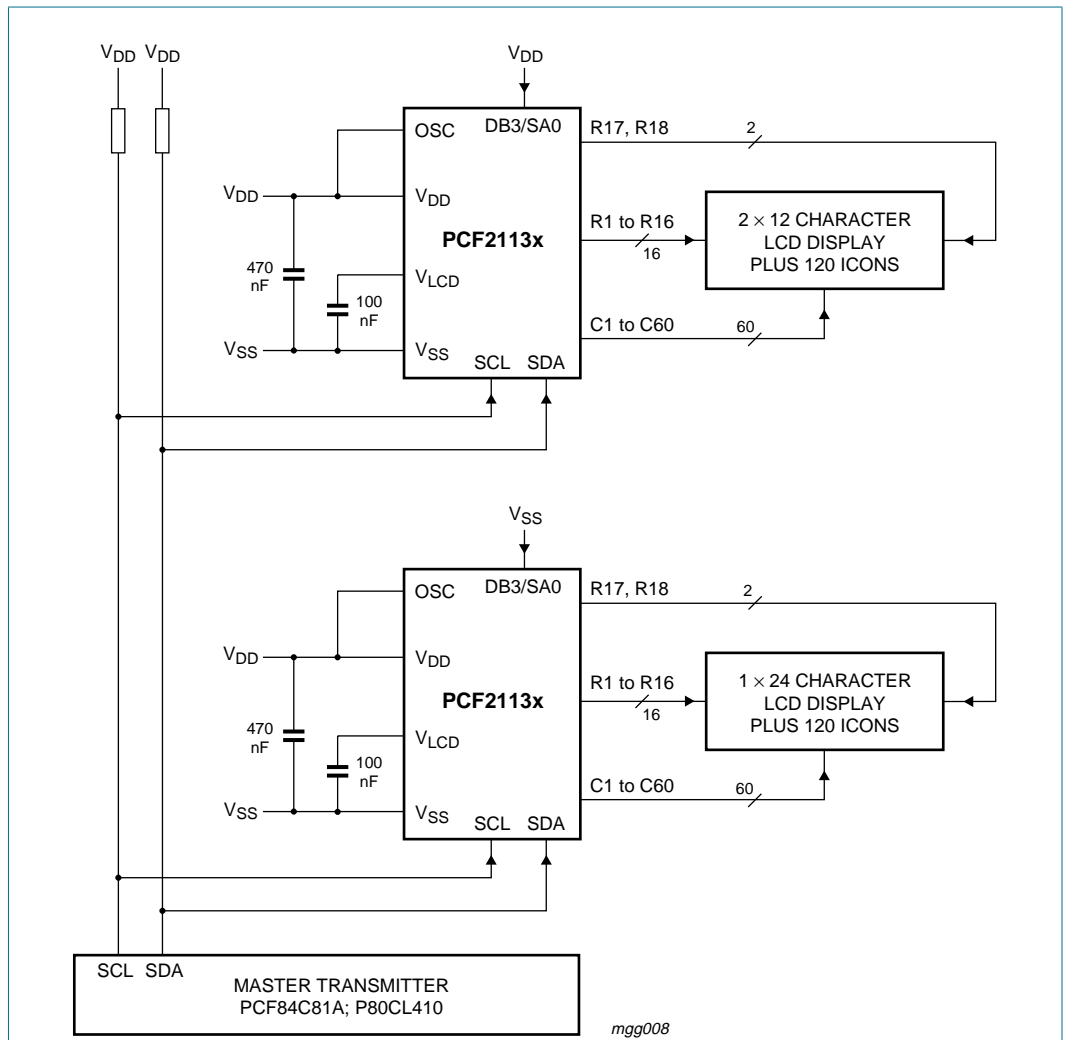


Fig 36. Direct connection to 8-bit microcontroller; 8-bit bus



**Fig 37. Typical application using parallel interface**



**Fig 38. Application using I<sup>2</sup>C-bus interface**



### 16.2 General application information

The required minimum value for the external capacitors in an application with the PCF2113x are:  $C_{ext} \geq 100$  nF between  $V_{LCD}$  and  $V_{SS}$ , and  $C_{ext} \geq 470$  nF between  $V_{DD}$  and  $V_{SS}$ . Higher capacitor values are recommended for ripple reduction.

For COG applications the recommended Indium Tin Oxide (ITO) track resistance is to be minimized for the I/O and supply connections. Optimized values for these tracks are below 50  $\Omega$  for the supply and below 100  $\Omega$  for the I/O connections. Higher track resistances reduce performance and increase current consumption.

To avoid accidental triggering of power-on reset (especially in COG applications), the supplies must be adequately decoupled. Depending on power supply quality,  $V_{DD1}$  may have to be risen above the specified minimum.

### 16.3 4-bit operation, 1-line display using internal reset

The program must set functions prior to a 4-bit operation (see [Table 21](#)). When power is turned on, 8-bit operation is automatically selected and the PCF2113x attempts to perform the first write as an 8-bit operation. Since nothing is connected to DB0 to DB3, a rewrite is then required. However, since one operation is completed in two accesses of 4-bit operation, a rewrite is required to set the functions (see [Table 21](#) step 3). Thus, DB4 to DB7 of the 'function set' are written twice.

**Table 21. 4-bit operation, 1-line display example using internal reset**

| Step | Instruction   | Display | Operation                       |     |     |     |     |    |   |   |   |   |   |   |   |  |  |
|------|---|---------|---------------------------------|-----|-----|-----|-----|----|---|---|---|---|---|---|---|--|--|
| 1    | internal power supply on (PCF2113x is initialized by the internal reset)  |         | initialized; no display appears |     |     |     |     |    |   |   |   |   |   |   |   |  |  |
| 2    | function set<br><table border="1" style="margin-left: 20px;"> <tr> <td>RS</td> <td>R/W</td> <td>DB7</td> <td>DB6</td> <td>DB5</td> <td>DB4</td> </tr> <tr> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>1</td> <td>0</td> </tr> </table>                           | RS      | R/W                             | DB7 | DB6 | DB5 | DB4 | 0  | 0 | 0 | 0 | 1 | 0 |   | sets a 4-bit operation; in this instance operation is handled as 8-bit by initialization and only this instruction completes with one write |  |  |
| RS   | R/W   | DB7     | DB6                             | DB5 | DB4 |     |     |    |   |   |   |   |   |   |   |  |  |
| 0    | 0   | 0       | 0                               | 1   | 0   |     |     |    |   |   |   |   |   |   |   |  |  |
| 3    | function set<br><table border="1" style="margin-left: 20px;"> <tr> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>1</td> <td>0</td> </tr> <tr> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> </tr> </table>                                      | 0       | 0                               | 0   | 0   | 1   | 0   | 0  | 0 | 0 | 0 | 0 | 0 |   | sets to 4-bit operation, selects 1-line display and $V_{LCD} = V_A$ ; 4-bit operation starts from this point and resetting is needed        |  |  |
| 0    | 0   | 0       | 0                               | 1   | 0   |     |     |    |   |   |   |   |   |   |   |  |  |
| 0    | 0   | 0       | 0                               | 0   | 0   |     |     |    |   |   |   |   |   |   |   |  |  |
| 4    | display control<br><table border="1" style="margin-left: 20px;"> <tr> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>—</td> </tr> <tr> <td>0</td> <td>0</td> <td>1</td> <td>1</td> <td>1</td> <td>0</td> <td></td> </tr> </table>              | 0       | 0                               | 0   | 0   | 0   | 0   | —  | 0 | 0 | 1 | 1 | 1 | 0 |   |  | turns on display and cursor; entire display is blank after initialization  |
| 0    | 0   | 0       | 0                               | 0   | 0   | —   |     |    |   |   |   |   |   |   |   |  |  |
| 0    | 0   | 1       | 1                               | 1   | 0   |     |     |    |   |   |   |   |   |   |   |  |  |
| 5    | entry mode set<br><table border="1" style="margin-left: 20px;"> <tr> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>—</td> </tr> <tr> <td>0</td> <td>0</td> <td>0</td> <td>1</td> <td>1</td> <td>0</td> <td></td> </tr> </table>               | 0       | 0                               | 0   | 0   | 0   | 0   | —  | 0 | 0 | 0 | 1 | 1 | 0 |   |  | sets mode to increment address by 1 and to shift the cursor to the right at the time of write to the DDRAM/CGRAM; display is not shifted |
| 0    | 0   | 0       | 0                               | 0   | 0   | —   |     |    |   |   |   |   |   |   |   |  |  |
| 0    | 0   | 0       | 1                               | 1   | 0   |     |     |    |   |   |   |   |   |   |   |  |  |
| 6    | 'write data' to CGRAM/DDRAM<br><table border="1" style="margin-left: 20px;"> <tr> <td>1</td> <td>0</td> <td>0</td> <td>1</td> <td>0</td> <td>1</td> <td>P—</td> </tr> <tr> <td>1</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td></td> </tr> </table> | 1       | 0                               | 0   | 1   | 0   | 1   | P— | 1 | 0 | 0 | 0 | 0 | 0 |   |  | writes 'P'; the DDRAM has already been selected by initialization at power-on; the cursor is incremented by 1 and shifted to the right   |
| 1    | 0   | 0       | 1                               | 0   | 1   | P—  |     |    |   |   |   |   |   |   |   |  |  |
| 1    | 0   | 0       | 0                               | 0   | 0   |     |     |    |   |   |   |   |   |   |   |  |  |

### 16.4 8-bit operation, 1-line display using internal reset

[Table 22](#) and [Table 23](#) show an example of a 1-line display in 8-bit operation. The PCF2113x functions must be set by the 'function set' instruction prior to display. Since the DDRAM can store data for 80 characters, the RAM can be used for advertising displays

when combined with display shift operation. Since the display shift operation changes display position only and the DDRAM contents remain unchanged, display data entered first can be displayed when the 'return home' operation is performed.

**Table 22. 8-bit operation, 1-line display example; using internal reset (character set 'A')**

| Step     | Instruction   |     |     |     |     |     |     |     |     |     | Display  | Operation  |
|----------|---|-----|-----|-----|-----|-----|-----|-----|-----|-----|----------|--|
|          | RS  | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |          |  |
| 1        | power supply on (PCF2113x is initialized by the internal reset) |     |     |     |     |     |     |     |     |     |          | initialized; no display appears  |
| 2        | function set  |     |     |     |     |     |     |     |     |     |          | sets to 8-bit operation, selects 1-line display and $V_{LCD} = V_A$  |
|          | 0   | 0   | 0   | 0   | 1   | 1   | 0   | 0   | 0   | 0   |          |  |
| 3        | display control   |     |     |     |     |     |     |     |     |     |          | turns on display and cursor; entire display is blank after initialization  |
|          | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 0   |          |  |
| 4        | entry mode set  |     |     |     |     |     |     |     |     |     |          | sets mode to increment the address by 1 and to shift the cursor to the right at the time of the write to the DDRAM/CGRAM; display is not shifted |
|          | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 0   |          |  |
| 5        | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     | P        | writes 'P'; the DDRAM has already been selected by initialization at power-on; the cursor is incremented by 1 and shifted to the right           |
|          | 1   | 0   | 0   | 1   | 0   | 1   | 0   | 0   | 0   | 0   |          |  |
| 6        | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     | PH       | writes 'H'   |
|          | 1   | 0   | 0   | 1   | 0   | 0   | 1   | 0   | 0   | 0   |          |  |
| 7 to 10  | :   |     |     |     |     |     |     |     |     |     |          | writes 'ILIP'  |
|          | :   |     |     |     |     |     |     |     |     |     |          |  |
| 11       | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     | PHILIPS  | writes 'S'   |
|          | 1   | 0   | 0   | 1   | 0   | 1   | 0   | 0   | 1   | 1   |          |  |
| 12       | entry mode set  |     |     |     |     |     |     |     |     |     | PHILIPS  | sets mode for display shift at time of write   |
|          | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 1   |          |  |
| 13       | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     | HILIPS   | writes space   |
|          | 1   | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   |          |  |
| 14       | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     | HILIPS M | writes 'M'   |
|          | 1   | 0   | 0   | 1   | 0   | 0   | 1   | 1   | 0   | 1   |          |  |
| 15 to 19 | :   |     |     |     |     |     |     |     |     |     |          | writes 'ICROK'   |
|          | :   |     |     |     |     |     |     |     |     |     |          |  |
| 20       | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     | MICROKO  | writes 'O'   |
|          | 1   | 0   | 0   | 1   | 0   | 0   | 1   | 1   | 1   | 1   |          |  |
| 21       | cursor/display shift  |     |     |     |     |     |     |     |     |     | MICROKO  | shifts only the cursor position to the left  |
|          | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   |          |  |
| 22       | cursor/display shift  |     |     |     |     |     |     |     |     |     | MICROKO  | shifts only the cursor position to the left  |
|          | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   |          |  |
| 23       | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     | ICROCO   | writes 'C' correction; the display moves to the left   |
|          | 1   | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 1   | 1   |          |  |
| 24       | cursor/display shift  |     |     |     |     |     |     |     |     |     | MICROCO  | shifts the display and cursor to the right   |
|          | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 0   | 0   |          |  |

**Table 22. 8-bit operation, 1-line display example; using internal reset (character set 'A') ...continued**

| Step | Instruction                 |     |     |     |     |     |     |     |     |     | Display   | Operation  |
|------|-----------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----------|--|
|      | RS                          | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |           |  |
| 25   | cursor/display shift        |     |     |     |     |     |     |     |     |     |           | shifts only the cursor to the right                                  |
|      | 0                           | 0   | 0   | 0   | 0   | 1   | 0   | 1   | 0   | 0   | MICROCO_  |  |
| 26   | 'write data' to CGRAM/DDRAM |     |     |     |     |     |     |     |     |     |           | writes 'M'   |
|      | 1                           | 0   | 0   | 1   | 0   | 0   | 1   | 1   | 0   | 1   | ICROCOM_  |  |
| 27   | return home                 |     |     |     |     |     |     |     |     |     |           | returns both display and cursor to the original position (address 0) |
|      | 0                           | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | PHILIPS M |  |

**Table 23. 8-bit operation, 1-line display and icon example; using internal reset (character set 'A')**

| Step | Instruction   |     |     |     |     |     |     |     |     |     | Display | Operation  |
|------|---|-----|-----|-----|-----|-----|-----|-----|-----|-----|---------|--|
|      | RS  | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |         |  |
| 1    | power supply on (PCF2113x is initialized by the internal reset) |     |     |     |     |     |     |     |     |     |         | initialized; no display appears  |
| 2    | function set  |     |     |     |     |     |     |     |     |     |         | sets to 8-bit operation, selects 1-line display and $V_{LCD} = V_A$  |
|      | 0   | 0   | 0   | 0   | 1   | 1   | 0   | 0   | 0   | 0   |         |  |
| 3    | display control   |     |     |     |     |     |     |     |     |     |         | turns on display and cursor; entire display is blank after initialization  |
|      | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 0   | _       |  |
| 4    | entry mode set  |     |     |     |     |     |     |     |     |     |         | sets mode to increment the address by 1 and to shift the cursor to the right at the time of the write to the DDRAM/CGRAM; display is not shifted |
|      | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 0   | _       |  |
| 5    | set CGRAM address   |     |     |     |     |     |     |     |     |     |         | sets the CGRAM address to position of character '0'; the CGRAM is selected   |
|      | 0   | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | _       |  |
| 6    | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     |         | writes data to CGRAM for icon even phase; icon appears   |
|      | 1   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 1   | 0   | _       |  |
| 7    | :   |     |     |     |     |     |     |     |     |     |         |  |
|      | :   |     |     |     |     |     |     |     |     |     |         |  |
| 8    | sets CGRAM address  |     |     |     |     |     |     |     |     |     |         | sets the CGRAM address to position of character '0'; the CGRAM is selected   |
|      | 0   | 0   | 0   | 1   | 1   | 1   | 0   | 0   | 0   | 0   | _       |  |
| 9    | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     |         | writes data to CGRAM for icon odd phase  |
|      | 1   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 1   | 0   | _       |  |
| 10   | :   |     |     |     |     |     |     |     |     |     |         |  |
|      | :   |     |     |     |     |     |     |     |     |     |         |  |
| 11   | function set  |     |     |     |     |     |     |     |     |     |         | sets H = 1: Extended instruction set   |
|      | 0   | 0   | 0   | 0   | 1   | 1   | 0   | 0   | 0   | 1   | _       |  |
| 12   | icon control  |     |     |     |     |     |     |     |     |     |         | icons blink  |
|      | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 1   | 0   | _       |  |
| 13   | function set  |     |     |     |     |     |     |     |     |     |         | sets H = 0   |
|      | 0   | 0   | 0   | 0   | 1   | 1   | 0   | 0   | 0   | 0   | _       |  |
| 14   | set DDRAM address   |     |     |     |     |     |     |     |     |     |         | sets the DDRAM to the first position; DDRAM is selected  |
|      | 0   | 0   | 1   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | _       |  |

**Table 23. 8-bit operation, 1-line display and icon example; using internal reset (character set 'A') ...continued**

| Step | Instruction                 |     |     |     |     |     |     |     |     |     | Display | Operation  |
|------|-----------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|---------|--|
|      | RS                          | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |         |  |
| 15   | 'write data' to CGRAM/DDRAM |     |     |     |     |     |     |     |     |     | P_      | writes 'P'; the cursor is incremented by 1 and shifted to the right  |
|      | 1                           | 0   | 0   | 1   | 0   | 1   | 0   | 0   | 0   | 0   |         |  |
| 16   | 'write data' to CGRAM/DDRAM |     |     |     |     |     |     |     |     |     | PH_     | writes 'H'   |
|      | 1                           | 0   | 0   | 1   | 0   | 0   | 1   | 0   | 0   | 0   |         |  |
| 17   | :                           |     |     |     |     |     |     |     |     |     |         | writes 'ILIPS'   |
|      | :                           |     |     |     |     |     |     |     |     |     |         |  |
| 22   | return home                 |     |     |     |     |     |     |     |     |     | PHILIPS | returns both display and cursor to the original position (address 0) |
|      | 0                           | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   |         |  |

### 16.5 8-bit operation, 2-line display

For a 2-line display the cursor automatically moves from the first to the second line after the 40th digit of the first line has been written. Thus, if there are only 8 characters in the first line, the DDRAM address must be set after the 8th character is completed (see [Table 24](#)). It should be noted that both lines of the display are always shifted together; data does not shift from one line to the other.

**Table 24. 8-bit operation, 2-line display example; using internal reset**

| Step    | Instruction   |     |     |     |     |     |     |     |     |     | Display  | Operation  |
|---------|---|-----|-----|-----|-----|-----|-----|-----|-----|-----|----------|--|
|         | RS  | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |          |  |
| 1       | power supply on (PCF2113x is initialized by the internal reset) |     |     |     |     |     |     |     |     |     |          | initialized; no display appears  |
| 2       | function set  |     |     |     |     |     |     |     |     |     |          | sets to 8-bit operation, selects 1-line display and $V_{LCD} = VA$   |
|         | 0   | 0   | 0   | 0   | 1   | 1   | 0   | 1   | 0   | 0   |          |  |
| 3       | display control   |     |     |     |     |     |     |     |     |     |          | turns on display and cursor; entire display is blank after initialization  |
|         | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 1   | 0   | _        |  |
| 4       | entry mode set  |     |     |     |     |     |     |     |     |     |          | sets mode to increment the address by 1 and to shift the cursor to the right at the time of the write to the DDRAM/CGRAM; display is not shifted |
|         | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 0   | _        |  |
| 5       | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     | P_       | writes 'P'; the DDRAM has already been selected by initialization at power-on; the cursor is incremented by 1 and shifted to the right           |
|         | 1   | 0   | 0   | 1   | 0   | 1   | 0   | 0   | 0   | 0   |          |  |
| 6 to 10 | :   |     |     |     |     |     |     |     |     |     |          | writes 'HILIP'   |
|         | :   |     |     |     |     |     |     |     |     |     |          |  |
| 11      | 'write data' to CGRAM/DDRAM                                     |     |     |     |     |     |     |     |     |     | PHILIPS_ | writes 'S'   |
|         | 1   | 0   | 0   | 1   | 0   | 1   | 0   | 0   | 1   | 1   |          |  |
| 12      | sets DDRAM address  |     |     |     |     |     |     |     |     |     | PHILIPS  | sets DDRAM to position the cursor at the start of the 2nd line   |
|         | 0   | 0   | 1   | 1   | 0   | 0   | 0   | 0   | 0   | 0   |          |  |

Table 24. 8-bit operation, 2-line display example; using internal reset ...continued

| Step     | Instruction                 |     |     |     |     |     |     |     |     |     | Display             | Operation  |
|----------|-----------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|---------------------|--|
|          | RS                          | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |                     |  |
| 13       | 'write data' to CGRAM/DDRAM |     |     |     |     |     |     |     |     |     | PHILIPS<br>M_       | writes 'M'   |
|          | 1                           | 0   | 0   | 1   | 0   | 0   | 1   | 1   | 0   | 1   |                     |  |
| 14 to 18 | :                           |     |     |     |     |     |     |     |     |     |                     | writes 'ICROC'   |
|          | :                           |     |     |     |     |     |     |     |     |     |                     |  |
| 19       | 'write data' to CGRAM/DDRAM |     |     |     |     |     |     |     |     |     | PHILIPS<br>MICROCO_ | writes 'O'   |
|          | 1                           | 0   | 0   | 1   | 0   | 0   | 1   | 1   | 1   | 1   |                     |  |
| 20       | entry mode set              |     |     |     |     |     |     |     |     |     | PHILIPS<br>MICROCO_ | sets mode for display shift at the time of write                                 |
|          | 0                           | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 1   | 1   |                     |  |
| 21       | 'write data' to CGRAM/DDRAM |     |     |     |     |     |     |     |     |     | HILIPS<br>ICROCOM_  | writes 'M'; display is shifted to the left; the 1st and 2nd lines shift together |
|          | 1                           | 0   | 0   | 1   | 0   | 0   | 1   | 1   | 0   | 1   |                     |  |
| 22       | return home                 |     |     |     |     |     |     |     |     |     | PHILIPS<br>MICROCOM | returns both the display and cursor to the original position (address 0)         |
|          | 0                           | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | 0   |                     |  |

### 16.6 I<sup>2</sup>C-bus operation, 1-line display

A control byte is required with most commands (see Table 25).

Table 25. Example of I<sup>2</sup>C-bus operation; 1-line display (using internal reset, assuming SA0 = V<sub>SS</sub>) [1]

| Step | I <sup>2</sup> C-bus byte              | Display | Operation   |
|------|--|---------|---|
| 1    | I <sup>2</sup> C-bus start             |         | initialized; no display appears   |
| 2    | slave address for write                |         | during the acknowledge cycle SDA is pulled down by the PCF2113x   |
|      | SA6 SA5 SA4 SA3 SA2 SA1 SA0 R/W Ack    |         |   |
|      | 0 1 1 1 0 1 0 0 0                      |         |   |
| 3    | send a control byte for 'function set' |         | control byte sets RS for the following data bytes   |
|      | Co RS 0 0 0 0 0 0 Ack                  |         |   |
|      | 0 0 0 0 0 0 0 0 1                      |         |   |
| 4    | function set                           |         | selects 1-line display and V <sub>LCD</sub> = VA; SCL pulse during acknowledge cycle starts execution of instruction                            |
|      | DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 Ack    |         |   |
|      | 0 0 1 X 0 0 0 0 1                      |         |   |
| 5    | display control                        |         | turns on display and cursor; entire display shows character 20h (blank in ASCII-like character sets)  |
|      | DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 Ack    |         |   |
|      | 0 0 0 0 1 1 1 0 1                      |         |   |
| 6    | entry mode set                         |         | sets mode to increment the address by 1 and to shift the cursor to the right at the time of write to the DDRAM or CGRAM; display is not shifted |
|      | DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 Ack    |         |   |
|      | 0 0 0 0 0 1 1 0 1                      |         |   |

**Table 25. Example of I<sup>2</sup>C-bus operation; 1-line display (using internal reset, assuming SA0 = V<sub>SS</sub>)** [\[1\]](#) ...continued

| Step     | I <sup>2</sup> C-bus byte  | Display  | Operation   |     |     |     |     |     |     |     |   |   |   |   |   |   |   |   |   |          |  |
|----------|--|----------|---|-----|-----|-----|-----|-----|-----|-----|---|---|---|---|---|---|---|---|---|----------|--|
| 7        | I <sup>2</sup> C-bus start   | —        | to write data to DDRAM, RS must be set to 1 so a control byte is needed |     |     |     |     |     |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 8        | slave address for write<br><table border="1"> <tr> <td>SA6</td><td>SA5</td><td>SA4</td><td>SA3</td><td>SA2</td><td>SA1</td><td>SA0</td><td>R/W</td><td>Ack</td> </tr> <tr> <td>0</td><td>1</td><td>1</td><td>1</td><td>0</td><td>1</td><td>0</td><td>0</td><td>1</td> </tr> </table> | SA6      | SA5   | SA4 | SA3 | SA2 | SA1 | SA0 | R/W | Ack | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | —        |  |
| SA6      | SA5  | SA4      | SA3   | SA2 | SA1 | SA0 | R/W | Ack |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 0        | 1  | 1        | 1   | 0   | 1   | 0   | 0   | 1   |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 9        | send a control byte for 'write data'<br><table border="1"> <tr> <td>Co</td><td>RS</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>Ack</td> </tr> <tr> <td>0</td><td>1</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>1</td> </tr> </table>  | Co       | RS  | 0   | 0   | 0   | 0   | 0   | 0   | Ack | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | —        |  |
| Co       | RS   | 0        | 0   | 0   | 0   | 0   | 0   | Ack |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 0        | 1  | 0        | 0   | 0   | 0   | 0   | 0   | 1   |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 10       | 'write data' to DDRAM<br><table border="1"> <tr> <td>DB7</td><td>DB6</td><td>DB5</td><td>DB4</td><td>DB3</td><td>DB2</td><td>DB1</td><td>DB0</td><td>Ack</td> </tr> <tr> <td>0</td><td>1</td><td>0</td><td>1</td><td>0</td><td>0</td><td>0</td><td>0</td><td>1</td> </tr> </table>   | DB7      | DB6   | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | P_       | writes 'P'; the DDRAM is selected at power-up; the cursor is incremented by 1 and shifted to the right   |
| DB7      | DB6  | DB5      | DB4   | DB3 | DB2 | DB1 | DB0 | Ack |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 0        | 1  | 0        | 1   | 0   | 0   | 0   | 0   | 1   |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 11       | 'write data' to DDRAM<br><table border="1"> <tr> <td>DB7</td><td>DB6</td><td>DB5</td><td>DB4</td><td>DB3</td><td>DB2</td><td>DB1</td><td>DB0</td><td>Ack</td> </tr> <tr> <td>0</td><td>1</td><td>0</td><td>0</td><td>1</td><td>0</td><td>0</td><td>0</td><td>1</td> </tr> </table>   | DB7      | DB6   | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | PH_      | writes 'H'   |
| DB7      | DB6  | DB5      | DB4   | DB3 | DB2 | DB1 | DB0 | Ack |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 0        | 1  | 0        | 0   | 1   | 0   | 0   | 0   | 1   |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 12 to 15 | :  | :        | writes 'ILIP'   |     |     |     |     |     |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 16       | 'write data' to DDRAM<br><table border="1"> <tr> <td>DB7</td><td>DB6</td><td>DB5</td><td>DB4</td><td>DB3</td><td>DB2</td><td>DB1</td><td>DB0</td><td>Ack</td> </tr> <tr> <td>0</td><td>1</td><td>0</td><td>1</td><td>0</td><td>0</td><td>1</td><td>1</td><td>1</td> </tr> </table>   | DB7      | DB6   | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | PHILIPS_ | writes 'S'   |
| DB7      | DB6  | DB5      | DB4   | DB3 | DB2 | DB1 | DB0 | Ack |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 0        | 1  | 0        | 1   | 0   | 0   | 1   | 1   | 1   |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 17       | (optional I <sup>2</sup> C-bus stop) I <sup>2</sup> C-bus start + slave address for write (as step 8)  | PHILIPS_ |   |     |     |     |     |     |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 18       | control byte<br><table border="1"> <tr> <td>Co</td><td>RS</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>Ack</td> </tr> <tr> <td>1</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>1</td> </tr> </table>                          | Co       | RS  | 0   | 0   | 0   | 0   | 0   | 0   | Ack | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | PHILIPS_ |  |
| Co       | RS   | 0        | 0   | 0   | 0   | 0   | 0   | Ack |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 1        | 0  | 0        | 0   | 0   | 0   | 0   | 0   | 1   |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 19       | return home<br><table border="1"> <tr> <td>DB7</td><td>DB6</td><td>DB5</td><td>DB4</td><td>DB3</td><td>DB2</td><td>DB1</td><td>DB0</td><td>Ack</td> </tr> <tr> <td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>1</td><td>0</td><td>1</td> </tr> </table>             | DB7      | DB6   | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | PHILIPS  | sets DDRAM address 0 in address counter (also returns shifted display to original position; DDRAM contents unchanged); this instruction does not update the Data Register (DR)   |
| DB7      | DB6  | DB5      | DB4   | DB3 | DB2 | DB1 | DB0 | Ack |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 0        | 0  | 0        | 0   | 0   | 0   | 1   | 0   | 1   |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 20       | I <sup>2</sup> C-bus start   | PHILIPS  |   |     |     |     |     |     |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 21       | slave address for read<br><table border="1"> <tr> <td>SA6</td><td>SA5</td><td>SA4</td><td>SA3</td><td>SA2</td><td>SA1</td><td>SA0</td><td>R/W</td><td>Ack</td> </tr> <tr> <td>0</td><td>1</td><td>1</td><td>1</td><td>0</td><td>1</td><td>0</td><td>1</td><td>1</td> </tr> </table>  | SA6      | SA5   | SA4 | SA3 | SA2 | SA1 | SA0 | R/W | Ack | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | PHILIPS  | during the acknowledge cycle the content of DR is loaded into the internal I <sup>2</sup> C-bus interface to be shifted out; in the previous instruction neither a 'set address' nor a 'read data' has been performed, so the content of the DR was unknown; the R/W has to be set to 1 while still in the I <sup>2</sup> C-bus write mode |
| SA6      | SA5  | SA4      | SA3   | SA2 | SA1 | SA0 | R/W | Ack |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 0        | 1  | 1        | 1   | 0   | 1   | 0   | 1   | 1   |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 22       | control byte for read<br><table border="1"> <tr> <td>Co</td><td>RS</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>Ack</td> </tr> <tr> <td>0</td><td>1</td><td>1</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>1</td> </tr> </table>                 | Co       | RS  | 0   | 0   | 0   | 0   | 0   | 0   | Ack | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | PHILIPS  | DDRAM content is read from the following instructions  |
| Co       | RS   | 0        | 0   | 0   | 0   | 0   | 0   | Ack |     |     |   |   |   |   |   |   |   |   |   |          |  |
| 0        | 1  | 1        | 0   | 0   | 0   | 0   | 0   | 1   |     |     |   |   |   |   |   |   |   |   |   |          |  |

**Table 25. Example of I<sup>2</sup>C-bus operation; 1-line display (using internal reset, assuming SA0 = V<sub>SS</sub>) [1] ...continued**

| Step | I <sup>2</sup> C-bus byte   | Display | Operation   |     |     |     |     |     |     |     |     |     |   |   |   |   |   |   |
|------|---|---------|---|-----|-----|-----|-----|-----|-----|-----|-----|-----|---|---|---|---|---|---|
| 23   | 'read data': 8 × SCL + master acknowledge [2]   | PHILIPS | 8 × SCL; content loaded into interface during previous acknowledge cycle is shifted out over SDA; MSB is DB7; during master acknowledge content of DDRAM address 01 is loaded into the I <sup>2</sup> C-bus interface   |     |     |     |     |     |     |     |     |     |   |   |   |   |   |   |
|      | <table border="1"> <thead> <tr> <th>DB7</th><th>DB6</th><th>DB5</th><th>DB4</th><th>DB3</th><th>DB2</th><th>DB1</th><th>DB0</th><th>Ack</th> </tr> </thead> <tbody> <tr> <td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>0</td> </tr> </tbody> </table> |         |   | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | X | X | X | X | X | X |
| DB7  | DB6   | DB5     | DB4   | DB3 | DB2 | DB1 | DB0 | Ack |     |     |     |     |   |   |   |   |   |   |
| X    | X   | X       | X   | X   | X   | X   | X   | 0   |     |     |     |     |   |   |   |   |   |   |
| 24   | 'read data': 8 × SCL + master acknowledge [2]   | PHILIPS | 8 × SCL; code of letter 'H' is read first; during master acknowledge, code of 'l' is loaded into the I <sup>2</sup> C-bus interface   |     |     |     |     |     |     |     |     |     |   |   |   |   |   |   |
|      | <table border="1"> <thead> <tr> <th>DB7</th><th>DB6</th><th>DB5</th><th>DB4</th><th>DB3</th><th>DB2</th><th>DB1</th><th>DB0</th><th>Ack</th> </tr> </thead> <tbody> <tr> <td>0</td><td>1</td><td>0</td><td>0</td><td>1</td><td>0</td><td>0</td><td>0</td><td>0</td> </tr> </tbody> </table> |         |   | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | 0 | 1 | 0 | 0 | 1 | 0 |
| DB7  | DB6   | DB5     | DB4   | DB3 | DB2 | DB1 | DB0 | Ack |     |     |     |     |   |   |   |   |   |   |
| 0    | 1   | 0       | 0   | 1   | 0   | 0   | 0   | 0   |     |     |     |     |   |   |   |   |   |   |
| 25   | 'read data': 8 × SCL + master acknowledge [2]   | PHILIPS | no master acknowledge;<br>-after the content of the I <sup>2</sup> C-bus interface register is shifted out no internal action is performed;<br>-no new data is loaded into the interface register;<br>-data register is not updated;<br>-address counter is not incremented and cursor is not shifted |     |     |     |     |     |     |     |     |     |   |   |   |   |   |   |
|      | <table border="1"> <thead> <tr> <th>DB7</th><th>DB6</th><th>DB5</th><th>DB4</th><th>DB3</th><th>DB2</th><th>DB1</th><th>DB0</th><th>Ack</th> </tr> </thead> <tbody> <tr> <td>0</td><td>1</td><td>0</td><td>0</td><td>1</td><td>0</td><td>0</td><td>1</td><td>1</td> </tr> </tbody> </table> |         |   | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | 0 | 1 | 0 | 0 | 1 | 0 |
| DB7  | DB6   | DB5     | DB4   | DB3 | DB2 | DB1 | DB0 | Ack |     |     |     |     |   |   |   |   |   |   |
| 0    | 1   | 0       | 0   | 1   | 0   | 0   | 1   | 1   |     |     |     |     |   |   |   |   |   |   |
| 26   | I <sup>2</sup> C-bus stop   | PHILIPS |   |     |     |     |     |     |     |     |     |     |   |   |   |   |   |   |

[1] X = not relevant.

[2] SDA is left at high-impedance by the microcontroller during the read acknowledge.

**Table 26. Initialization by instruction, 8-bit interface [1]**

| Step | Instruction          |     |     |     |     |     |     |     |     |     | Description  |  |
|------|----------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|--|--|
|      | RS                   | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |  |  |
| 1    | internal reset       |     |     |     |     |     |     |     |     |     | :<br>:   | starting from power-on or unknown state  |
| 2    | wait 2 ms            |     |     |     |     |     |     |     |     |     | :<br>:   |  |
| 3    | 0                    | 0   | 0   | 0   | 1   | 1   | X   | X   | X   | X   | function set (interface is 8 bit long). Busy Flag (BF) cannot be checked before this instruction |  |
| 4    | wait 2 ms            |     |     |     |     |     |     |     |     |     | :<br>:   |  |
| 5    | 0                    | 0   | 0   | 0   | 1   | 1   | X   | X   | X   | X   | function set (interface is 8 bit long). BF cannot be checked before this instruction             |  |
| 6    | wait more than 40 μs |     |     |     |     |     |     |     |     |     | :<br>:   |  |
| 7    | 0                    | 0   | 0   | 0   | 1   | 1   | X   | X   | X   | X   | function set (interface is 8 bit long). BF cannot be checked before this instruction             |  |
| 8    |                      |     |     |     |     |     |     |     |     |     | :<br>:<br>:  | BF can be checked after the following instructions; when BF is not checked the waiting time between instructions is the specified instruction time (see <a href="#">Table 10</a> ) |
| 9    | 0                    | 0   | 0   | 0   | 1   | 1   | 0   | M   | 0   | H   | function set (interface is 8 bit long); specify the number of display lines                      |  |
| 10   | 0                    | 0   | 0   | 0   | 0   | 0   | 1   | 0   | 0   | 0   | display off  |  |

**Table 26. Initialization by instruction, 8-bit interface** [\[1\]](#) ...continued

| Step | Instruction         |     |     |     |     |     |     |     |     |     | Description    |
|------|---------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|----------------|
|      | RS                  | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |                |
| 11   | 0                   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | clear display  |
| 12   | 0                   | 0   | 0   | 0   | 0   | 0   | 0   | 1   | I/D | S   | entry mode set |
|      | :                   |     |     |     |     |     |     |     |     |     |                |
| 13   | initialization ends |     |     |     |     |     |     |     |     |     |                |

[1] X = not relevant.

**Table 27. Initialization by instruction, 4-bit interface; not applicable for I<sup>2</sup>C-bus operation**

| Step | Instruction          |     |     |     |     |     | Description  |
|------|----------------------|-----|-----|-----|-----|-----|--|
| 1    | internal reset       |     |     |     |     |     | starting from power-on or unknown state  |
|      | :                    |     |     |     |     |     |  |
| 2    | wait 2 ms            |     |     |     |     |     |  |
|      | :                    |     |     |     |     |     |  |
| 3    | RS                   | R/W | DB7 | DB6 | DB5 | DB4 | BF cannot be checked before this instruction   |
|      | 0                    | 0   | 0   | 0   | 1   | 1   | function set (interface is 8 bit long)   |
| 4    | wait 2 ms            |     |     |     |     |     |  |
|      | :                    |     |     |     |     |     |  |
| 5    | RS                   | R/W | DB7 | DB6 | DB5 | DB4 | BF cannot be checked before this instruction   |
|      | 0                    | 0   | 0   | 0   | 1   | 1   | function set (interface is 8 bit long)   |
| 6    | wait more than 40 μs |     |     |     |     |     |  |
|      | :                    |     |     |     |     |     |  |
| 7    | RS                   | R/W | DB7 | DB6 | DB5 | DB4 | BF cannot be checked before this instruction   |
|      | 0                    | 0   | 0   | 0   | 1   | 1   | function set (interface is 8 bit long)   |
| 8    | :                    |     |     |     |     |     | BF can be checked after the following instructions; when BF is not checked the waiting time between instructions is the specified instruction time (see <a href="#">Table 10</a> ) |
|      | :                    |     |     |     |     |     |  |
| 9    | RS                   | R/W | DB7 | DB6 | DB5 | DB4 | function set (set interface to 4 bit long)   |
|      | 0                    | 0   | 0   | 0   | 1   | 0   | interface is 8 bit long  |
| 10   | 0                    | 0   | 0   | 0   | 1   | 0   | function set (interface is 4 bit long)   |
|      | 0                    | 0   | 0   | M   | 0   | H   | specify number of display lines  |
| 11   | 0                    | 0   | 0   | 0   | 0   | 0   | display off  |
|      | 0                    | 0   | 1   | 0   | 0   | 0   |  |
| 12   | 0                    | 0   | 0   | 0   | 0   | 0   | clear display  |
|      | 0                    | 0   | 0   | 0   | 0   | 1   |  |
| 13   | 0                    | 0   | 0   | 0   | 0   | 0   | entry mode set   |
|      | 0                    | 0   | 0   | 1   | I/D | S   |  |
|      | :                    |     |     |     |     |     |  |
| 14   | initialization ends  |     |     |     |     |     |  |



**17. Package outline**

LQFP100: plastic low profile quad flat package; 100 leads; body 14 x 14 x 1.4 mm

SOT407-1

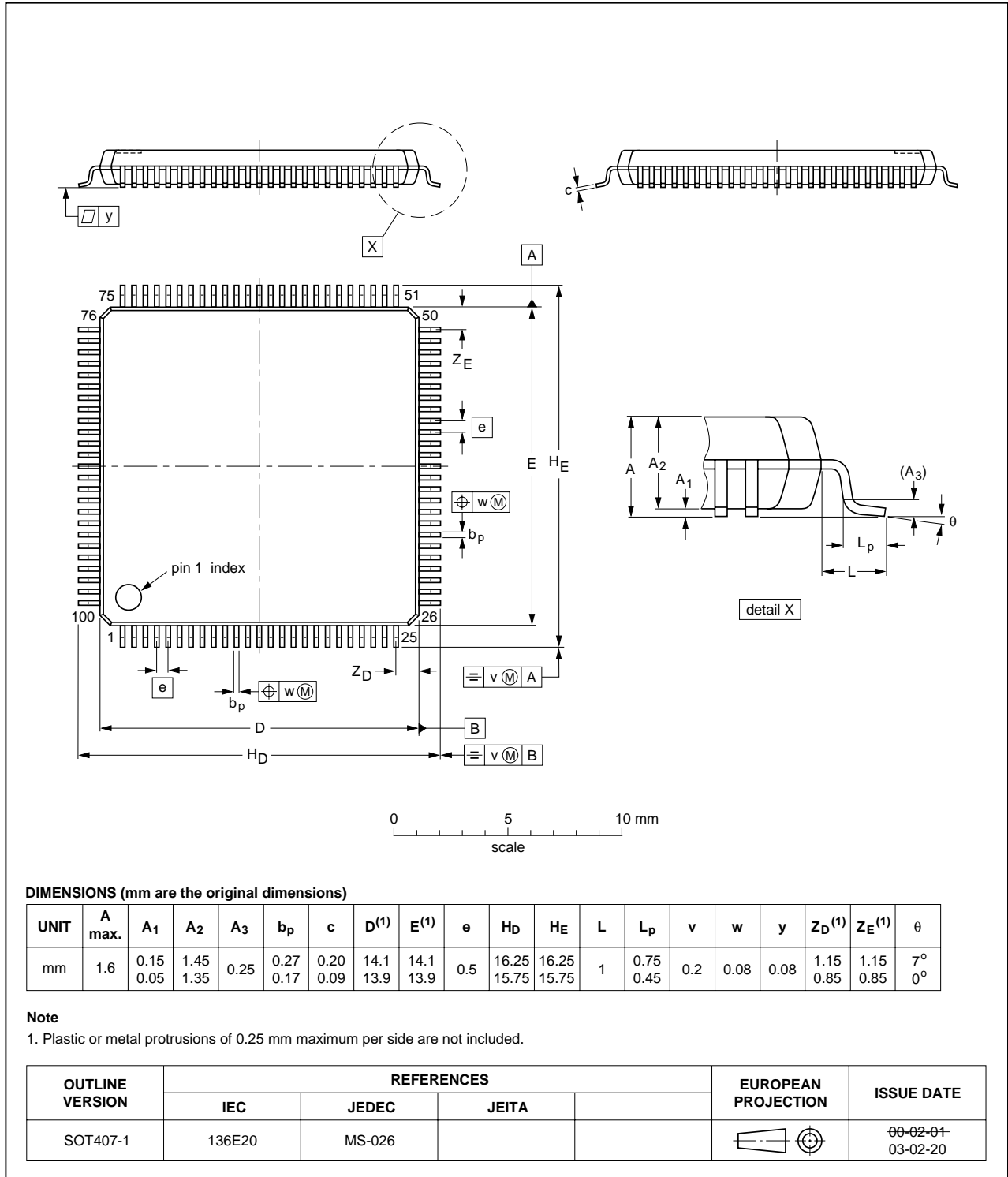


Fig 39. Package outline SOT407-1 (LQFP100)

## 18. Handling information

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be completely safe you must take normal precautions appropriate to handling MOS devices; see *JESD625-A* and/or *IEC61340-5*.

## 19. Packing information

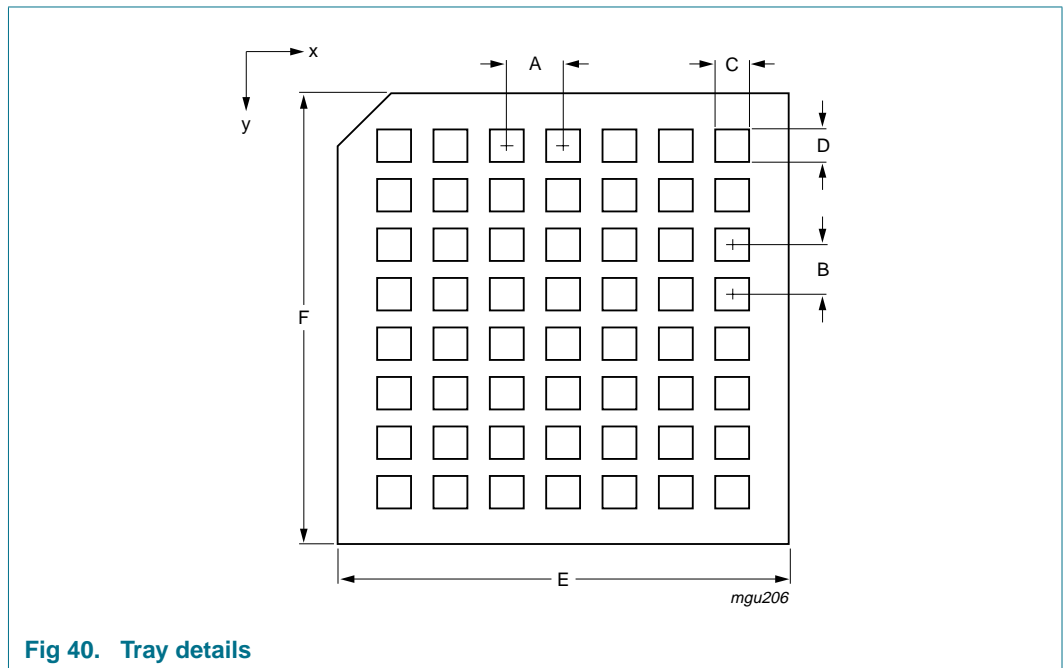


Fig 40. Tray details

Table 28. Tray dimensions (see Figure 40)

| Symbol | Description                    | Value   |
|--------|--------------------------------|---------|
| A      | pocket pitch in x direction    | 6.35 mm |
| B      | pocket pitch in y direction    | 5.59 mm |
| C      | pocket width in x direction    | 3.82 mm |
| D      | pocket width in y direction    | 3.66 mm |
| E      | tray width in x direction      | 50.8 mm |
| F      | tray width in y direction      | 50.8 mm |
| x      | number of pockets, x direction | 7       |
| y      | number of pockets, y direction | 8       |

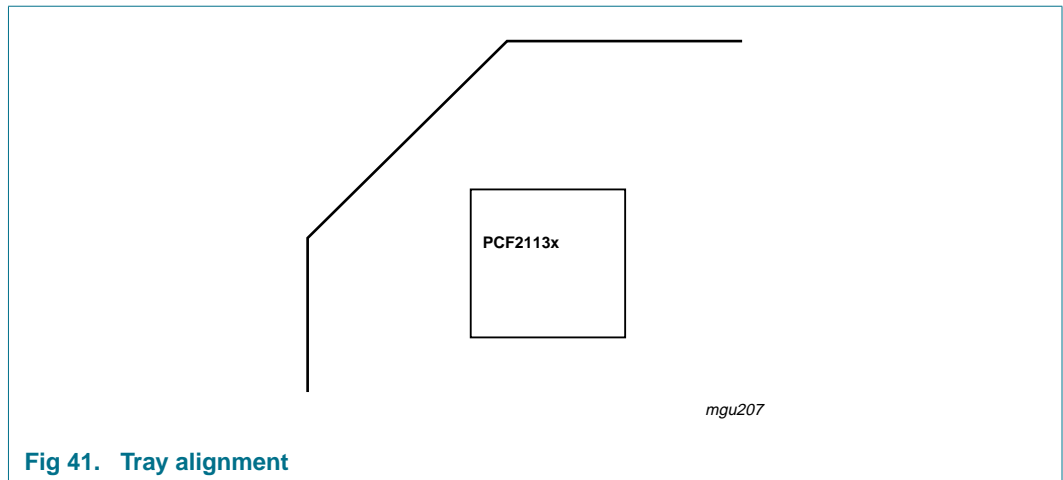


Fig 41. Tray alignment

The orientation of the IC in a pocket is indicated by the position of the IC type name on the die surface with respect to the chamfer on the upper left corner of the tray. Refer to the bonding pad location diagram ([Figure 3](#)) for the orientation and position of the type name on the die surface.

## 20. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

### 20.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 20.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

### 20.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

### 20.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see [Figure 42](#)) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with [Table 29](#) and [30](#)

**Table 29. SnPb eutectic process (from J-STD-020C)**

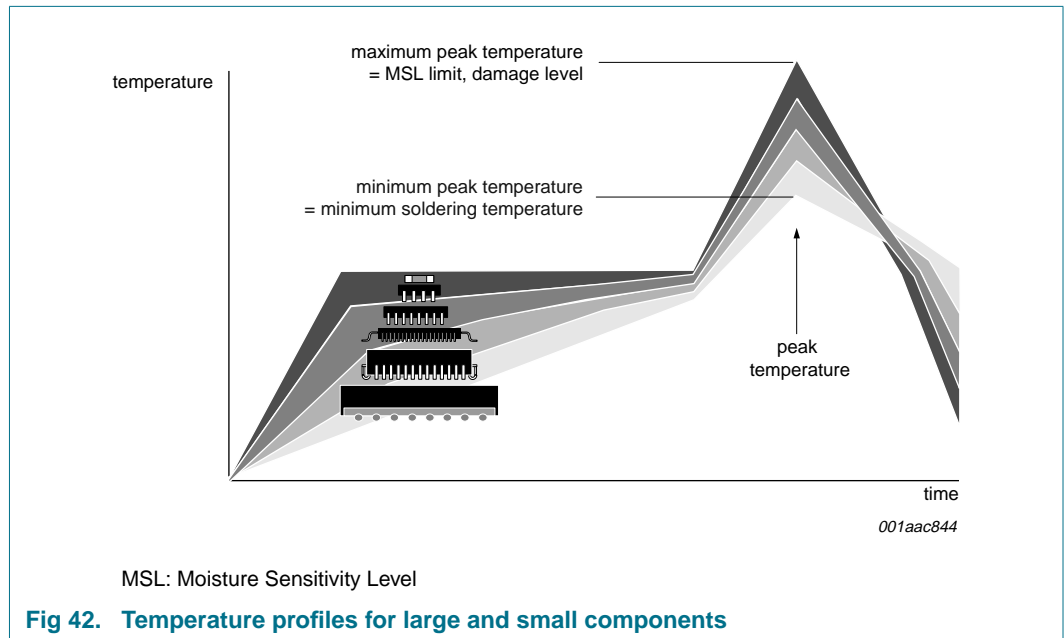
| Package thickness (mm) | Package reflow temperature (°C) |       |
|------------------------|---------------------------------|-------|
|                        | Volume (mm <sup>3</sup> )       |       |
|                        | < 350                           | ≥ 350 |
| < 2.5                  | 235                             | 220   |
| ≥ 2.5                  | 220                             | 220   |

**Table 30. Lead-free process (from J-STD-020C)**

| Package thickness (mm) | Package reflow temperature (°C) |             |        |
|------------------------|---------------------------------|-------------|--------|
|                        | Volume (mm <sup>3</sup> )       |             |        |
|                        | < 350                           | 350 to 2000 | > 2000 |
| < 1.6                  | 260                             | 260         | 260    |
| 1.6 to 2.5             | 260                             | 250         | 245    |
| > 2.5                  | 250                             | 245         | 245    |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see [Figure 42](#).



For further information on temperature profiles, refer to Application Note *AN10365 "Surface mount reflow soldering description"*.

## 21. Revision history

**Table 31. Revision history**

| Document ID                       | Release date | Data sheet status   | Change notice | Supersedes    |
|-----------------------------------|--------------|---|---------------|---------------|
| PCF2113_FAM_4                     | 20080304     | Product data sheet  | -             | PCF2113_FAM_3 |
| Modifications:                    |              | <ul style="list-style-type: none"> <li>• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>• Legal texts have been adapted to the new company name where appropriate.</li> <li>• <a href="#">Figure 3</a>, <a href="#">Figure 13</a>, <a href="#">Figure 20</a> and <a href="#">Figure 21</a>: new graphics.</li> <li>• <a href="#">Table 2</a> added: marking codes table.</li> <li>• <a href="#">Table 4</a>: adjusted die size.</li> <li>• <a href="#">Table 18</a> and <a href="#">Table 19</a>: adjusted values.</li> <li>• <a href="#">Table 25</a>: changed byte settings.</li> </ul> |               |               |
| PCF2113_FAM_3<br>(9397 750 06995) | 20011219     | Product specification   | -             | PCF2113_FAM_2 |
| PCF2113_FAM_2<br>(9397 750 01753) | 19970404     | Preliminary data sheet  | -             | PCF2113_FAM_1 |
| PCF2113_FAM_1                     | 19961021     | Preliminary specification   | -             | -             |

## 22. Legal information

### 22.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

### 22.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

### 22.3 Disclaimers

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected

to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Terms and conditions of sale** — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nxp.com/profile/terms>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

### 22.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

**I<sup>2</sup>C-bus** — logo is a trademark of NXP B.V.

## 23. Contact information

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)

24. Contents

|       |   |           |           |  |           |
|-------|---|-----------|-----------|--|-----------|
| 1     | <b>General description</b> .....                    | 1         | 9.11      | Read data from CGRAM or DDRAM .....                          | 30        |
| 2     | <b>Features</b> .....                               | 1         | <b>10</b> | <b>Extended function set instructions and features</b> ..... | <b>31</b> |
| 3     | <b>Applications</b> .....                           | 2         | 10.1      | New instructions .....                                       | 31        |
| 4     | <b>Ordering information</b> .....                   | 2         | 10.2      | Icon control .....   | 31        |
| 5     | <b>Marking</b> .....                                | 2         | 10.3      | Bit IM .....   | 32        |
| 6     | <b>Block diagram</b> .....                          | 3         | 10.4      | Bit IB .....   | 32        |
| 7     | <b>Pinning information</b> .....                    | 4         | 10.5      | Direct mode .....  | 33        |
| 7.1   | Pinning .....                                       | 4         | 10.6      | Voltage multiplier control .....                             | 33        |
| 8     | <b>Functional description</b> .....                 | <b>10</b> | 10.6.1    | Bits S1 and S0 .....   | 33        |
| 8.1   | LCD supply voltage generator .....                  | 10        | 10.7      | Screen configuration .....                                   | 33        |
| 8.2   | LCD bias voltage generator .....                    | 10        | 10.7.1    | Bit L .....  | 33        |
| 8.3   | Oscillator .....                                    | 11        | 10.8      | Display configuration .....                                  | 34        |
| 8.4   | External clock .....                                | 11        | 10.8.1    | Bit P .....  | 34        |
| 8.5   | Power-on reset .....                                | 11        | 10.8.2    | Bit Q .....  | 34        |
| 8.6   | Registers .....                                     | 11        | 10.9      | Temperature control .....                                    | 35        |
| 8.7   | Busy flag .....                                     | 11        | 10.10     | Set V <sub>LCD</sub> .....                                   | 35        |
| 8.8   | Address counter .....                               | 12        | 10.10.1   | V <sub>LCD</sub> programming .....                           | 35        |
| 8.9   | Display data RAM .....                              | 12        | 10.11     | Reducing current consumption .....                           | 35        |
| 8.10  | Character generator ROM .....                       | 13        | <b>11</b> | <b>Interfaces to microcontroller</b> .....                   | <b>36</b> |
| 8.11  | Character generator RAM .....                       | 18        | 11.1      | Parallel interface .....                                     | 36        |
| 8.12  | Cursor control circuit .....                        | 18        | 11.2      | I <sup>2</sup> C-bus interface .....                         | 37        |
| 8.13  | Timing generator .....                              | 19        | 11.2.1    | I <sup>2</sup> C-bus protocol .....                          | 38        |
| 8.14  | LCD row and column drivers .....                    | 19        | 11.2.2    | Definitions .....  | 40        |
| 8.15  | Power-down mode .....                               | 23        | <b>12</b> | <b>Internal circuitry</b> .....                              | <b>41</b> |
| 8.16  | Reset function .....                                | 23        | <b>13</b> | <b>Limiting values</b> .....                                 | <b>42</b> |
| 9     | <b>Instructions</b> .....                           | <b>24</b> | <b>14</b> | <b>Static characteristics</b> .....                          | <b>43</b> |
| 9.1   | Clear display .....                                 | 27        | <b>15</b> | <b>Dynamic characteristics</b> .....                         | <b>45</b> |
| 9.2   | Return home .....                                   | 28        | <b>16</b> | <b>Application information</b> .....                         | <b>47</b> |
| 9.3   | Entry mode set .....                                | 28        | 16.1      | Application diagrams .....                                   | 47        |
| 9.3.1 | Bit I/D .....                                       | 28        | 16.2      | General application information .....                        | 49        |
| 9.3.2 | Bit S .....   | 28        | 16.3      | 4-bit operation, 1-line display using internal reset .....   | 49        |
| 9.4   | Display control (and partial Power-down mode) ..... | 28        | 16.4      | 8-bit operation, 1-line display using internal reset .....   | 49        |
| 9.4.1 | Bit D .....   | 28        | 16.5      | 8-bit operation, 2-line display .....                        | 52        |
| 9.4.2 | Bit C .....   | 28        | 16.6      | I <sup>2</sup> C-bus operation, 1-line display .....         | 53        |
| 9.4.3 | Bit B .....   | 29        | <b>17</b> | <b>Package outline</b> .....                                 | <b>57</b> |
| 9.5   | Cursor or display shift .....                       | 29        | <b>18</b> | <b>Handling information</b> .....                            | <b>58</b> |
| 9.6   | Function set .....                                  | 29        | <b>19</b> | <b>Packing information</b> .....                             | <b>58</b> |
| 9.6.1 | Bit DL (parallel mode only) .....                   | 29        | <b>20</b> | <b>Soldering of SMD packages</b> .....                       | <b>59</b> |
| 9.6.2 | Bit M .....   | 29        | 20.1      | Introduction to soldering .....                              | 59        |
| 9.6.3 | Bit SL .....  | 29        | 20.2      | Wave and reflow soldering .....                              | 59        |
| 9.6.4 | Bit H .....   | 29        | 20.3      | Wave soldering .....   | 60        |
| 9.7   | Set CGRAM address .....                             | 29        | 20.4      | Reflow soldering .....                                       | 60        |
| 9.8   | Set DDRAM address .....                             | 30        |           |  |           |
| 9.9   | Read busy flag and read address .....               | 30        |           |  |           |
| 9.10  | Write data to CGRAM or DDRAM .....                  | 30        |           |  |           |

continued >>



|           |                                  |           |
|-----------|----------------------------------|-----------|
| <b>21</b> | <b>Revision history</b> .....    | <b>62</b> |
| <b>22</b> | <b>Legal information</b> .....   | <b>63</b> |
| 22.1      | Data sheet status .....          | 63        |
| 22.2      | Definitions .....                | 63        |
| 22.3      | Disclaimers .....                | 63        |
| 22.4      | Trademarks .....                 | 63        |
| <b>23</b> | <b>Contact information</b> ..... | <b>63</b> |
| <b>24</b> | <b>Contents</b> .....            | <b>64</b> |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.



© NXP B.V. 2008.

All rights reserved.

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)

Date of release: 4 March 2008

Document identifier: PCF2113\_FAM\_4